

PLEASE CHECK FOR CHANGE INFORMATION AT THE REAR OF THIS MANUAL.

TSG6

NTSC MULTIBURST
AND VIDEO SWEEP
TEST SIGNAL GENERATOR
MODULE

INSTRUCTION MANUAL

Tektronix, Inc.
P.O. Box 500
Beaverton, Oregon 97077
070-2528-00
Product Group 20

Serial Number _

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CHANGE INFORMATION & TEST EQUIPMENT

OPERATORS SAFETY SUMMARY

The general safety information in this part of the summary is for both operating and servicing personnel. Specific warnings and cautions will be found throughout the manual where they apply, but may not appear in this summary.

TERMS

In This Manual

CAUTION statements identify conditions or practices that could result in damage to the equipment or other property.

WARNING statements identify conditions or practices that could result in personal injury or loss of life.

As Marked on Equipment

CAUTION indicates a personal injury hazard not immediately accessible as one reads the marking, or a hazard to property including the equipment itself.

DANGER indicates a personal injury hazard immediately accessible as one reads the marking.

SYMBOLS

In This Manual

This symbol indicates where applicable cautionary or other information is to be found.

As Marked on Equipment



DANGER — High voltage.



Protective ground (earth) terminal.



ATTENTION — refer to manual.

Grounding the Product

This product is grounded through the grounding conductor of the power cord. To avoid electrical shock, plug the power cord into a properly wired receptacle before connecting to the product input or output terminals. A protective ground connection by way of the grounding conductor in the power cord is essential for safe operation.

Use the Proper Power Cord

Use only the power cord and connector specified for your product. Use only a power cord that is in good condition.

For detailed information on power cords and connectors, see Servicing information.

Refer cord and connector changes to qualified service personnel.

Use the Proper Fuse

To avoid fire hazard, use only the fuse specified in the parts list for your product, and which is identical in type, voltage rating, and current rating.

Refer fuse replacement to qualified service personnel.

Do Not Operate In Explosive Atmospheres

To avoid explosion, do not operate this product in an atmosphere of explosive gases unless it has been specifically certified for such operation.

Do Not Remove Covers or Panels

To avoid personal injury, do not remove the product covers or panels. Do not operate the product without the covers and panels properly installed.

SERVICING SAFETY SUMMARY

FOR QUALIFIED SERVICE PERSONNEL ONLY

Refer also to the preceding Operators Safety Summary.

Do Not Service Alone

Do not perform internal service or adjustment of this product unless another person capable of rendering first aid and resuscitation is present.

Use Care When Servicing With Power On

Dangerous voltages exist at several points in this product. To avoid personal injury, do not touch exposed connections and components while power is on.

Disconnect power before removing protective panels, soldering, or replacing components.

Power Source

This product is intended to operate from a power source that will not apply more than 250 volts rms between the supply conductors or between either supply conductor and ground. A protective ground connection by way of the grounding conductor in the power cord is essential for safe operation.

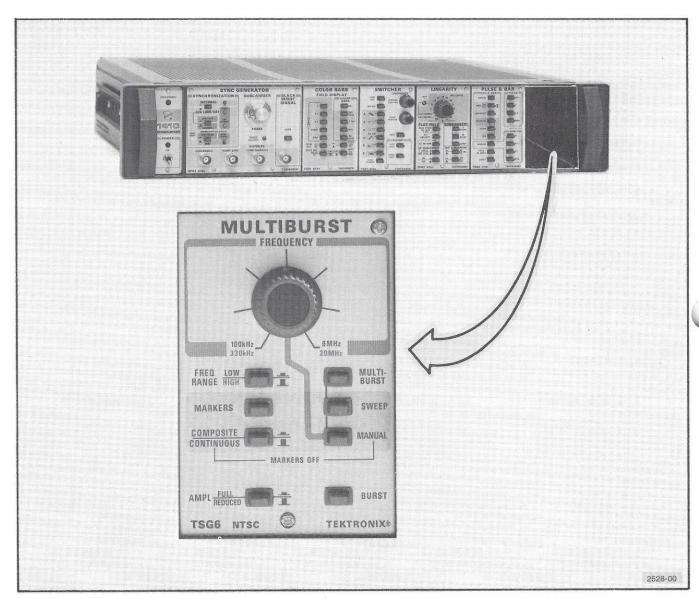


Fig. 1-1. The TSG6 NTSC Multiburst & Video Sweep Test Signal Generator Module.

PART I OPERATORS INFORMATION

OPERATING INSTRUCTIONS

DESCRIPTION

The TSG6 is an NTSC Multiburst & Video Sweep Test Signal Generator for use in the 1410 (NTSC) Generator mainframe.

Main features for the TSG6 Multiburst generator are as follows:

- Multiburst test signals which are: (A) amplitude modulated to produce controlled rise and falltime burst packets, and (B) phase modulated to enhance the ability to detect peak-to-peak burst-packet amplitudes.
- Manual or swept frequency signals.
- REDUCED or FULL AMPLitude signals.
- A LOW and HIGH frequency band in MULTIBURST, MANUAL, or SWEEP (field sweep) mode.
- COMPOSITE video or CONTINUOUS sine-wave operation.
- Front-panel on/off switch for color BURST in COM-POSITE mode.
- Last burst variable mode, with the frequency of the last burst in multiburst controllable via the manual Frequency dial.
- Multiburst VITS remote enable.
- Markers for amplitude reference in MULTIBURST and MANUAL modes.
- Markers for frequency and amplitude reference in SWEEP mode.

FRONT-PANEL CONTROLS

Refer to Figs. 1-2 through 1-5 while reading about the control functions. Fig. 1-2 shows the front-panel controls. Figs. 1-3 through 1-5 show the various output waveforms and displays obtained when the TSG6 is operating in the modes described in the illustrations.

1) FREQ RANGE

Selects frequency limits in field SWEEP and MANUAL modes; selects burst-packet frequencies in the MULTIBURST mode. Figs. 1-3, 1-4, and 1-5A through 1-5E show various displays obtained when using the LOW and HIGH frequency ranges.

(2)MARKERS

Inserts amplitude/frequency markers in the SWEEP mode and amplitude markers in the COM-POSITE/MANUAL mode. See Figs. 1-4, 1-5A, 1-5C, and 1-5D for examples of "markers on" displays.

(3) COMPOSITE/CONTINUOUS

Determines whether sync, blanking, and a pedestal will be added to the sweep and manual signals.

COMPOSITE: Sync, blanking, and a pedestal are added to the sweep and manual signals. See Figs. 1-4, 1-5A, 1-5C, and 1-5D. In the MULTIBURST mode (see Figs. 1-3 and 1-5E), these components are present regardless of the COMPOSITE/CONTINUOUS switch setting.

CONTINUOUS: Sync, blanking, and the pedestal are removed from the sweep and manual signals. See Fig 1-5B.

Operating Instructions—TSG6

4 AMPLitude

Selects FULL or REDUCED amplitude in all operating modes. See Figs. 1-3, 1-4, and 1-5A through 1-5C for examples of FULL AMPLitude displays. In the REDUCED position, both sine-wave and luminance components are reduced. See Figs. 1-5D and 1-5E.

5 FREQUENCY

Determines frequency of sine wave in MANUAL mode and last burst in last burst variable mode. Figs. 1-5A and 1-5B show examples of MANUAL mode.

6 MULTIBURST

Selects line-rate discrete-frequency packets with reference insertion levels. See Figs. 1-3 and 1-5E.

NOTE

MULTIBURST, SWEEP, and MANUAL are self-canceling switches.

(7) SWEEP

Selects field sweep. See Figs. 1-4, 1-5C, and 1-5D.

(8) MANUAL

Selects fixed-frequency sine waveshape with frequency determined by the front-panel FREQUENCY control and FREQ RANGE switch. See Figs 1-5A and 1-5B.

9 BURST

Determines whether color burst will be inserted on composite video. See Figs. 1-3, 1-4, 1-5A, 1-5C, 1-5D, and 1-5E.

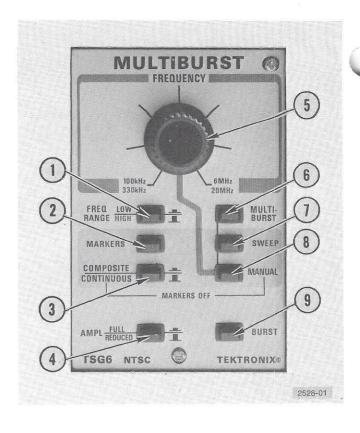
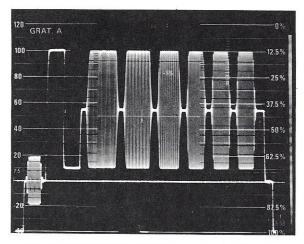


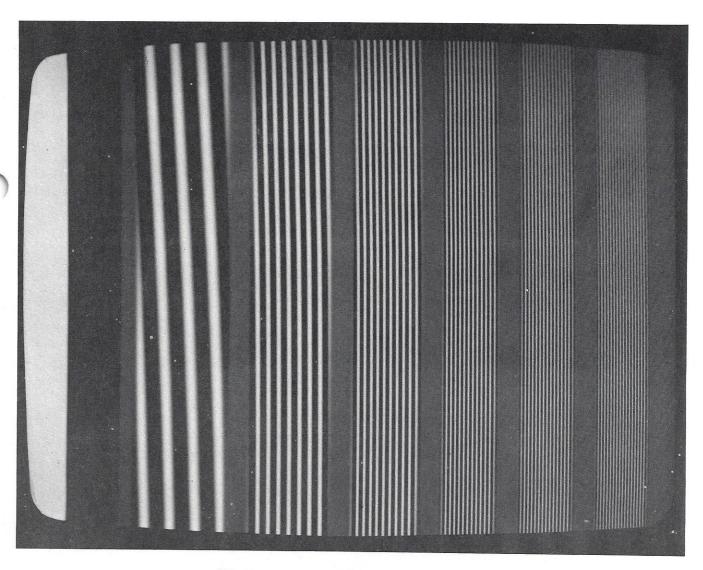
Fig. 1-2. TSG6 Front-Panel Controls.

NOTE

For internal jumper options, refer to Part II—Service & Installation portion of this manual. Any changes in jumper positions must be made by qualified service personnel only.

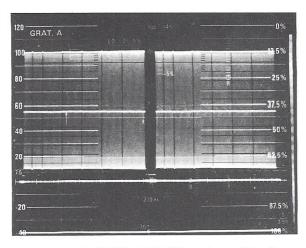


(A) TEKTRONIX 1480 Waveform Monitor display. Sweep rate: $5 \mu s/div$.

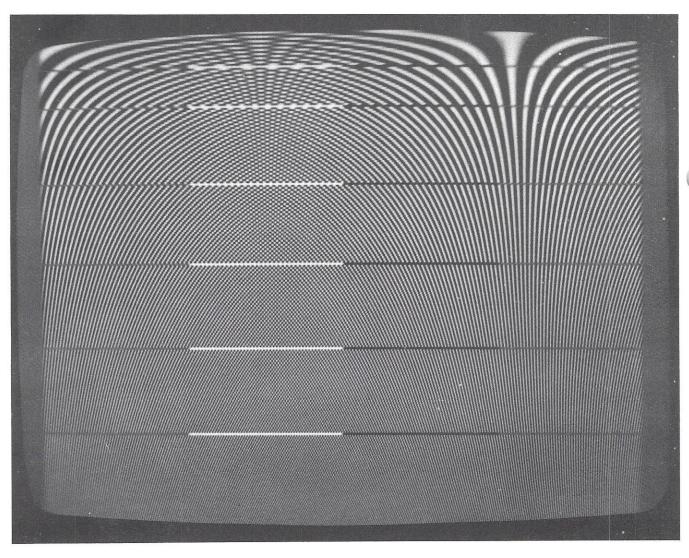


(B) Monochrome picture monitor display.

Fig. 1-3. TSG6 low range, full amplitude, composite multiburst, burst on, output signal.

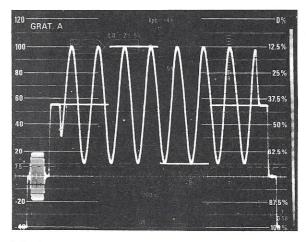


(A) TEKTRONIX 1480 Waveform Monitor display. Sweep rate: 2 Field.

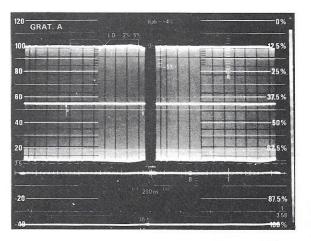


(B) Monochrome picture monitor display.

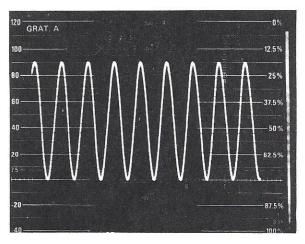
Fig. 1-4. TSG6 low range, full amplitude, composite sweep output signal; markers and burst on.



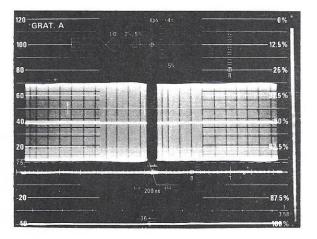
(A) Low range, full amplitude, composite manual mode; markers and burst on. Sweep rate: 5 μs/div.



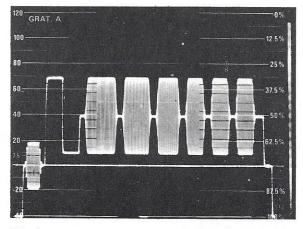
(C) High range, full amplitude, composite sweep mode; markers and burst on. Sweep rate: 2 Field.



(B) Low range, full amplitude, continuous sine wave, manual mode. Sweep rate: 5 µs/div.



(D) High range, reduced amplitude, composite sweep mode; markers and burst on. Sweep rate: 2 Field.



(E) Low range, reduced amplitude, composite multiburst, burst on, output signal. Sweep rate: $5 \mu s/div$.

Fig. 1-5. TSG6 output waveforms displayed on a TEKTRONIX Waveform Monitor that was modified to provide wideband frequency response. The TSG6 front-panel controls and waveform monitor sweep rate were set as described below each waveform.

REMOTE FUNCTIONS

The following remote functions are enabled through the 1410 rear-panel Remote J41 connector. Enabling is accomplished by ground closure.

MULTIBURST

Enables multiburst. Disables the front-panel MANUAL and SWEEP pushbuttons.

LAST BURST VARIABLE

If enabled, this allows the front-panel FREQUENCY control to be used for adjusting the last burst packet frequency in the MULTIBURST mode. The range of adjustment is reduced relative to normal operation (this also applies to MANUAL mode). This feature allows the operator to set the frequency of the last burst with a frequency counter when used in conjunction with the CALIBRATE remote function.

CALIBRATE

If enabled, this forces the module into CONTINUOUS operating mode. If MULTIBURST is selected from the front panel, then a continuous sine wave is obtained with the frequency of the last burst packet. If in SWEEP mode, a continuous unblanked sweep is obtained. This line disables all VITS keying.

VITS (Vertical Interval Test Signal)

The VITS Key enables multiburst during the vertical interval. During this interval, the VITS Key disables the front-panel MANUAL and SWEEP pushbutton positions. Fig. 1-6 shows the multiburst VITS signal that was enabled by the VITS Key.

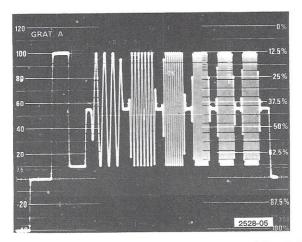


Fig. 1-6. Low range, full amplitude, composite multiburst VIT signal with burst off.

The VITS Key may originate from any one of three sources:

- 1. Internally from the TSP1 Test Signal Switcher, if installed.
- 2. Remotely via the 1410 rear-panel J41 Remote connector.
- 3. Internally from the black burst board (in SPG or TSG module).

Refer to the 1410 and TSP1 Instruction Manuals for more information concerning VITS enable.

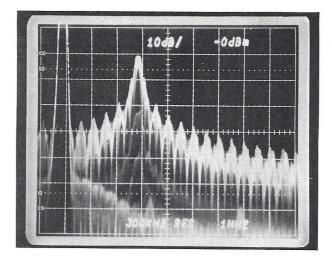
APPLICATIONS

NOTE

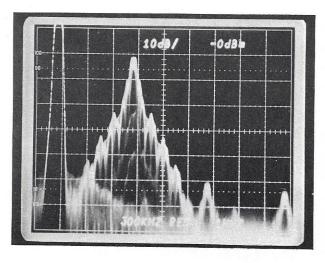
The waveform monitor displays in this section were obtained using a TEKTRONIX 1480 MOD W5F Waveform Monitor. This monitor was modified to provide wideband frequency response.

The TSG6 is a generator for analysis of devices or systems by frequency-domain techniques. It provides sine-wave excitation from 100 kHz to 20 MHz at a level of 643 mV or 428 mV into a 75-ohm load. The sine wave is function-generated to allow for rapid frequency variations required in multiburst operation. Attempt has been made to provide a sine wave with harmonic content commensurate with specified sweep flatness. Many ambiguities associated with system measurements made with multiburst in the past will be reduced through improvements made in the TSG6 multiburst. Harmonics due to the function-generation process have been reduced by design of a custom hybrid integrated circuit and refinements in the triangle-generation circuitry. However, the multiburst is still a sequence of discrete burst packets.

The spectrum of the multiburst signal consists of the convolution of the spectrum of the sine wave (ideally an impulse) and the spectrum of the gating waveform. In conventional multiburst this approximates a step function with a $\sin x/x$ spectrum. This multiburst, when viewed on a spectrum analyzer, will yield an amplitude spectrum of $(\sin x/x)$ squared shape. A TSG6 was modified to generate a single-frequency multiburst with risetimes of less than 50 ns and 4 μ s durations. The resulting spectrum is shown in Fig. 1-7A. The same signal with risetime of 400 ns is shown in Fig. 1-7B. The reduction of skirt energy is graphically illustrated. The benefit of controlled risetime is further illustrated by Fig. 1-8A, the spectrum of the standard TSG6 low-range multiburst.



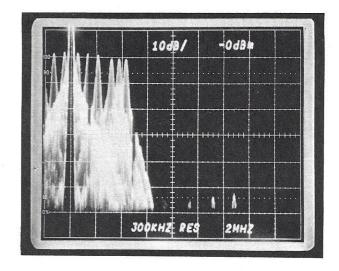
(A) Fast risetime of <50 ns; 4 μ s duration.



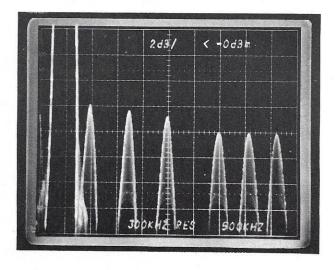
(B) Controlled risetime of 400 ns, 4 μ s duration.

Fig. 1-7. Spectrum analyzer displays of single-frequency multiburst signals.

The TSG6 Multiburst is optimized for use with a waveform monitor, allowing lower frequency burst packets more time during the active line. When viewed on a spectrum analyzer this may result in misinterpretation of the flatness of the multiburst. Fig. 1-8B is a magnified version of the spectrum of a TSG6 low-range multiburst as viewed on a TEKTRONIX 7603 Oscilloscope with 7L12 Spectrum Analyzer at 2 dB/div. The burst packet is not of sufficient duration to obtain steady-state response of the analyzer. The different packet widths result in more amplitude at the lower frequencies. A PROM set is available to generate multiburst with six equal 4 μ s duration burst packets where this is the primary purpose of the TSG6 (see Operating Mode Selection in the Installation section).



(A) Unmagnified display.



(B) Magnified display. Packet duration (left to right): 7 μ s, 6 μ s, 5 μ s, 4 μ s, 4 μ s, and 4 μ s

Fig. 1-8. Spectrum analyzer displays of a standard TSG6 low-range multiburst signal.

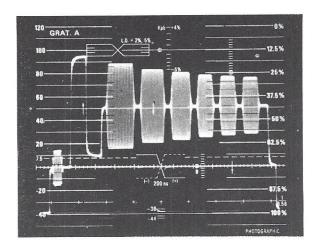
There are a wide range of applications in video facilities for frequency-domain measurements within the capabilities of the TSG6. The following are a sampling of such uses.

Cable Equalization

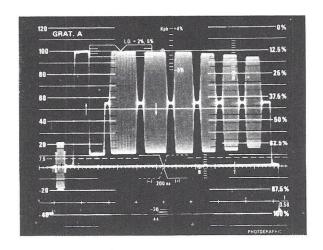
The transmission of video information over long lengths of cable degenerates the signal through frequency-dependent losses of the cable. One application of the high-range multiburst is to set equalization controls on distribution amplifiers with provisions for compensating cable losses. The TSG5 T/2 pulse is also needed to assure that the group delay after equalization is correct.

Operating Instructions—TSG6

This application is demonstrated in Figs. 1-9A and 1-9B. Figure 1-9A is a photograph of losses through 500 feet of an unbalanced 75-ohm video cable. Fig. 1-9B illustrates the correction achieved by a cable-equalizing video distribution amplifier. This application can also demonstrate the use of the last burst variable mode of the TSG6. The standard high-range multiburst covers the range of 1.25 MHz to 12 MHz. Last Burst Variable operation allows adjustment of the last burst frequency from 14 MHz to 20 MHz. Fig. 1-10A is the equivalent of Fig. 1-9A with the last burst set at 15 MHz. Fig. 1-10B is the equalized output with last burst set at 15 MHz. Verification of 15 MHz last burst was done by grounding the TSG6 Calibrate Remote input and measuring the TSG6 output on a frequency counter.



(A) Uncompensated waveform obtained at output of cable.

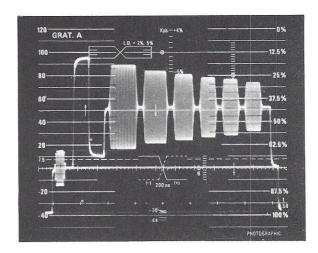


(B) Compensated waveform obtained at output of cable equalizer. 2528-08

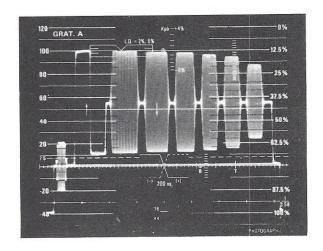
Fig. 1-9. Effect of 500 feet of unbalanced 75-ohm video cable on the high-range multiburst signal. Waveform (B) shows the signal compensated for cable losses by using a cable equalizer.

Video Test Equipment Verification

The TSG6 has been used to evaluate and verify performance of television test equipment. One application provides an illustration for use of low-range field and manual sweep with markers for both frequency and amplitude reference. The TEKTRONIX 1450 is a precision television demodulator. Calibration of the demodulator is performed in conjunction with a precision test modulator. Test signals can be modulated to intermediate frequency or radio frequency and demodulated through the 1450 mainframe or corresponding down converter. The TSG6 is used to sweep the mainframe and combination mainframe-down converter. The 1450 has provisions for



(A) Uncompensated.



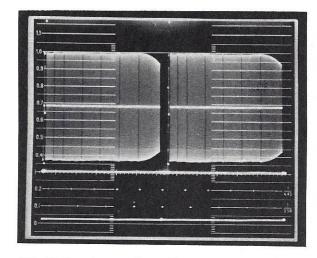
(B) Compensated.

Fig. 1-10. Same conditions as Fig. 1-9 except last burst variable mode was used. Last burst frequency was set at 15 MHz instead of using a standard frequency of 12 MHz.

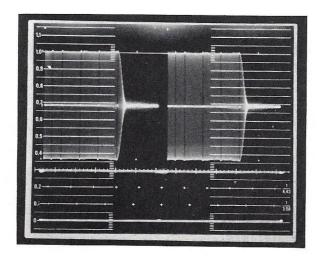
demodulating with or without a sound trap. Fig. 1-11A demonstrates flatness in wide-band mode (low-range sweep) and Fig. 1-11B shows flatness with sound-trap in. To determine the 3-dB cutoff frequency of the mainframe with sound trap, manual sweep in Last Burst Variable mode is used. Grounding the Last Burst Variable remote input to the TSG6 reduces the range of the front-panel FREQUENCY control to: 3.8 MHz to 4.5 MHz. Fig. 1-11C is a line-rate display of the signal with the front-panel knob set to achieve the desired amplitude. Note the ability to set the amplitude relative to the marker. The frequency can be measured by grounding the Calibrate remote input and connecting the TSG6 output to a frequency counter.

Television Studio Maintenance

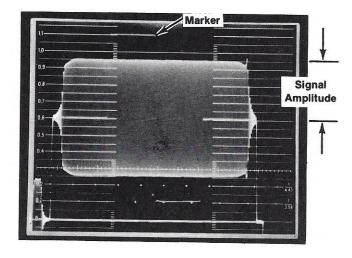
There are many points within the television studio at which frequency-response measurements are valuable. Several applications could be: 1) sweeping of routing switchers, 2) sweeping of production switchers, 3) testing of video tape recorders: electronic versus record/playback, 4) testing of time-base correctors, etc. Fig. 1-12A is a high-range sweep of a routing switcher. Figs. 1-12B and 1-12C are high-range, full- and reducedamplitude sweeps (respectively) of a production switcher. These photographs illustrate the ability to examine performance of systems beyond specifications to check for deteriorating elements (i.e., slew-rate limiting amplifiers, reflections, oscillations, etc.). The low-range sweep is shown sweeping the electronic processing circuits in a helical scan video tape recorder in Fig. 1-13A. Fig. 1-13B is a playback on the same recorder. Fig. 1-13C illustrates the effect of recording with color processing, note the dip between 2 and 3 MHz.



(A) Without soundtrap. Sweep rate: 2 Field.



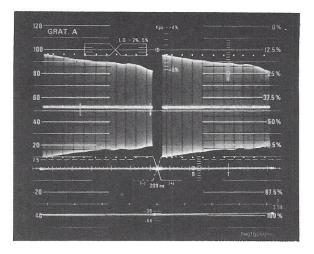
(B) With soundtrap. Sweep rate: 2 Field.



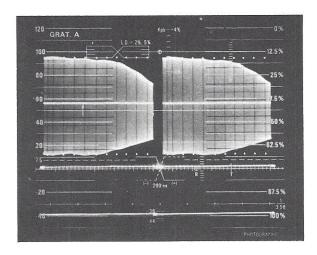
(C) With soundtrap. Sweep rate: 5 μ s/div. 2528-10

Fig. 1-11. Evaluating performance of a precision television demodulator.

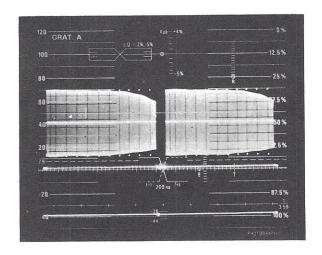
Operating Instructions—TSG6



(A) Routing switcher output.



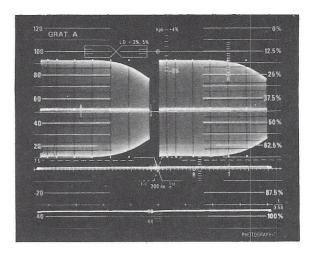
(B) Production switcher output.



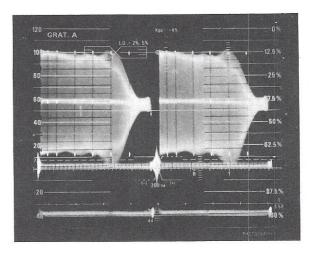
(C) Production switcher output.

Fig. 1-12. Using the TSG6 high-frequency range sweep mode to check television switcher frequency response. Sweep rate of waveform monitor: 2 Field.

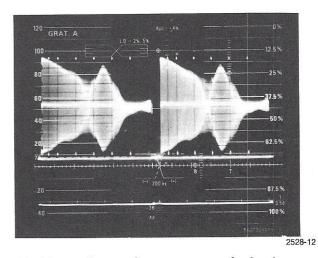
2528-11



(A) Electronic processing circuit output.

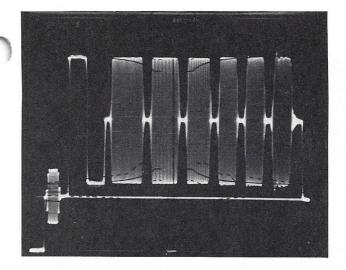


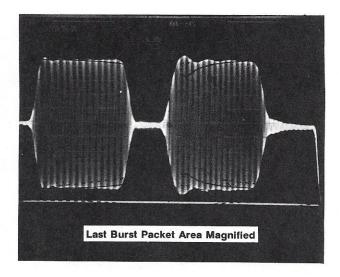
(B) Direct color playback.



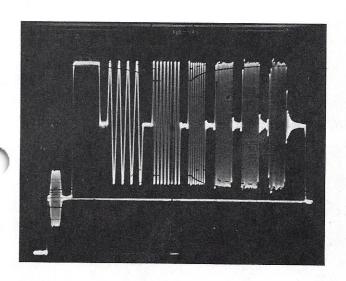
(C) Heterodyne color processor playback.

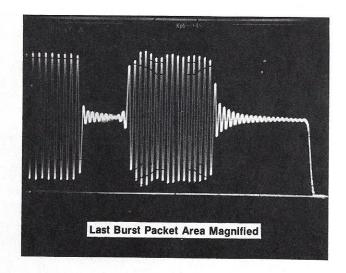
Fig. 1-13. Using the TSG6 low-frequency range sweep mode to check helical scan VTR performance.





(A) TSG6 low-frequency range, full amplitude, multiburst signal.





(B) Conventional multiburst signal.

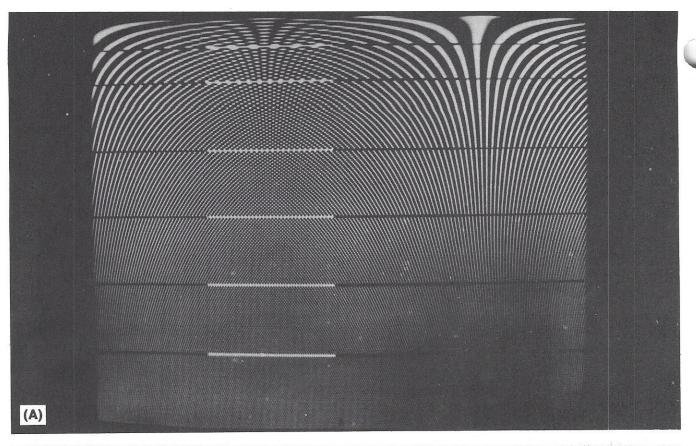
Fig. 1-14. Comparing the TSG6 and conventional multiburst signals as observed at the output of a delay equalized low-pass filter (-40 dB at 5.5 MHz).

Common Carrier Transmission Testing

The low-range multiburst signal is commonly used to evaluate transmission over common-carrier microwave radio-relay links. The TSG6 can be VITS keyed to produce a multiburst in the vertical interval for insertion into a program. This allows in-service testing of the transmission path. The TSG6 multiburst, having less out-of-band energy because of controlled risetime, will produce less intermodulation distortion than previously available multiburst signals. Figs. 1-14A and 1-14B are full-field tests of a band-limited system, illustrating the difference between the TSG6 and conventional multiburst.

Picture Monitor Resolution

The low-range field and manual sweep can be used for comparative evaluation of horizontal resolution of picture monitors. By starting each line of the sweep at a fixed phase, the pattern displayed on a picture monitor is as shown in Fig. 1-4B. The frequency markers indicate positions in the field sweep corresponding to the appropriate frequencies. Figs. 1-15A and 1-15B represent the performance of two different high-resolution color picture monitors when tested using the low-frequency range sweep mode of the TSG6. Another use of the field sweep is detecting aliasing in pictures processed using digital techniques.



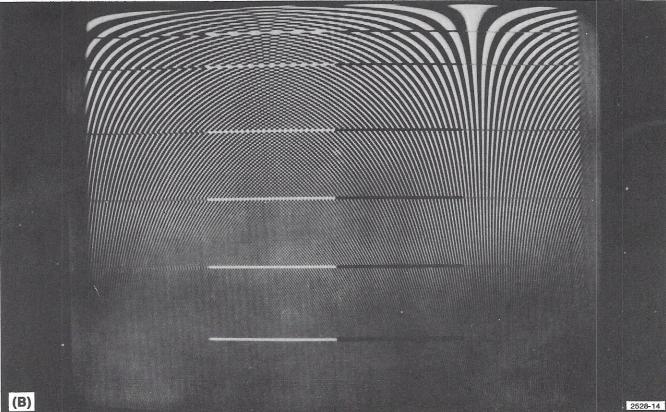


Fig. 1-15. Comparing performance of two different color picture monitors. Signal source: TSG6 low-frequency range sweep signal with markers on and burst off.

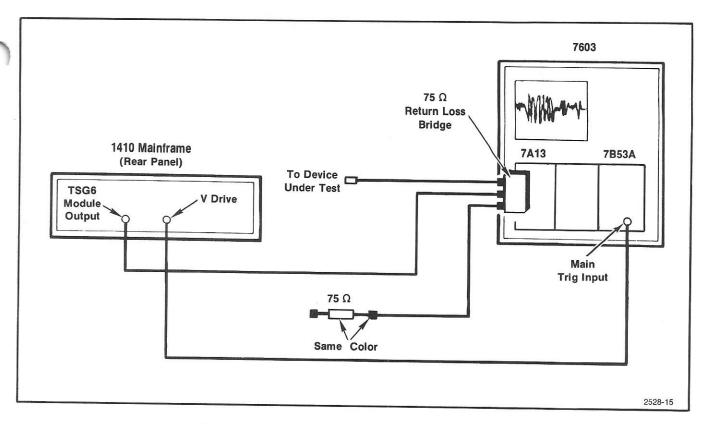


Fig. 1-16. Equipment connections for measuring return loss.

Return Loss Evaluation

The TSG6 provides convenient signals for evaluating return loss of video equipment when used in conjunction with: (1) TEKTRONIX Return Loss Bridge Part No. 015-0149-00, (2) TEKTRONIX 7603 Oscilloscope with a 7A13 Differential Comparator plug-in and a 7B53 Dual Time Base plug-in. This oscilloscope system provides an amplifier unit with the necessary common-mode rejection ratio to make return-loss measurements of better than 54 dB to 6 MHz and 46 dB to 20 MHz. The instruction manual for the Return Loss Bridge contains both theory of operation of the bridge and a detailed procedure for

usage. The following changes are required to adapt the procedure for usage with the TSG6. The equipment setup is as shown in Fig. 1-16. The TSG6 can be operated in different modes, depending upon the desired measurement. Field SWEEP, MARKERS on, and CONTINUOUS provide a convenient display evaluation over either HIGH or LOW frequency range. MANUAL can be used for measurements at selected frequencies. The MULTI-BURST mode can also be used for line-rate displays on either frequency range. FULL amplitude should be used for best accuracy. This amplitude provides a 161 mV signal level for the E_{open} voltage. Fig. 1-17 is a nomograph to be used with the TSG6.

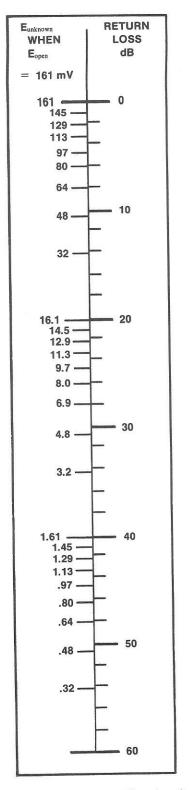


Fig. 1-17. Nomograph for computing the return loss of a device under test.

SPECIFICATION AND PERFORMANCE CHECK

SPECIFICATION

ELECTRICAL CHARACTERISTICS

The following electrical performance requirements are valid only if the instrument has been calibrated at an ambient temperature between $+20^{\circ}$ C and $+30^{\circ}$ C, and the instrument is operating at an ambient temperature between 0° C and $+50^{\circ}$ C. The instrument must have a warm-up period of at least 20 minutes before checking specification.

Characteristic Instants

Signals shown in Fig. 2-1 are defined in characteristic instants. A characteristic instant equals approximately 2 μs (or 63.6 μs /32). T_0 is at the leading edge of sync.

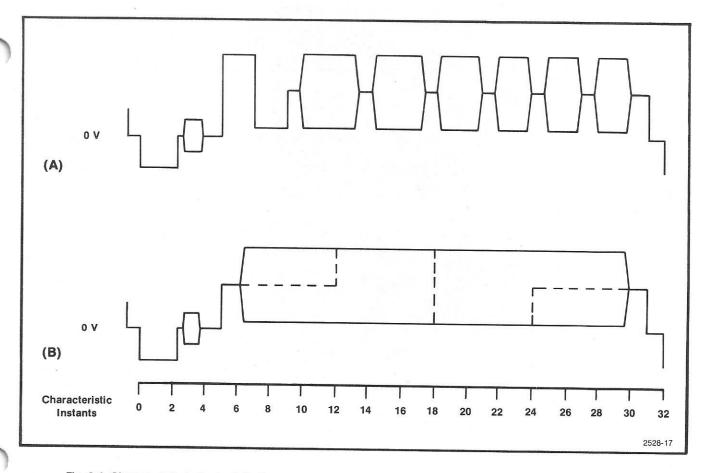


Fig. 2-1. Characteristic instants plotted against the TSG6 multiburst (A) and composite manual/sweep (B) signals.

Specification and Performance Check—TSG6

Characteristics

Characteristics are the properties of the TSG6.

Performance Requirement

Items listed in the Performance Requirement column of the Electrical Characteristics are quantitative terms of performance, usually stated in terms of tolerance limits, and are guaranteed by Tektronix, Inc. Items in this column that are verified in the Performance Check Procedure, which follows this Specification, are indicated by a Performance Check Step number. Items not verified in the Performance Check Procedure may be one or more of the following:

a. Parameters that are dependent upon other 1410 system components (i.e., an SPG unit), where they are verified in the appropriate Instruction Manual.

- b. Parameters that are fixed by the nature of their function, such as range settings of switches, etc.
- c. Characteristics that are digitally derived from a timing reference that is checked (for example, from a crystal-controlled oscillator whose frequency is checked).
- d. Characteristics of a very stable nature that would necessitate an exhaustive procedure and require test equipment that is not commonly available in order to perform a check.

Supplemental Information

Items listed in the Supplemental Information column are not verified in this manual; they are either explanatory notes or performance characteristics for which no performance check procedure is provided.

Table 2-1
ELECTRICAL CHARACTERISTICS

	Performance Requirement		Supplemental	Perf. Ck.	
Characteristics	Low Range High Range		Information	Step No.	
Multiburst					
Frequencies	500 kHz ±3% 1.25 MHz ±3% 2.00 MHz ±3% 3.00 MHz ±3% 3.58 MHz ±3%	1.25 MHz ±3% 3.50 MHz ±3% 5.50 MHz ±3% 8.00 MHz ±3% 10.0 MHz ±3%		1	
	4.10 MHz ±3%	12.0 MHz ±3%			
Amplitude (First Multiburst Packet)					
Full (see Fig. 1-3)	643 mV (90 IRE) ±20 mV	643 mV ±25 mV		5	
Reduced (see Fig. 1-5E)	428 mV (60 IRE) ±12 mV	428 mV ±16 mV			
Flatness					
Full	10 mV or less	16 mV or less		9	
Reduced	10 mV or less	16 mV or less			
Packet Envelope Risetime	400 ns ±60 ns	400 ns ±60 ns		6	
Burst Phasing			Phase shifted at field rate to provide filled-in burst packets.		

Table 2-1 (cont)

	Performance Requirement		Supplemental	Perf. Ck. Step No.
Characteristics	Low Range High Range		Information	
Sweep/Manual				
Sine Wave				
Frequencies				
Start	100 kHz minimum	330 kHz minimum		4
Stop	6 MHz ±10%	20 MHz ±10%		
Amplitude at First Marker				
Full (see Figs. 1-4 & 1-5C)	643 mV ±20 mV	643 mV ±25 mV		5
Reduced (see Fig. 1-5D)	428 mV ±12 mV	428 mV ±16 mV		
Flatness (Max-Min Diode Detected Peak-to-Peak Voltage)				
Full	10 mV	15 mV to 12 MHz 20 mV to 20 MHz	_	9
Reduced	10 mV	15 mV to 12 MHz 20 mV to 20 MHz		
Markers				
Frequencies (see Figs. 1-4, 1-5C & 1-5D)	500 kHz ±3% ^a 1.0 MHz ±3% ^a 2.0 MHz ±3% ^a 3.0 MHz ±3% ^a 4.0 MHz ±3% ^a 5.0 MHz ±3% ^a	1.0 MHz ±3% ^a 2.0 MHz ±3% ^a 4.0 MHz ±3% ^a 6.0 MHz ±3% ^a 8.0 MHz ±3% ^a 10.0 MHz ±4% ^a 12.0 MHz ±4% ^b 14.0 MHz ±6% ^b 16.0 MHz ±7% ^b 18.0 MHz ±7% ^b 20.0 MHz ±7% ^b		2
Multiburst/Manual Last Burst Variable Mode)	11 10			
Frequency Range				
Start	<3.8 MHz	<14 MHz		3
Stop	>4.5 MHz	20 MHz ±10%		
Accuracy	±0.2% short term	±1% short term		

^aWithin one television line either side of the marker.

 $^{^{\}mathrm{b}}$ Above 10 MHz, difference frequency between markers is 2 MHz \pm 400 kHz.

Table 2-1 (cont)

	Performance	Requirement	Supplemental	Perf. Ck	
Characteristics	Low Range High Range		Information	Step No.	
Markers & Pedestal (all modes)					
Amplitude Markers Relative to Pedestal Level					
Full (see Fig. 1-5A)	±321 mV ±1%	±321 mV ±1%		5	
Reduced	±214 mV ±1%	±214 mV ±1%			
Pedestal Level					
Full	393 mV ±1%	393 mV \pm 1%			
Reduced	286 mV ±1%	286 mV ±1%			
Risetime	250 ns ±50 ns	250 ns ±50 ns		6	
Harmonic Distortion Full Amplitude Mode; Single Frequency Relative	-44 dB, 300 kHz to 4.2 MHz	-38 dB, 330 kHz to 6.0 MHz	Harmonic distortion in reduced amplitude mode may be degraded by up to		
o Fundamental)	-40 dB, 100 kHz to 300 kHz	-36 dB, 6.0 MHz to 20 MHz	2 dB from full amplitude specification.	8	
	-40 dB, 4.2 MHz to 6.0 MHz				
Sync					
Amplitude	$-285.7~\mathrm{mV}~\pm5.7~\mathrm{m}$ blanking.	nV40 IRE from		5	
Timing			From 1410 Composite Sync		
Risetime	130 ns +20 ns, -	10 ns		6	
Half Amplitude Duration (HAD)			4.70 μ s ± 100 ns		
Burst (Color)					
Amplitude	285.7 mV (40 IRE peak) \pm 8.6 mV peak-to-		5	
Phase	Adjustable ±10°. From 1410 Sub- carrier Reference.			7	
Timing			From 1410 TSG Burst Flag		
Risetime	400 ns ±60 ns			6	
Half Amplitude Duration			2.51 μ s \pm 70 ns (9 cycles of subcarrier)		
Delay from Line Sync			5.309 μ s \pm 35 ns (19 cycles of subcarrier)		
Breezeway			475 ns typical		
Output Impedance			75 Ω nominal		
Return Loss	30 dB or more to	20 MHz		10	

Table 2-1 (cont)

Characteristics	Performance Requirement	Supplemental Information	Perf. Ck. Step No.
Isolation			
Passive	Amplitude of all signal components, less than 5 MHz, at one output change less than 1% (40 dB) as the other output is switched to open or short circuit.	See Section 4, step 22, in the Calibration Procedure.	
Active (Non-coherent Crosstalk)	A signal introduced at one output connector shall be attenuated by at least 20 dB at the other connector.		

ENVIRONMENTAL CHARACTERISTICS

Table 2-2
ENVIRONMENTAL CHARACTERISTICS

Performance Requirement	Characteristic	Performance Requirement
	Altitude	Process of the second
0°C to 50°C.	Operating	To 15,000 feet.
-40° C to +65° C.	Storage	To 50,000 feet.
	Requirement 0° C to 50° C.	Requirement Characteristic Altitude 0°C to 50°C. Operating

PERFORMANCE CHECK

Introduction

This procedure is to be used to verify that the TSG6 is performing to specification. None of the checks in this procedure involve any internal adjustments or operating changes. Do not remove any protective covers from the 1410 mainframe.

NOTE

The procedure assumes that the internal jumpers are set to their factory-set positions.

Complete the entire procedure. If the TSG6 does not meet some of the performance requirements, a qualified service technician can refer to the Calibration Procedure in Section 4 of this manual to determine the adjustment step(s) that may need to be performed.

In the procedure, the TSG6 front-panel control names are all capitalized; for example, FREQ RANGE. Controls and connector names for the 1410 mainframe with its SPG2 Sync Generator and the names for the associated test equipment have only their first letter capitalized; for example, Module Output connector. No capitals are used if a generic term is used when referring to associated test equipment; for example, set the test oscilloscope time base triggering controls for internal triggering mode of operation.

TEST EQUIPMENT

The test equipment listed here was used in preparing this procedure. The measurement capabilities described are the minimum required to verify instrument performance. Each piece of test equipment is assumed to be operating within its stated specification. If alternative equipment is used, it must meet or exceed these requirements.

1. TEKTRONIX 1410 Generator mainframe with an SPG2 NTSC Sync Generator Module.

With the TSG6 to be verified installed in the 1410 mainframe, and a remote control unit connected to the 1410 mainframe Remote connector.

2. Sine Wave Generator.

Frequency range, 250 kHz to 20 MHz. Frequency accuracy is not critical, since the frequency counter (item 3) is used for the readout. Output amplitude, approximately 200 mV to 300 mV and 6 V to 7 V. (Approximately 6.6 V is needed to drive the 015-0149-00 Return Loss Bridge). For example, a TEKTRONIX SG 503 Leveled Sine Wave Generator in a TM 503 mainframe.

3. Digital Counter.

Frequency range, 100 kHz to 20 MHz. Display, at least 4 digits. Minimum accuracy, 1%. Sensitivity, 200 mV peak-to-peak. For example, a TEKTRONIX DC 501 Digital Counter in a TM 503 mainframe.

4. Test Oscilloscope.

Dual Time Base. Range from 100 ns/div to 2 ms/div with provisions for delaying sweep.

Differential Comparator. Bandwidth, dc to 75 MHz (including mainframe). Minimum deflection factor, 5 mV/div.

For example, a TEKTRONIX 7603 Oscilloscope mainframe with a 7B53A Dual Time Base and a 7A13 Differential Comparator plug-in units.

5. Spectrum Analyzer.

Capable of measuring harmonic distortion of signals from 100 kHz to 20 MHz. Single frequency relative to fundamental harmonic distortion measurement capability: -46 dB. For example, a TEKTRONIX 7L12 Spectrum Analyzer in a 7000-Series Oscilloscope mainframe. Can be used with item 4.

6. Waveform Monitor.

Capable of viewing line-rate and field-rate signals. Contains a magnifier to measure risetime and check wave shape. For example, a TEKTRONIX 1480 NTSC Waveform Monitor with Graticule A.

7. Vectorscope.

Capable of measuring phase differences of less than 0.5° between two signals. For example, a TEKTRONIX 520A NTSC Vectorscope.

8. Video Detector.

Rectifies and detects the peak amplitude of the applied signal. For example, a Marconi TM9703 Video Detector.

9. Return Loss Bridge.

Return loss for the specification was verified using the following Marconi test equipment: TM9692 Video Sweep Unit, TF2361 Sweep Generator, TF2907 Differential Probe Unit, and TM9827 Return Loss Probe.

An alternate method was used in this Performance Check procedure. This method uses the TEKTRONIX 015-0149-00 Return Loss Bridge driven by the TEKTRONIX SG 503 Leveled Sine Wave Generator (item 2). The Return Loss Bridge is used with the TEKTRONIX 7603 Oscilloscope and 7B53A/7A13 plug-in units (item 4).

10. 50-Ohm to 75-Ohm Minimum Loss Attenuator.

Tektronix Part No. 011-0057-00.

11. BNC T Adapter.

Tektronix Part No. 103-0030-00.

12. 50-Ohm Coaxial Cable.

Two required. 42 inches long. Tektronix Part No. 012-0057-01.

13. 75-Ohm 10X Attenuator.

Tektronix Part No. 011-0061-00.

14. 75-Ohm End-Line Termination.

Two required. Tektronix Part No. 011-0102-00.

15. 75-Ohm Feed-Through Termination.

Tektronix Part No. 011-0103-00.

16. 75-Ohm Coaxial Cable.

Three required. 42 inches long. Tektronix Part No. 012-0074-00.

17. Calibration Fixture.

For use with 1480 Waveform Monitor (item 7). Refer to Fig. 2-2 and the topics, "Calibration Fixture" and "Measurements Using the Calibration Fixture", that follow for details.

Calibration Fixture

This fixture and the 1480 Waveform Monitor provide a variable calibration voltage level which can be read directly from a 10-turn dial. The schematic diagram and parts list for the fixture appear in Fig. 2-2. When S1 is in the Variable position, the 1480 calibrator voltage is determined by the circuit in the fixture.

With P9034 connected to J9034 on the 1480, set the fixture S1 to the Fixed position. Push in the 1480 Sync Tip and Cal buttons to display the internal calibrator 1 V square wave. Calibrate the graticule for 1 V. Set the Amplitude dial to 1000 and S1 to Variable. Adjust R3 (CAL), to exactly match the internal 1 V calibrator level. The dial is now calibrated so that each turn of the dial represents 100 mV.

Measurements Using the Calibration Fixture

The signal to be measured must be fed to the 1480 CH A input, and both the Oper and Cal buttons pushed in. Set the DC Restorer button to Off. To check luminance amplitude within a given tolerance, adjust the fixture Amplitude dial while watching the waveform monitor display. When the level being measured overlays the blanking level, read the amplitude directly from the dial.

Peak-to-peak chrominance amplitude can be checked for tolerance by adjusting the fixture Amplitude dial until the peaks of the chrominance packet being measured just meet.

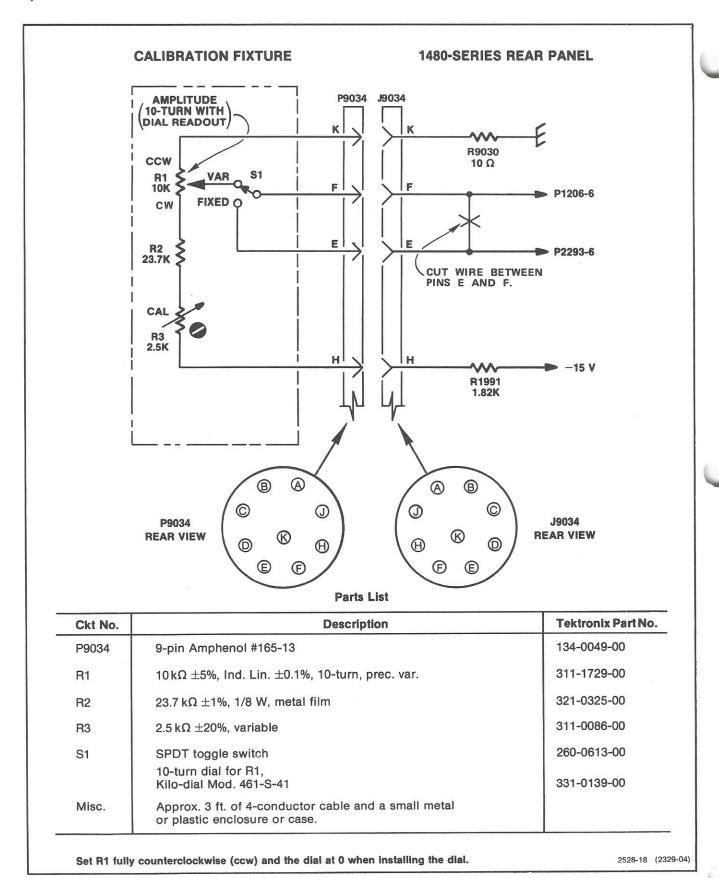


Fig. 2-2. Waveform Monitor Calibration Fixture.

PROCEDURE

Preliminary Instructions

Before starting this procedure, the TSG6 should be installed in the 1410 Generator mainframe along with an SPG2 module.

Allow a 20 minute warmup period for the 1410 system and all test equipment before starting the procedure.

The SPG2 installed in the 1410 mainframe should be set for internal mode of operation.

1. Check Multiburst Frequencies

- a. Connect the TSG6 Module Output signal via a 75ohm coaxial cable to the 1480 Waveform Monitor CH A Video Input connector. Terminate the remaining CH A Video Input connector into 75 ohms. See Fig. 2-3.
- b. Connect the output signal from the sine-wave generator via a 50-ohm coaxial cable to the 1480 Waveform Monitor CH B Video Input connector. Leave the Ch Bloop-through connector unterminated. See Fig. 2-3.

- c. Connect the 1410 mainframe or SPG2 Comp Sync signal via a 75-ohm coaxial cable to the 1480 Waveform Monitor Ch A External Sync input connector. Terminate this loop-through connector into 75 ohms.
- d. Set the TSG6 and test equipment controls as follows:

TSG6

FREQ RANGE LOW MARKERS Off

COMPOSITE/

COMPOSITE CONTINUOUS

AMPL **FULL**

MULTIBURST/SWEEP/

MULTIBURST MANUAL

FREQUENCY Control As is BURST Off

Sine-Wave Generator

Output Frequency 500 kHz Output Amplitude

Approximately 286 mV

(40 IRE)

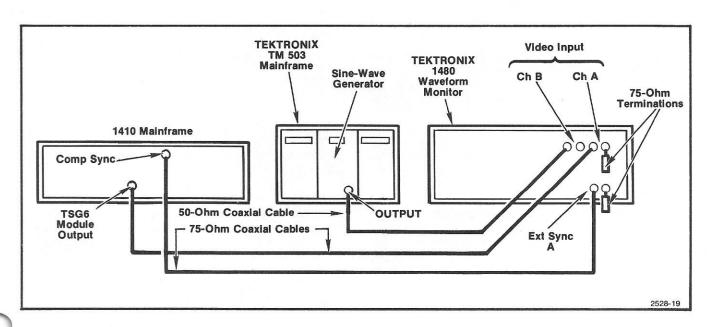


Fig. 2-3. Equipment connections for checking TSG6 multiburst and marker frequencies.

Table 2-3
CHECKING MULTIBURST FREQUENCIES

TSG6 FREQ RANGE Switch Setting	Multiburst-Packet Frequency	PROCEDURE: Set sine-wave generator to obtain a zero beat within the following range.
HIGH	1.25 MHz ±3%	1.29 MHz to 1.21 MHz
	3.50 MHz ±3%	3.61 MHz to 3.40 MHz
	5.50 MHz ±3%	5.67 MHz to 5.34 MHz
	8.00 MHz ±3%	8.24 MHz to 7.76 MHz
	10.0 MHz ±3%	10.30 MHz to 9.70 MHz
	12.0 MHz ±3%	12.36 MHz to 11.64 MHz
LOW	2.00 MHz ±3%	2.06 MHz to 1.94 MHz
	3.00 MHz ±3%	3.09 MHz to 2.91 MHz
	3.58 MHz ±3%	3.69 MHz to 3.47 MHz
	4.10 MHz ±3%	4.22 MHz to 3.98 MHz

1480 Waveform Monitor

Input	A-B, DC Coupled
Response	Flat
Volts Full Scale	1.0
DC Restorer	Slow, Backporch
Oper/Cal	Oper
Display	10 μs/Div
Magnifier	X1
Field	1
Line Selector	Variable
Sync	Ext. AFC

- e. CHECK—500-kHz multiburst-packet frequency by slowly rotating the sine-wave generator Variable Frequency control until a zero beat is obtained (see Fig. 2-4A). The readout frequency should be 500 kHz $\pm 3\%$ or equivalent to 515 kHz to 485 kHz.
- f. Set the sine-wave generator for an output frequency of 1.25 MHz.
- g. CHECK—1.25-MHz multiburst-packet frequency by rotating the sine-wave generator Variable Frequency control until a zero beat is obtained. The readout frequency should be 1.25 MHz \pm 3% or equivalent to 1.29 MHz to 1.21 MHz. See Fig. 2-4B.
- h. CHECK—the remaining multiburst frequencies listed in Table 2-3 using the technique described in parts d through g of this step as a guide.

2. Check Marker Frequencies

a. Use the same equipment connections and control settings as described in parts a through d of step 1 except as follows:

TSG6

MARKERS On
MULTIBURST/SWEEP/
MANUAL SWEEP

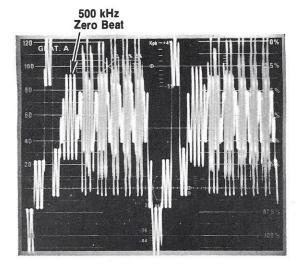
Sine Wave Generator

Output Amplitude 200 mV (28 IRE)

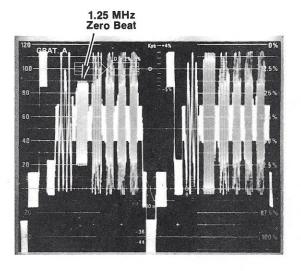
1480 Waveform Monitor

Display 2 Field

- b. Check that the sine-wave generator is set for an output frequency of 500 kHz. Rotate the waveform monitor Variable Line Selector control to intensify the 500 kHz marker as shown in Fig. 2-5A.
- c. Set the waveform monitor Display switch to 10 μ s/Div. Check that the marker is displayed as shown in Fig. 2-5B. Set the TSG6 MARKERS pushbutton to Off.
- d. CHECK—500-kHz marker frequency by rotating the sine-wave generator Variable Frequency control until a zero beat is obtained as shown in Fig. 2-5C. The frequency should be 500 kHz $\pm 3\%$ or 515 kHz to 485 kHz within one television line either side of the marker. For example, if the



(A) 500 kHz.

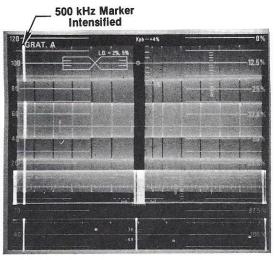


(B) 1.25 MHz.

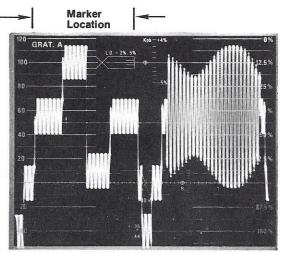
2528-20

Fig. 2-4. Typical waveforms obtained when checking the multiburst packet frequency using zero beat method. Waveform monitor Input switch set to A-B, DC Coupled.

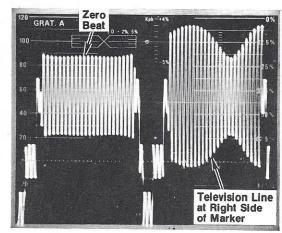
readout is 516 kHz at the marker location, obtain a zero beat on the television line located to the left of the marker. Then, obtain a zero beat on the television line to the right of the marker. (The TSG6 MARKERS button can be set to On while making the checks described in this example.) If the readout is 515 kHz or lower at one of these television line locations, the marker meets the performance requirement.



(A) 500 kHz marker intensified. Waveform monitor Display switch set to 2 Field.



(B) Location of 500 kHz marker. Waveform monitor Display switch set to 10 μs/Div.



(C) Zero beat at 500 kHz marker location.
TSG6 MARKERS button set to Off. 2528-2

Fig. 2-5. Typical displays obtained when checking marker frequency.

Table 2-4
CHECKING MARKER FREQUENCIES

TSG6 FREQ RANGE Marker Frequency Switch Setting		PROCEDURE: Locate appropriate marker and obtain a zero beat within the following range.		
LOW	2.0 MHz ±3% 3.0 MHz ±3%	2.06 MHz to 1.94 MHz 3.09 MHz to 2.91 MHz	Within one television line	
	4.0 MHz ±3% 5.0 MHz ±3%	4.12 MHz to 3.88 MHz 5.15 MHz to 4.85 MHz	either side of marker.	
HIGH	1.0 MHz ±3% 2.0 MHz ±3% 4.0 MHz ±3% 6.0 MHz ±3% 8.0 MHz ±3% 10.0 MHz ±4%	1.03 MHz to 0.97 MHz 2.06 MHz to 1.94 MHz 4.12 MHz to 3.88 MHz 6.18 MHz to 5.82 MHz 8.24 MHz to 7.76 MHz 10.40 MHz to 9.60 MHz		
	12.0 MHz ±4% 14.0 MHz ±6% 16.0 MHz ±7% 18.0 MHz ±7% 20.0 MHz ±7%	12.48 MHz to 11.52 MHz 14.84 MHz to 13.16 MHz 17.12 MHz to 14.88 MHz 19.26 MHz to 16.74 MHz 21.40 MHz to 18.60 MHz	Difference frequency between markers should be 2 MHz ±400 kHz.	

- e. Set the TSG6 MARKERS button to On. Set the waveform monitor Display switch to 2 Field and rotate the Variable Line Selector control to intensify the 1.0 MHz marker. Set the Display switch to 10 $\mu s/\text{Div}$ and note the location of the marker on the waveform monitor display. Set the TSG6 MARKERS pushbutton to Off.
- f. CHECK—1.0 MHz marker frequency by rotating the sine-wave generator Variable Frequency control until a zero beat is obtained. The readout frequency should be 1.0 MHz $\pm 3\%$ or 1.03 MHz to 0.97 MHz within one television line either side of the marker.
- g. Set the waveform monitor Display switch to 2 Field and the TSG6 MARKERS button to On.
- h. CHECK—the remaining marker frequencies listed in Table 2-4 using the technique described in parts b through g of this step as a guide.
- Set the TSG6 FREQ RANGE switch to LOW and the MARKERS pushbutton to Off.

3. Check Multiburst/Manual Frequency Range and Accuracy

NOTE

The Multiburst/Manual (last burst variable mode) frequency range accuracy check given in the specification was verified using a Hewlett-Packard Gated Counter. The following procedure is an alternate method that utilizes less expensive test equipment. When using the alternate method, perform the high-frequency accuracy checks (parts t and v) within 10 seconds after setting the remote control unit to the Calibrate position. If it is necessary to repeat the check, wait at least 1-1/2 minutes for the TSG6 to stabilize. Checking the accuracy as quickly as possible is particularly important when checking the high-range stop-frequency accuracy in part tof this step.

a. Use the equipment connections as shown in Fig. 2-6A. Leave the Aux Video Out cable from the waveform monitor disconnected at the end as shown in the illustration. Use the same control settings as described in part d of step 1 except as follows:

TSG6

COMPOSITE/ CONTINUOUS FREQUENCY Control

CONTINUOUS

Fully counterclockwise

Sine Wave Generator

Output Frequency

Approximately 3.8 MHz

Waveform Monitor

Display

5 μs/Div

b. Check that the TSG6 FREQUENCY control is set fully counterclockwise and the waveform monitor Line Selector pushbutton switch is set to Variable. Check that the Variable Line Selector control is set to an active line displaying the multiburst signal.

c. Use the remote control unit to enable the last burst variable mode. (1410 mainframe Interface line 56 goes low.)

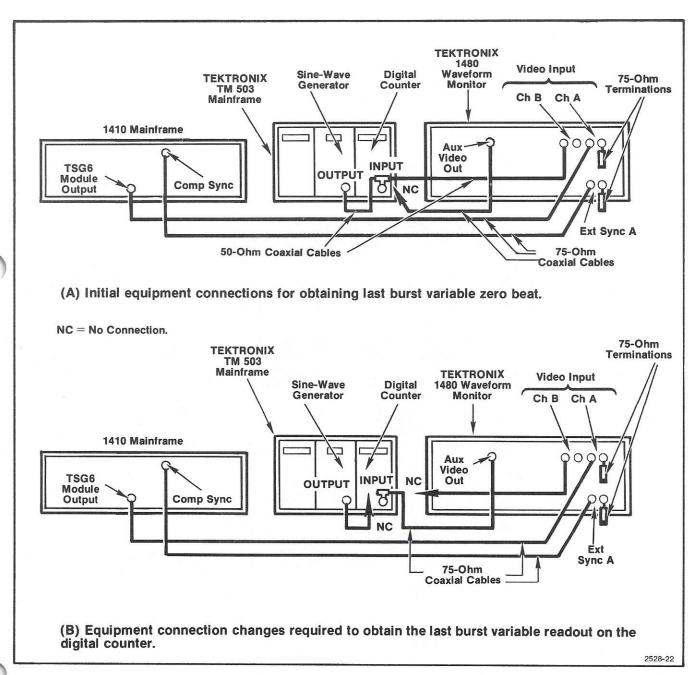


Fig. 2-6. Checking last burst variable frequency and accuracy.

Specification and Performance Check—TSG6

- d. Rotate the sine-wave generator Variable Frequency control until a zero beat is obtained at the location of the last multiburst packet.
- e. CHECK—the last multiburst packet for zero beat at 3.8 MHz or less. Note the frequency readout obtained at zero beat for use in part h of this step.
- f. Disconnect the sine-wave generator output and waveform monitor Ch B video input cables from the bnc T connector adapter as shown in Fig. 2-6B. Connect the 75-ohm coaxial cable from the waveform monitor Aux Video Out connector to the bnc T adapter that is attached to the digital counter input.
- g. Check that the remote control unit is set to the Last Burst Variable position. Set the remote control unit to the Calibrate position also. (1410 mainframe Interface lines 56 and 57 should be low.)
- h. CHECK—that the digital counter readout frequency is within $\pm 0.2\%$ of the frequency noted in part e of this step.
- i. Set the remote control unit Calibrate switch to Off while leaving the Last Burst Variable switch On.
- j. Return the equipment cable connections to the original connections shown in Fig. 2-6A.
- k. Rotate the TSG6 FREQUENCY control fully clockwise. Set the sine-wave generator Variable Frequency control to 4.5 MHz.
- I. CHECK—the last multiburst packet for a zero beat at 4.5 MHz or higher. Note the frequency readout obtained at zero beat for use in part n of this step.
 - m. Repeat parts f and g of this step.
- n. CHECK—that the digital counter readout frequency is within $\pm 0.2\%$ of the frequency noted in part I of this step.
- o. Set the remote control unit Calibrate switch to Off while leaving the Last Burst Variable switch On.
- p. Return the equipment cable connections to the original connections shown in Fig. 2-6A.

- q. Set the TSG6 FREQ RANGE pushbutton to HIGH. Set the sine-wave generator Variable Frequency control to 20 MHz.
- r. CHECK—the last multiburst packet for a zero beat at 20 MHz $\pm 10\%$. Note the frequency readout obtained at zero beat for use in part t of this step.
 - s. Repeat parts f and g of this step.
- t. CHECK—that the digital counter readout frequency is within $\pm 1\%$ of the frequency noted in part r of this step.

IMPORTANT

This check must be made within 10 seconds after setting the remote control unit to the Calibrate mode.

- u. Set the remote control unit Calibrate switch to Off while leaving the Last Burst Variable switch On.
- v. Return the equipment cable connections to the original connections shown in Fig. 2-6A.
- w. Set the TSG6 FREQUENCY control fully counterclockwise. Set the sine-wave generator Variable Frequency control to 14 MHz. Check that the TSG6 FREQ RANGE switch is set to HIGH.
- x. CHECK—the last multiburst packet for a zero beat at 14 MHz or lower. Note the frequency readout obtained at zero beat for use in part z of this step.
 - y. Repeat parts f and g of this step.
- z. CHECK—that the digital counter readout frequency is within $\pm 1\%$ of the frequency noted in part x of this step.
- aa. Set the remote control unit Calibrate and Last Burst Variable switches to Off.
 - ab. Disconnect all the signals.

4. Check Manual Sweep Frequency Range

a. Apply the TSG6 Module Output signal via a 75-ohm coaxial cable and a 75-ohm feed-through termination to the frequency counter input connector.

NOTE

If the TSG6 is VITS keyed (either by the TSP1 or an external signal applied to the 1410 rear-panel Remote connector), set the remote control unit Calibrate switch to On.

b. Set the TSG6 front-panel controls as follows:

FREQ RANGE

LOW

MARKERS

Off

COMPOSITE/

CONTINUOUS

CONTINUOUS

AMPL

FULL

MULTIBURST/SWEEP/

MANUAL

MANUAL

FREQUENCY Control

Fully counterclockwise

BURST

Off

- c. CHECK-for a 100 kHz, or less, frequency readout on the counter.
- d. Rotate the TSG6 FREQUENCY control fully clockwise.
- e. CHECK-for a 6 MHz $\pm 10\%$ or 6.6 MHz to 5.4 MHz readout on the counter.
 - f. Set the TSG6 FREQ RANGE switch to HIGH.
- g. CHECK—for a 20 MHz $\pm 10\%$ or 22 MHz to 18 MHz readout on the counter.
- h. Set the TSG6 FREQUENCY control to its fully counterclockwise position.

- i. CHECK-for a 330 kHz, or less, frequency readout on the counter.
- i. Disconnect the signal from the frequency counter. If the remote control unit Calibrate switch was set to On, set the switch to Off so that Interface line 57 is ungrounded.

5. Check Multiburst and Sweep Signal Amplitudes (Includes Marker, Pedestal Level, Sync, and Burst Amplitudes)

- a. Apply the TSG6 Module Output signal via a 75-ohm coaxial cable to the 1480 Waveform Monitor CH A Video Input connector. Terminate the remaining CH A Video Input connector into 75 ohms.
- b. Set the TSG6 and waveform monitor controls as follows:

TSG6

FREQ RANGE On **MARKERS**

LOW

COMPOSITE/

CONTINUOUS

COMPOSITE

AMPL

FULL

MANUAL

MULTIBURST

FREQUENCY Control

MULTIBURST/SWEEP/

As is

BURST

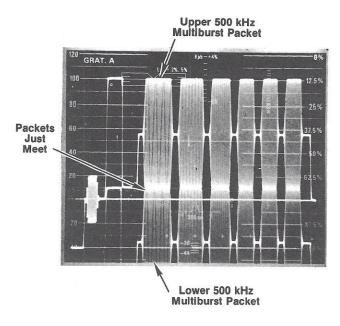
On

1480 Waveform Monitor

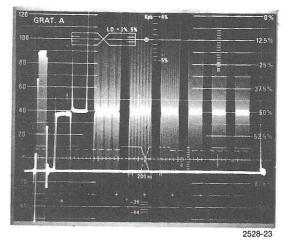
Input	A, DC Coupled
Response	Flat
Volts Full Scale	1.0
DC Restorer	Off
Oper/Cal	Oper
Display	5 μs/Div
Magnifier	X1
Field	1
Line Selector	Off
Sync	Int, AFC

c. Press in the waveform monitor Cal pushbutton while holding the Oper button depressed.

Specification and Performance Check-TSG6



(A) Volts Full Scale switch set to 1.0.



(B) Volts Full Scale switch set to 0.2.

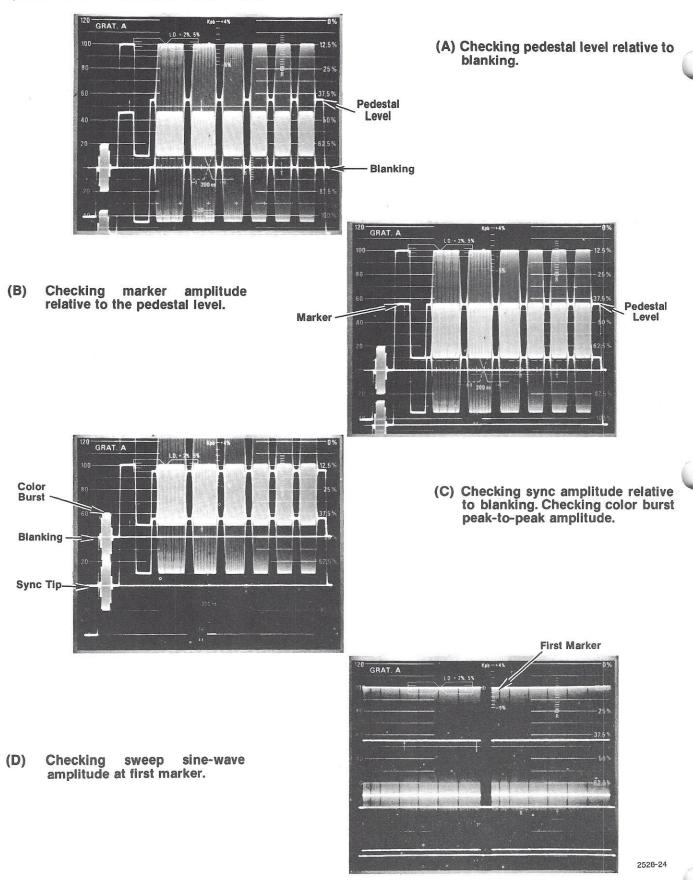
Fig. 2-7. Waveform monitor displays obtained when using the Calibration Fixture to check multiburst amplitude.

- d. Use the Amplitude dial of the Calibration Fixture to match the top of the lower 500 kHz multiburst packet with the bottom of the upper 500 kHz multiburst packet as shown in Fig. 2-7A. Set the waveform monitor Volts Full Scale switch to 0.2 for better resolution (see Fig. 2-7B).
- e. CHECK—Calibration Fixture dial for a 500 kHz multiburst packet amplitude reading of 643 mV peak-to-peak (90 IRE) ± 20 mV.
- f. CHECK—the TSG6 output waveform for the amplitudes given in Table 2-5. Use the technique described in parts d and e of this step. Figs. 2-8A through 2-8D show some typical displays that are obtained when checking the signal amplitudes. The waveform monitor Volts Full Scale switch was set to 1.0 to illustrate the measurement points on these waveforms. After locating the measurement points, the Volts Full Scale switch should be set to 0.2 for optimum resolution when performing the measurement.
- g. Press in the waveform monitor Oper button to release the Cal button.

Table 2-5
CHECK SIGNAL AMPLITUDES

Check	Calibration Fixture Dial	TSG6 Control Settings	
	Reading:	AMPL	FREQ RANGE
Multiburst Amplitude (First Packet Only)			
Full, High Range	643 mV ± 25 mV or 668 mV to 618 mV	FULL	HIGH
Reduced, High Range	428 mV \pm 16 mV or 444 mV to 412 mV	REDUCED	HIGH
Reduced, Low Range	428 mV \pm 12 mV or 440 mV to 416 mV	REDUCED	LOW
Pedestal Level (Relative to Blanking)			
Full (see Fig. 2-8A)	393 mV $\pm 1\%$ or 396.9 mV to 390.1 mV	FULL	LOW or HIGH
Reduced	286 mV \pm 1% or 288.9 mV to 283.1 mV	REDUCED	LOW or HIGH
Marker Amplitude (Relative to Pedestal Level)			
Full (see Fig. 2-8B)	± 321 mV $\pm 1\%$ or ± 324.2 mV to ± 317.8 mV	FULL	LOW or HIGH
Reduced	\pm 214 mV \pm 1% or \pm 216.1 mV to \pm 211.9 mV	REDUCED	LOW or HIGH
Sync Amplitude (Relative to Blanking; see Fig. 2-8C)	-285.7 mV ± 5.7 mV or -291.4 mV to -280 mV	FULL or REDUCED	LOW or HIGH
Color Burst Amplitude (Peak-to-Peak; see Fig. 2-8C)	285.7 mV \pm 8.6 mV or 294.3 mV to 277.1 mV	FULL or REDUCED	LOW or HIGH
Sweep Sine-Wave Amplitude ^a (Measured at First Marker)			
Full, Low Range (see Fig. 2-8D)	643 mV ± 20 mV or 663 mV to 623 mV	FULL	LOW
Full, High Range	643 mV \pm 25 mV or 668 mV to 618 mV	FULL	HIGH
Reduced, High Range	428 mV \pm 16 mV or 444 mV to 412 mV	REDUCED	HIGH
Reduced, Low Range	428 mV ±12 mV or 440 mV to 416 mV	REDUCED	LOW

^aSet the TSG6 MULTIBURST/SWEEP/MANUAL switch to SWEEP. Set the waveform monitor Display switch to 2 Field.



 $\textbf{Fig. 2-8. Typical displays obtained when locating the measurement points and using the \textit{Calibration Fixture to check amplitude}. \\$

6. Check Signal Risetimes

- a. Use the same equipment connections and control settings as described in parts a and b of step 5 except as follows: Set the waveform monitor DC Restorer switch to Slow, Backporch.
- b. To measure risetime, set the waveform monitor Volts Full Scale switch and Variable Volts Full Scale control so that the upper half of the 500 kHz multiburst packet is equivalent to 100 IRE in amplitude.
- c. Set the waveform monitor Magnifier switch to .2. The sweep rate is now 200 ns/div. Use the Vertical and Horizontal Position controls to position the display so that the rising portion of the upper half of the 500 kHz multiburst packet is positioned to the location shown in Fig. 2-9. Note that the rising portion of the multiburst packet is positioned with the pedestal level at -10 IRE and the 90% amplitude point coincides with point R on the short 2 IRE division scale.
- d. Measure the distance from point T on the 0 IRE graticule reference line to where the transition crosses the reference line. This is equivalent to the horizontal distance between the 10% and 90% amplitude points as shown in Fig. 2-9.

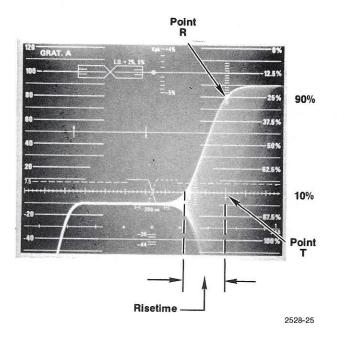


Fig. 2-9. Checking the 500 kHz multiburst packet risetime. Time base: 200 ns/div.

e. CHECK—the first multiburst packet envelope for a risetime of 400 ns ± 60 ns or 460 ns to 340 ns as measured between the 10% and 90% amplitude points.

NOTE

Risetime measurements for the low-frequency range will be the same fc the high-frequency range. Therefore, only the low requency range is checked in this procedure.

- f. Use the waveform monitor controls to position the marker into view. Sut the Variable Volts Full Scale control so that the marker is equivalent to 100 IRE in amplitude as measured from the backporch level to the top of the marker. Set the Magnifier switch to .1 (100 ns/div). Using the technique described in parts c and d of this step, measure the risetime.
- g. CHECK—marker for a risetime of 250 ns ± 50 ns or 300 ns to 200 ns as measured between the 10% and 90% amplitude points.
- h. Set the waveform monitor controls to measure the risetime of the sync pulse.
- i. CHECK—sync for a risetime of 130 ns \pm 20 ns, \pm 10 ns, or 150 ns to 120 ns.
- j. Set the waveform monitor controls to measure the risetime of color burst. Use a 200 ns/div sweep rate.
- k. CHECK—color-burst envelope for a risetime of 400 ns ± 60 ns or 460 ns to 340 ns as measured between the 10% and 90% amplitude points on the upper half of the envelope. Depress the SPG2 Horiz Unlock button while performing this measurement.
 - I. Disconnect the signal from the waveform monitor.

7. Check Color Burst Phase

a. Connect the 1410 rear-panel Subcarrier output J20 signal via a 75-ohm coaxial cable to the 520A Vectorscope Ext CW ϕ Ref connector. Terminate the Ext CW ϕ Ref loop-through connector into 75 ohms. Connect the 1410 rear-panel Subcarrier output J21 signal through a 10X attenuator and a 75-ohm coaxial cable (in that order) to the vectorscope Ch A input connector. Terminate the Ch A loop-through connector into 75 ohms. See Fig. 2-10A.

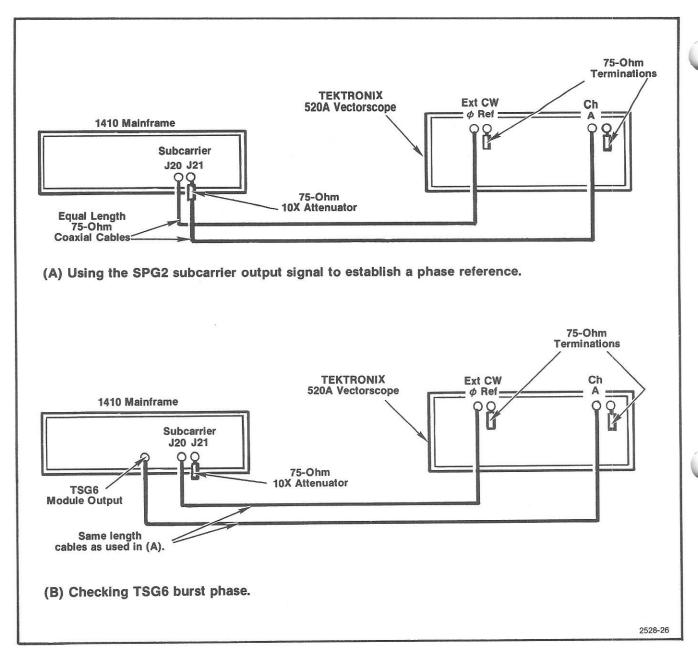


Fig. 2-10. Equipment connections for step 7.

b. Check that the TSG6 front-panel controls are set as follows:

c. Set the 520A Vectorscope controls as follows: Depress the Ch A, Full Field, $A\phi$, and Vector pushbuttons. Set the ϕ Ref switch to Ext. Check that the Ch A Gain control is set to Cal.

FREQ RANGE
MARKERS
On
COMPOSITE/
CONTINUOUS
COMPOSITE
AMPL
MULTIBURST/SWEEP/
MANUAL
FREQUENCY Control
MULTIBURST
As is

On

d. Rotate the vectorscope Ch A Phase control to position the subcarrier vector at 180° for use as a reference.

NOTE

Do not move the Vectorscope Ch A Phase control until completing parts e and f of this step.

BURST

- e. Disconnect the 75-ohm coaxial cable at the 10X attenuator connection. Connect this same cable, without changing its length, to the TSG6 Module Output connector. See Fig. 2-10B.
- f. CHECK—that the TSG6 color-burst vector is at 180° within a tolerance of $\pm 10^{\circ}$. See Fig. 2-11.
 - g. Disconnect the signals applied to the vectorscope.

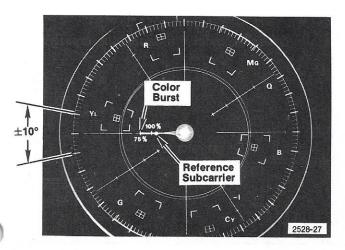


Fig. 2-11. Double-exposure photograph showing color burst in phase with the reference subcarrier.

8. Check Harmonic Distortion

- a. Connect the TSG6 Module Output signal via the 75ohm to 50-ohm minimum loss attenuator and a 50-ohm coaxial cable to the spectrum analyzer RF Input connector.
 - b. Set the TSG6 front-panel controls as follows:

FREQ RANGE LOW **MARKERS** Off

COMPOSITE/

CONTINUOUS CONTINUOUS AMPL **FULL**

MULTIBURST/SWEEP/

MANUAL

MANUAL FREQUENCY Control

100 kHz minimum

BURST

Off

c. Set the spectrum analyzer controls to display the signal at a resolution of 30 kHz. The 7L12 Spectrum Analyzer control settings that follow are given as a guide.

Time/Div switch 2 ms

Freq Span/Div selector

100 kHz (0.1 MHz)

Resolution selector

30 kHz

Center Frequency control

Tune to center the

display

Display Mode

10 dB/Div 20 dB

RF Attenuator selector Gain Selector (Reference

Level)

-10 dBm

P-P Auto & Free Run

buttons

Pressed in

Video Filters 30 kHz

d. CHECK-that harmonic distortion relative to the fundamental is at least -40 dB. See Fig. 2-12. Using this check as a guide, check harmonic distortion relative to the fundamental for the other continuous sine-wave frequencies as follows:

With the TSG6 FREQ RANGE pushbutton set to LOW, harmonic distortion for frequencies from 100 kHz minimum to 300 kHz should be at least -40 dB; above 300 kHz to 4.2 MHz harmonic distortion should be 44 dB; above 4.2 MHz to 6.0 MHz (±10%) harmonic distortion should be at least -40 dB.

e. Set the TSG6 FREQ RANGE pushbuttons to HIGH.

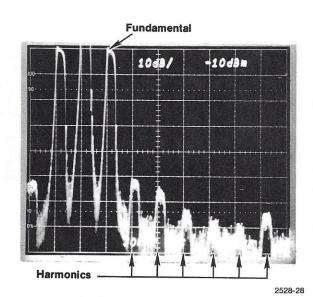


Fig. 2-12. Checking harmonic distortion.

Specification and Performance Check—TSG6

- f. CHECK—that harmonic distortion for frequencies from 330 kHz minimum to 6 MHz is at least -38 dB; above 6 MHz to 20 MHz ($\pm 10\%$) harmonic distortion should be at least -36 dB.
 - g. Disconnect the signal from the spectrum analyzer.

9. Check Sweep Sine-Wave Flatness

NOTE

If the TSG6 meets the performance requirements given in this step, the TSG6 will also meet the multiburst flatness performance requirements.

a. Connect the input of the video detector (item 8) directly to the TSG6 Module Output connector. Connect the output cable from the video detector to the +Input connector on the differential comparator plug-in unit of the test oscilloscope (see Fig. 2-13). Externally trigger the time base using the 1410 mainframe rear-panel V Drive signal.

b. Set the video detector slide switch to the Normal position. Set the TSG6 front-panel controls as follows:

FREQ RANGE HIGH
MARKERS Off
COMPOSITE/
CONTINUOUS CONTINUOUS
AMPL FULL

MULTIBURST/SWEEP/

MANUAL SWEEP FREQUENCY Control As is BURST Off

c. Set the test oscilloscope controls to establish a ground reference at graticule center. Set the differential comparator +Input Mode switch to DC and the -Input Mode switch to Vc. Set the Volts/Div switch to 5 mV and the Time/Div switch to 2 ms. Set the Comparison Voltage (Vc) control to approximately 0.39 V to position the top of the waveform to graticule center as shown in Fig. 2-14A.

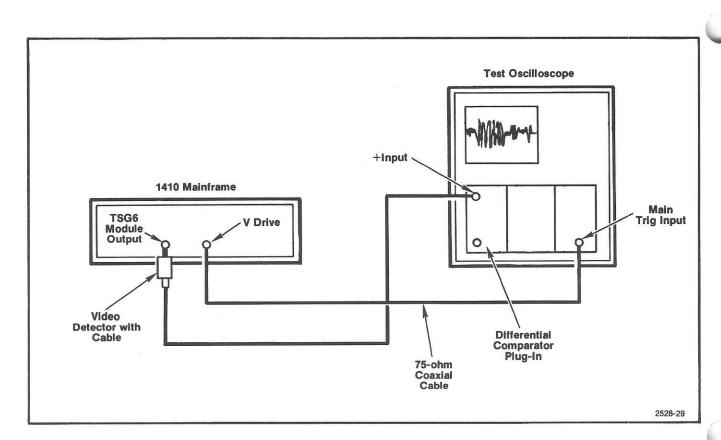
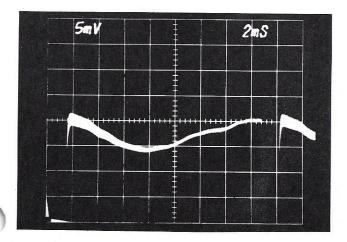
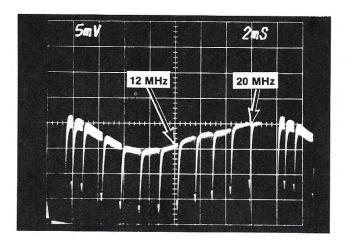


Fig. 2-13. Equipment connections for step 9.

- d. CHECK—for flatness of the brightened top portion of the waveform as follows: Within 15 mV up to a frequency of 12 MHz; within 20 mV above 12 MHz to 20 MHz. To locate the 12 MHz and 20 MHz frequency points, set the TSG6 MARKERS button to On as shown in Fig. 2-14B.
- e. Set the TSG6 FREQ RANGE switch to LOW and the MARKERS button to Off.
 - f. CHECK-that flatness is within 10 mV.



(A) MARKERS button set to Off.



(B) MARKERS button set to On.

2528-30A

Fig. 2-14. Checking sweep sine-wave flatness using a Marconi Video Detector.

- g. Set the TSG6 AMPL button to REDUCED. Set the test oscilloscope differential comparator Voltage (Vc) control to approximately 0.21 V to position the top of the reduced-amplitude waveform to graticule center.
 - h. CHECK-that flatness is within 10 mV.
 - i. Set the TSG6 FREQ RANGE switch to HIGH.
- j. CHECK—that flatness is within 15 mV up to a frequency of 12 MHz; within 20 mV above 12 MHz to 20 MHz. If desired, set the MARKERS button to On to locate the 12 MHz and 20 MHz frequency points.
- k. Disconnect all the signals applied to the test oscilloscope. Disconnect the video detector from the TSG6 Module Output connector.

10. Check Return Loss

Preferred Method

(Using Marconi Test Equipment)

The Preferred Method that was used to verify return loss to 20 MHz utilized the following Marconi test equipment: TM9692 Video Sweep Unit, TF2361 Sweep Generator, TF2907 Differential Probe Unit, and TM9827 Return Loss Probe. The instruction manuals for this equipment describes how to check return loss. If this equipment is not available, use the Alternate Method that follows.

Alternate Method

(Using Tektronix Test Equipment)

Refer to 015-0149-00 Return Loss Bridge instruction manual if detailed information is needed. The following procedure should provide sufficient information for those familiar with return loss measurements.

- a. Connect the 015-0149-00 Return Loss Bridge to the test oscilloscope differential comparator input connectors.
- b. Connect the leveled sine-wave generator output signal via a 50-ohm coaxial cable and a 50-ohm to 75-ohm minimum loss attenuator to the Return Loss Bridge input connector.
- c. Set the leveled sine-wave generator frequency controls for 5 MHz output.

Specification and Performance Check—TSG6

- d. Remove the 75-ohm termination from the Return Loss Bridge Unknown arm. Leave the other arm of the bridge terminated into 75 ohms.
- e. Set the test oscilloscope for dc-coupled differential amplifier mode of operation, Volts/Div switch set to .1 V, and the time base triggering controls for free-running mode of operation.
- f. Adjust the leveled sine-wave generator output amplitude control for 500 mV displayed amplitude.
- g. Reconnect the 75-ohm termination to the Return Loss Bridge Unknown arm.
 - h. Set the test oscilloscope Volts/Div switch to 10 mV.
- i. Adjust the Return Loss Bridge Balance control for minimum display amplitude. Note the amplitude.
- j. Remove the 75-ohm termination from the Return Loss Bridge Unknown arm. Connect the Unknown arm directly to the TSG6 Module Output connector on the 1410 mainframe rear panel.

k. Set the TSG6 controls as follows:

FREQ RANGE LOW
MARKERS Off
COMPOSITE/

CONTINUOUS COMPOSITE

AMPL FULL

MULTIBURST/SWEEP/

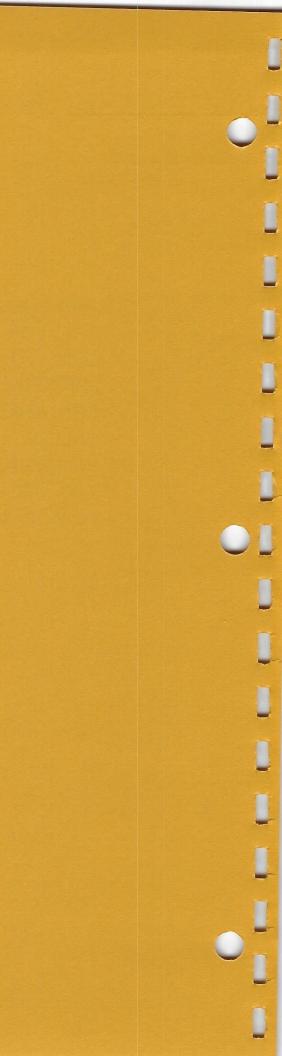
MANUAL MULTIBURST

FREQUENCY Control As is BURST Off

- I. Check that the 1410 mainframe Power switch is set to On.
- m. CHECK—that the amplitude of the sine-wave generator signal component, superimposed on the TSG6 composite video signal, is 16 mV or less in amplitude after subtracting the null amplitude noted in part i of this step. Repeat this check, if desired, at frequencies between 250 kHz to 20 MHz.
- n. Remove the Return Loss Bridge. This completes the Performance Check procedure.

WARNING

THE FOLLOWING SERVICING INSTRUCTIONS ARE FOR USE BY QUALIFIED PERSONNEL ONLY. TO AVOID PERSONAL INJURY, DO NOT PERFORM ANY SERVICING OTHER THAN THAT CONTAINED IN OPERATING INSTRUCTIONS UNLESS YOU ARE QUALIFIED TO DO SO. REFER TO OPERATORS SAFETY SUMMARY AND SERVICE SAFETY SUMMARY PRIOR TO PERFORMING ANY SERVICE.



PART II SERVICE INFORMATION

INSTALLATION

INSTALLING TSG6 IN THE MAINFRAME

Use the following steps to install the TSG6 module in the 1410 mainframe.

CAUTION

Set the 1410 mainframe Power switch to Off before starting the installation.

- 1. Remove the top cover from the mainframe. Remove the plastic spacer bars that hold down the installed modules.
- 2. Select one of the available 1410 module locations for installation. Use Locations 2 through 6 when a dual-width SPG is installed, or Locations 1 through 6 if a single-width SPG is installed. (The factory installs the TSG6 in Location 6 for use with the TSP1. This is the preferred location for the TSG6.) See Fig. 3-1. Remove the blank front panel from this location.
- 3. Check that the jumper connectors on the A60 Multiburst Logic board are positioned to the desired operating mode. Refer to the topic, "Operating Mode Selection" that follows this installation procedure.

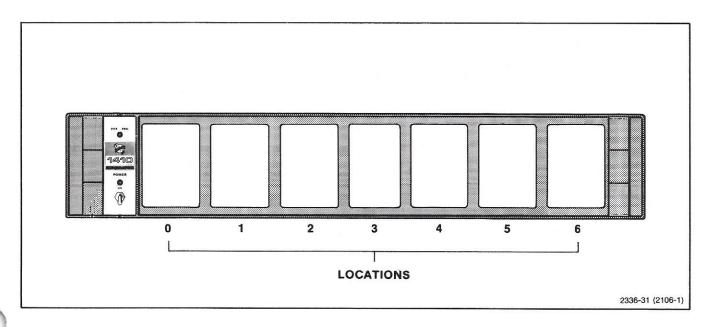


Fig. 3-1. 1410 Generator Module Locations.

- 4. If not already installed, install the plastic pushbutton extenders on the pushbutton shafts of both boards.
- 5. Position the A60 Multiburst Logic board over the right row of the mainframe interface pins at the selected location; for example, P72 at Location 6 as shown in Figs. 3-2 and 3-3. Use the plastic guides for proper pin alignment. Seat the board firmly on the Interface board.

CAUTION

Be sure that all of the pins on the Interface etched circuit board are properly aligned with the connectors on the TSG6. Improper alignment of the pins and connectors can permanently damage the TSG6 connectors.

- 6. Position the A61 Multiburst Output board over the middle row of interface pins; for example, P71 at Location 6 as shown in Figs. 3-2 and 3-3. Use the plastic guides for proper alignment. Seat the board firmly on the Interface board.
- 7. If you have installed the TSG6 to the immediate right of a Tektronix Part No. 670-4451-00 VIRS/Black Burst board (A25), install a shield board on the shield mounting pins located between the VIRS/Black Burst board and the A61 Multiburst Output board. Seat the board firmly on the Interface board.

If the Tektronix Part No. for the A25 VIRS/Black Burst board is 670-4451-01 or higher, do **not** install a shield board.

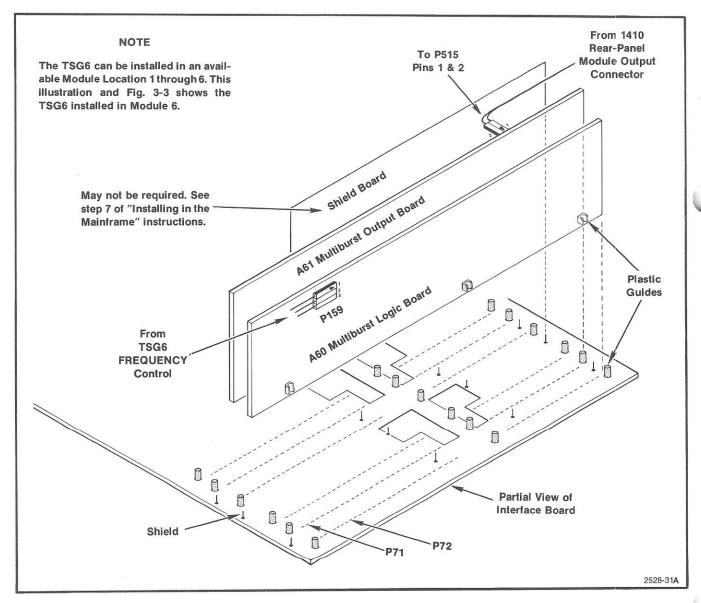


Fig. 3-2. Installing the TSG6 module in the 1410 Generator mainframe.

- 8. Position the TSG6 front panel over the pushbutton extenders and secure the front panel to the 1410 mainframe front casting, using the self-tapping screws provided.
- 9. Connect the TSG6 FREQUENCY control cable multi-pin connector to P159 on the A60 Multiburst Logic board. See Fig. 3-2. Also, refer to Fig. 8-1 in Section 8.
- 10. Connect the appropriate 75-ohm coaxial cable from the 1410 rear-panel Module Output connector to P515, pins 1 and 2, on the A61 Multiburst Output board. See Fig. 3-2. Also, refer to Fig. 8-2 in Section 8.

1410 MAINFRAME POWER SUPPLY MODIFICATION

The power supply in TEKTRONIX 1410 Generator mainframes below SN B010743 may not be capable of handling the requirements of a full complement of modules including the TSG6 NTSC Multiburst & Video Sweep Test Signal Generator. To modify the 1410 mainframe so that the power supply has increased capacity, order the following kit:

1410 Power Supply Field Modification Kit, Tektronix Part No. 040-0898-00.

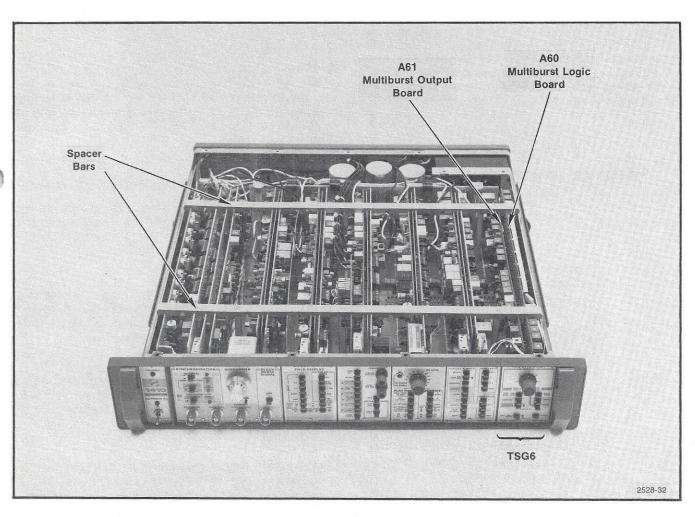


Fig. 3-3. TSG6 module installed.

INSTALLATION ADJUSTMENTS

After the TSG6 is installed in the 1410 mainframe, the Calibration Procedure is Section 4 provides a detailed, logically-sequenced procedure that may have to be performed to check that the TSG6 meets all the published performance requirements.

NOTE

The TSG6 contains many interrelated adjustments. Some of the most important ones are as follows: C336, C383, R138, R139, R309, R319, R349, R359, R369, R379, R389, and R399. If any of these adjustments are inadvertently misadjusted, the TSG6 may have to be recalibrated.

If you prefer to quickly check the TSG6 performance, Table 3-1 lists the minimum checks and readjustments that should be performed after the TSG6 is installed. The step numbers are the same as those used in the Calibration Procedure of Section 4. These steps can be performed without using an Extender board. Refer to the Calibration Procedure for detailed instructions.

Table 3-1
ADJUSTMENTS AFTER INSTALLATION

Step No. (See Calibration Procedure in Section 4)	Instructions
11	Perform parts a through e in Step 11 of the Calibration Procedure. If the 500 kHz multiburst packet is not within the 643 mV peak-to-peak (±20 mV) amplitude requirement, adjust R489 (Master Gain).
14	If R489 in Step 11 is adjusted, adjust R479 (Continuous DC Level) and R278 (Composite Backporch Level).
19	Adjust R439 and R429. These are Reduced and Full Amplitude Pedestal Balance adjustments, respectively.

The following test equipment is needed for performing steps 11, 14, and 19 in the Calibration Procedure of Section 4. Refer to Section 4 for more information about the listed items.

Item No.	Description	
1	TEKTRONIX 1410 Generator Mainframe with SPG2 installed. (The TSG6 to be checked is installed in this mainframe.)	
5	Test Oscilloscope with Vertical Amplifier and Time Base Plug-in Units.	
7	Waveform Monitor.	
16 75-Ohm Feed-Through Termination.		
17 75-Ohm End-Line Termination.		
18 Two 75-Ohm Coaxial Cables.		

OPERATING MODE SELECTION

The TSG6 contains internal jumpers to permit selection of operating modes. Altering an operating mode is accomplished by moving the appropriate jumper connector. The following information describes the operating mode selections. To locate the jumper connectors, refer to the Servicing Illustration, Fig. 8-1, located on a foldout page in Section 8.

Internal Jumpers on A60 Multiburst Logic Board

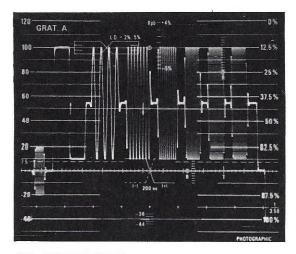
P104, P105, P114, and P115: These jumpers are factory installed to obtain normal operation. Do not move these jumpers until instructed to do so in the Calibration Procedure, Section 4, of this manual.

P132: No jumper is installed. Not needed for normal operation. The Calibration Procedure in Section 4 describes when to move the jumper connector from P104 to P132 for calibration purposes.

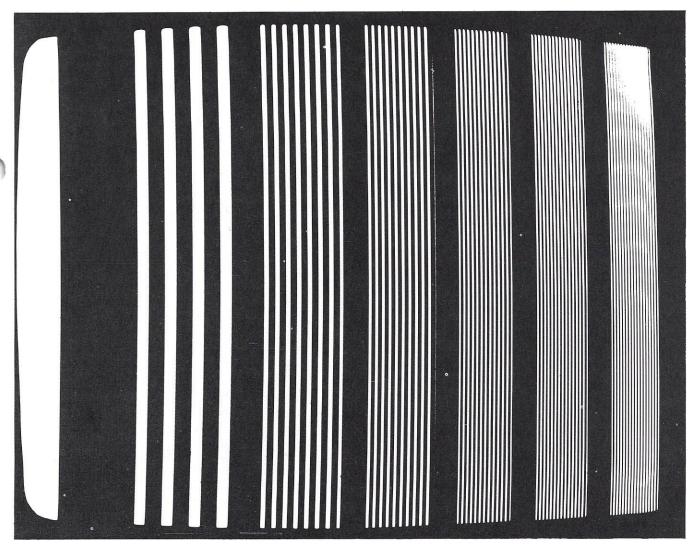
P239: Phase-Slewed Multiburst. Fixed Phase if set to 1 and 2; see Fig. 3-4. Phase Slewed if set to 2 and 3. P239 is normally factory-set to the Phase Slewed position (2 and 3 connected).

P280: Luminance Drive. Risetime is 250 ns if set to 1 and 2; 130 ns if set to 2 and 3. P280 is normally factory-set for 250 ns risetime (1 and 2 connected).

P281: Sync Drive. Risetime is 250 ns if set to 1 and 2; 130 ns if set to 2 and 3. P281 is normally factory-set for 130 ns risetime (2 and 3 connected).



(A) TEKTRONIX 1480 Waveform Monitor display. Sweep rate: 5 μ s/div.



(B) Monochrome picture monitor display.

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Fig. 3-4. TSG6 low range, full amplitude, composite multiburst, burst on, output signal. P239 set to the Fixed Phase position.

Wire Strap Connections for A60 Multiburst Logic Board

W260: This wire strap is connected from 1 to 2 for NTSC operation and should not be moved. (The wire strap is connected between 2 and 3 when the board is used in a TSG16 PAL module.)

Wire Strap Connections for A61 Multiburst Output Board

W400: A wire strap that connects pin 13 of U390 to pin 14 for NTSC operation and should not be moved.

W420: No wire strap is needed for NTSC operation.

Terminating Connector on A61 Multiburst Output Board

P515 (Pins 3 and 4): These pins are the Spare Output connector for the TSG6 module output signal. A multipin connector with a 75-ohm resistor is installed on P515, pins 3 and 4, to terminate the signal when it is not used. If a TSP1 is installed in the 1410 mainframe, the TSP1 input signal cable is connected to the TSG6 Spare Output connector and the multi-pin connector with its terminating resistor is stored on an unused shield pin.

Altering the High-Range Multiburst-Packet Frequencies

The high-range multiburst-packet frequencies are controlled by R107, R115, R117, R125, R127, and R112. These frequency-control resistors are located on the A60 Multiburst Logic board. If it is necessary to alter the multiburst frequencies, refer to the topic, "Frequency Decode Logic", in Section 5, Multiburst Logic (Diagram 1) circuit description for further information.

Altering the Multiburst Packet Widths

A PROM set is available to generate multiburst with six equal 4 μ s duration burst packets. The PROMs in this set replace U121 and U141 on A60 Multiburst Logic board. The PROM set can be obtained by ordering as follows: PROM Set consisting of U121, Tektronix Part No. 160-0220-00, and U141, Tektronix Part No. 160-0222-00.

TSG6 REMOTE FUNCTIONS

Table 3-2 provides the Remote connector J41 information required to perform the TSG6 remote functions. An example is given in the Multiburst description that follows.

Multiburst (Interface Line 55)

The TSG6 front-panel MULTIBURST pushbutton is enabled and the MANUAL and SWEEP pushbuttons are disabled by grounding the appropriate pin at the 1410 rear-panel Remote connector J41. For example, if the TSG6 is installed in Location 6 of the 1410, pin 1 of the Remote connector must be grounded to enable MULTIBURST and disable the MANUAL and SWEEP functions. Grounding pin 1 of J41 grounds 1410 Interface line 55. This Interface line connects to the TSG6 Multiburst Remote enabling circuit on A60 Multiburst Logic board.

Table 3-2
1410 REMOTE CONNECTOR INPUTS

	1410 Remote Connector J41 Pins to 1410 Interface Line			
TSG6 Module Location	Interface Line 55 Multiburst	Interface Line 56 Last Burst	Interface Line 57 Calibrate	Interface Line 19 VITS Key
1	16	17	18	24
2	13	14	15	23
3	10	11	12	22
4	7	8	9	21
5	4	5	6	20
6	1	2	3	19

NOTE

Pin 36 of 1410 Remote Connector is ground.

VITS Key (Interface Line 19)

Normally, the TSG6 uses the vertical blanking signal from the 1410 mainframe to ensure that no test signal is generated during the vertical interval. If a multiburst VITS is desired, the TSG6 can be enabled by grounding the TSG6 Interface line 19 during the active portion of the appropriate television line. See Table 3-1 and the 1410/TSP1 Instruction Manuals for more details.

CALIBRATION

Introduction

This procedure is arranged in a logical sequence to either verify the accuracy of the TSG6 adjustments or to recalibrate the TSG6 after repairs or long periods of operation.

NOTE

This procedure assumes that the internal jumpers are set to their factory-set positions as shown in Figs. 8-1 and 8-2 in Section 8. The SPG2 should be set for internal mode of operation.

Calibration at 20°C to 30°C, with a 20-minute warm-up period, is required to attain stated accuracies. Limits and tolerances appearing in this procedure are calibration guides. They are not performance requirements unless listed in Section 2, Specification.

In the procedure, the TSG6 front-panel names are all capitalized; for example, FREQ RANGE. Controls and connector names for the 1410 mainframe with its SPG2 module and the names for the associated test equipment have only their first letter capitalized; for example, Module Output connector. No capitals are used if a generic term is used when referring to the associated test equipment; for example, set the test oscilloscope time base triggering controls for internal triggering mode of operation.

A short form procedure precedes the Calibration Procedure for use by an experienced calibrator. This procedure can also be used as a calibration record or as an index to the complete procedure.

Test Equipment

The test equipment listed here was used in preparing this procedure. The measurement capabilities described are the minimum required to recalibrate the instrument. Each piece of test equipment is assumed to be operating within its stated specification. If alternative equipment is used, it must meet or exceed these requirements.

 TEKTRONIX 1410 Generator mainframe with a SPG2 NTSC Sync Generator Module. With the TSG6 (to be checked and/or recalibrated) installed in the 1410 mainframe.

- 2. Digital Voltmeter (DVM). 20-volt dc range. 0.1% dc voltage accuracy. For example, a TEKTRONIX DM 501 Digital Multimeter in a TM 503 mainframe.
- 3. Sine Wave Generator. Frequency range, 500 kHz to 20 MHz. Frequency accuracy is not critical since the frequency counter (item 4) is used for the readout. Output amplitude, approximately 200 mV to 300 mV. For example, a TEKTRONIX SG 503 Leveled Sine Wave Generator in a TM 503 mainframe.
- **4. Digital Counter.** Frequency range, 500 kHz to 20 MHz. Display, at least 4 digits. Minimum accuracy, 1%. Sensitivity, 200 mV peak-to-peak. For example, a TEKTRONIX DC 501 Digital Counter in a TM 503 mainframe.

5. Test Oscilloscope.

Dual Time Base. Range from 100 ns/div to 2 ms/div with provisions for delaying sweep.

Differential Comparator. Bandwidth, dc to 75 MHz (including mainframe). Minimum deflection factor, 5 mV/div. Selectable bandwidth, full or 5 MHz.

Dual Trace Amplifier. OPTIONAL: Used if the Marconi Video Detector (item 9) is not available to perform step 21. Bandwidth, dc to 100 MHz, including mainframe. Minimum deflection factor, 200 mV/div. Used as a single-trace amplifier in this procedure.

For example, a TEKTRONIX 7603 Oscilloscope mainframe with 7B53A Dual Time Base, 7A13 Differential Comparator, and 7A26 Dual Trace Amplifier.

- 6. Spectrum Analyzer. Capable of measuring the 2nd through 5th harmonic of 500 kHz, 4 MHz, and 5 MHz signals to -46 dB of the fundamental. For example, a TEKTRONIX 7L12 Spectrum Analyzer in a 7000-Series Oscilloscope mainframe. Can be used with item 5.
- 7. Waveform Monitor. Capable of viewing line-rate and field-rate signals. Includes a magnifier to measure risetime and check wave shape. For example, a TEKTRONIX 1480 NTSC Waveform Monitor with Graticule A.
- **8. Vectorscope.** Capable of measuring phase difference of less than 0.5° between two signals. For example, a TEKTRONIX 520A NTSC Vectorscope.

- **9. Video Detector.** Rectifies and detects the peak amplitude of the applied signal. For example, a Marconi TM9703 Video Detector. If not available, use a 100 MHz bandwidth test oscilloscope.
- 10. 50-Ohm to 75-Ohm Minimum Loss Attenuator. Tektronix Part No. 011-0057-00.
- **11. 50-Ohm End-Line Termination.** Tektronix Part No. 011-0049-01.
- **12. 50-Ohm Coaxial Cable.** Two required. 42 inches long. Tektronix Part No. 012-0057-01.
- 13. 50-Ohm Connector-Adapter Cable. Equipped with a male Peltola connector on one end and a bnc female connector on the other end. Cable is 30 inches long. Tektronix Part No. 067-0709-00.
 - 14. Bnc T Adapter. Tektronix Part No. 103-0030-00.
- **15. 75-Ohm 10X Attenuator.** Tektronix Part No. 011-0061-00.
- **16. 75-Ohm Feed-Through Termination.** Tektronix Part No. 011-0103-00.
- **17. 75-Ohm End-Line Termination.** Two required. Tektronix Part No. 011-0102-00.
- **18. 75-Ohm Coaxial Cable.** Three required. 42 inches long. Tektronix Part No. 012-0074-00.
- 19. Calibration Fixture. For use with the 1480 Waveform Monitor (item 7). Refer to the topics "Calibration Fixture" and "Measurements", that follow this Test Equipment list for a description. See Fig. 2-2 in Section 2 of this manual for a schematic diagram and a parts list.

Calibration Fixture

This fixture and the 1480 Waveform Monitor provide a variable calibration voltage level which can be read directly from a 10-turn dial. The schematic diagram and parts list for the fixture appear in Fig. 2-2 in Section 2. When S1 is in the Variable position, the 1480 calibrator voltage is determined by the circuit in the fixture.

With P9034 connected to J9034 on the 1480, set the fixture S1 to the Fixed position. Push in the 1480 Sync Tip and Cal buttons to display the internal calibrator 1 V square wave. Calibrate the graticule for 1 V. Set the Amplitude dial to 1000 and S1 to Variable. Adjust R3 (CAL), to exactly match the internal 1 V calibrator level. The dial is now calibrated so that each turn of the dial represents 100 mV.

Measurements Using The Calibration Fixture

The signal to be measured must be fed to the 1480 CH A input, and both the OPER and CAL buttons pushed in. Set the DC Restorer button to Off. To check luminance amplitude within a given tolerance, adjust the fixture Amplitude dial while watching the waveform monitor display. When the level being measured overlays the blanking level, read the amplitude directly from the dial.

Peak-to-peak chrominance amplitude can be checked for tolerance by adjusting the fixture Amplitude dial until the peaks of the chrominance packet being measured just meet.

To adjust a signal level, use the Calibration Fixture as a reference. First, set the Amplitude dial to the desired level. Then, for a luminance signal, adjust the proper control so that the signal level overlays the blanking level. For chrominance, adjust for the peaks to just meet.

Extender Board

Use the A2 Extender board, furnished with the 1410 mainframe, whenever it is necessary to obtain easy access to the adjustments and test points on the TSG6 circuit board under test. The boards can be removed without removing the front panel.

SHORT-FORM CALIBRATION PROCEDURE

Refer to Figs. 8-1 and 8-2 in Section 8, Servicing Illustrations, for adjustment and jumper locations.

Table 4-1
TSG6 SHORT FORM CALIBRATION PROCEDURE

Step	Adjustments	Parameter
1	R339	Equal deviation from 3 V measured at pins 3 and 22 of U390.
2	R319 ^a , R309	Even harmonics should be at least 50 dB down relative to the fundamental as measured at J370.

Table 4-1 (cont)

Step	Adjustments	Parameter	
3	R389ª	Top of triangle waveform at $J370$ should be ± 60 mV above ground.	
	R379ª	Bottom of triangle waveform at J370 should be -60 mV below ground.	
4 ^b	R493	Minimum residual subcarrier on backporch.	
5	L535, L537	Best corner on leading edge of negative-going line sync pulse.	
6	L531, L533	Best leading top corner on white reference bar.	
	R439°	Reduced amplitude pedestal segments are all at the same level.	
	R459	Minimum transients between reduced amplitude pedestal segments.	
	R429°	Full amplitude pedestal segments are all at the same level.	
7	L475, L485	Subcarrier harmonics should be at least 30 dB down as displayed on spectrum analyzer. Best phase transient response is displayed on vectorscope.	
8	C224	Burst vector phase matches phase of reference subcarrier.	
	L211	Adjust if C224 has insufficient range.	
9	L471	Best burst shape.	
10	R379, R389 R319	Optimum 2nd through 5th harmonic attenuation at 500 kHz manual mode.	
	C383	Minimum 3rd harmonic at 4 MHz manual mode.	
	R349 ^d	Minimum 2nd harmonic at 4 MHz manual mode.	
11	R489	643 mV (90 IRE) ± 20 mV 500 kHz multiburst packet amplitude. Low-frequency range, full-amplitude, multiburst mode.	
	R442	Burst: 285.7 mV (40 IRE) \pm 8.6 mV peak-to-peak.	
12	R268	Sync: $-285.7~\text{mV}~(-40~\text{IRE}) \pm 5.7~\text{mV}$ from blanking. Low-frequency range, markers on, reduced-amplitude, multiburst mode.	
	R279	Setup: 71.4 mV (10 IRE) \pm 7.1 mV from blanking. Same mode as for \$\mathbb{P}\$268.	

Table 4-1 (cont)

Step	Adjustments	Parameter
	R298	Reduced Pedestal: 214 mV (30 IRE) \pm 2.1 mV from setup. Same mode as for R268.
	R289	Reduced Marker: 214 mV (30 IRE) \pm 2.1 mV from pedestal. Same mode as for R268.
13	R299	Full Pedestal: 321.5 mV (45 IRE) \pm 3.22 mV from setup. Low-frequency range, markers on, full-amplitude, multiburst mode.
	R288	Full Marker: 321.5 mV (45 IRE) \pm 3.22 mV from pedestal. Same mode as for R299.
14	R479	0 V \pm 50 mV dc level between sinewave packets. Low-frequency range, markers on, continuous, full-amplitude sweep mode.
	R278	0 V \pm 50 mV backporch dc level. Same mode as for R479.
15	C336	Same mode as for R479 except use manual operation. Set FREQUENCY control to 3 MHz, set FREQ RANGE button to HIGH, and adjust C336 to obtain 10 MHz \pm 100 kHz output signal.
16	R138	Marker at 500 kHz ±3% within one television line either side of marker in low-frequency range, markers on, composite, full-amplitude sweep mode.
	R139	Marker at 3 MHz $\pm 3\%$ within one television line either side of marker using same mode as for R138.
17	R359	15 MHz $\pm 6\%$ zero beat centered between 14 MHz and 16 MHz markers. Same mode as for R138 except use high-frequency range.
	R369	Marker at 20 MHz $\pm 7\%$. The difference frequency between the 20 MHz and 18 MHz markers must be within 2 MHz ± 400 kHz.
18	R109	500 kHz $\pm 3\%$ in low-frequency range, markers off, continuous, full amplitude, multiburst mode. Jumper moved from P104 to P132.
	R112	1.25 MHz $\pm 3\%$ using high-frequency range mode. Jumpers same as for R109.

Table 4-1 (cont)

Step	Adjustments	Parameter
	R108	1.25 MHz $\pm 3\%$ using same mode as for R109. Jumper moved from P105 to P104.
	R119	2.00 MHz $\pm 3\%$ using same mode as for R109. Jumper moved from P114 to P105.
	R118	3.00 MHz $\pm 3\%$ using same mode as for R109. Jumper moved from P115 to P114.
	R129	3.58 MHz $\pm 3\%$ using same mode as for R109. Jumper moved from P125 to P115.
	R128	4.10 MHz $\pm 3\%$ using same mode as for R109. Jumper moved from P132 to P125.
	R146	6.00 MHz \pm 10% using same mode as for R109 except use manual operation with FREQUENCY control set fully clockwise.
19	R439	Flat pedestal. Low-frequency range, markers off, composite, reduced-amplitude, multiburst mode.
	R429	Flat pedestal. Same mode as for R439 except use full amplitude.
20	R349	Best high-frequency symmetry around pedestal axis. High-frequency range, markers off, composite, full-amplitude, sweep mode.
21	C505	Preferred method using Diode Detector: Equal deviation when observing brightened top portion of waveform. Same mode as for R349 except use continuous sweep. Flatness must be within 15 mV to 12 MHz; within 20 mV to 20 MHz.
		Alternate method response. Same mode as for R349 except use markers on, composite mode.
22	√ Only	Check Isolation: 1% or less.

^{*}Readjusted in step 10.

CALIBRATION PROCEDURE A61 Multiburst Output Board (see Fig. 8-2)

NOTE

The TSG6 contains many interrelated adjustments. Be aware of the interrelationships when performing only part of the Calibration Procedure. This procedure is logically sequenced to minimize interaction.

Preliminary Procedure

- a. Mount the A61 Multiburst Output board on the 1410 Extender board (see Fig. 4-1). Turn on the 1410 mainframe and allow 20 minutes warmup time at $\pm 20^{\circ}$ C to $\pm 30^{\circ}$ C.
- b. Set the 1410 mainframe Power switch to Off. Carefully remove U390 from its socket. Set the 1410 mainframe Power switch to On.

IMPORTANT

Steps 1 through 9 are performed with U390 removed from its socket.

1. Check/Adjust 3.000 V Hybrid Supply Adj (R399)

- a. Check that parts a and b of the Preliminary Procedure have been performed.
- b. Connect a DVM between pins 1 and 3 of U390. Note the voltage deviation from ± 3 V.
- c. Connect the DVM between pins 1 and 22 of U390. Note the voltage deviation from $-3\ V$.
- d. CHECK—for equal deviation from 3 V. For example, if the voltage at pin 3 is ± 3.003 V, the voltage at pin 22 should be ± 2.997 V.
- e. ADJUST—R399 (3.000 V Hybrid Supply Adj) for equal voltage deviation from 3 V as described in parts b through d of this step.
 - f. Disconnect the DVM from the test points.

Steps 4 through 22 use the TSG6 Module Output signal.

Readjusted in step 19.

dReadjusted in step 20.

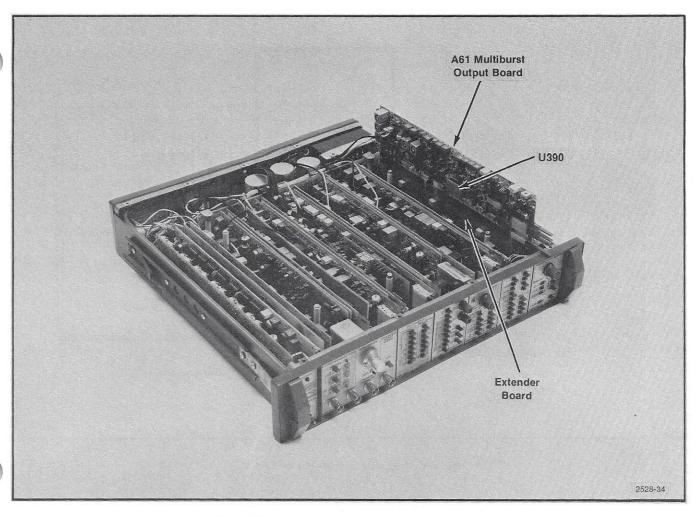


Fig. 4-1. A61 Multiburst Output board mounted on the Extender board.

2. Check/Adjust Symmetry (R319) and Low-Current Symmetry (R309)

- a. Check that parts a and b of the Preliminary Procedure have been performed.
- b. Connect the signal from J370 on the Multiburst Output board via the 50-ohm connector-adapter cable to the spectrum analyzer RF Input connector (see Fig. 4-2).
 - c. Set the TSG6 front-panel controls as follows:

FREQ RANGE **MARKERS** COMPOSITE/

LOW Off

CONTINUOUS

CONTINUOUS

AMPL MULTIBURST/SWEEP/ **FULL**

MANUAL

MANUAL

FREQUENCY Control

Approximately 4 MHz (control set to midrange)

BURST

Off

d. Set the spectrum analyzer controls to display the signal at a resolution of 300 kHz. The 7L12 Spectrum Analyzer control settings that follow are given as a guide.

Time/Div switch Freq Span/Div selector Resolution selector

2 ms 5 MHz 300 kHz

Center Frequency control

Tuned to center the display 10 dB/Div

Display Mode RF Attenuator selector Gain selector

10 dB

(Reference Level) P-P Auto & Free Run

-20 dBm

buttons Video Filters

Pressed in 30 kHz

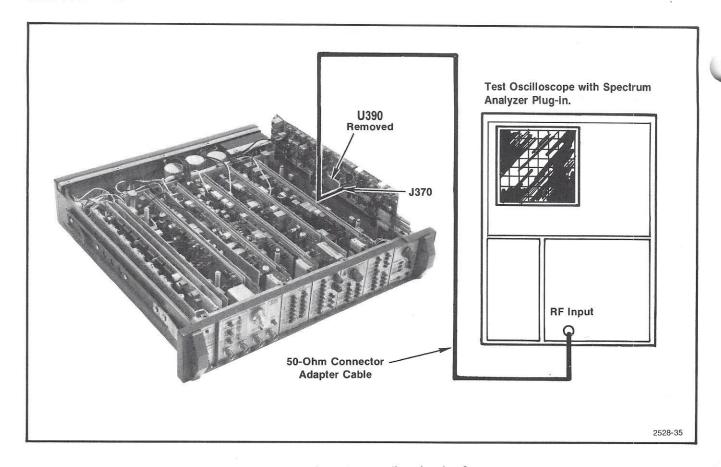


Fig. 4-2. Equipment connections for step 2.

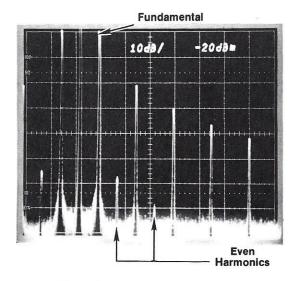
- e. CHECK—that the even harmonics are at least 50 dB down relative to the fundamental. See Fig. 4-3A.
- f. ADJUST—R319 (Symmetry) for minimum even harmonics; -50 dB or less.
- g. Set the TSG6 FREQUENCY control to approximately 100 kHz. Set the spectrum analyzer Frequency Span/Div selector to 100 kHz (0.1 MHz) and the Resolution selector to 30 kHz.
- h. CHECK—that the even harmonics are at least 50 dB down. See Fig. 4-3B.
- i. ADJUST—R309 (Low-Current Symmetry) for minimum even harmonics; -50 dB or less.
- j. Disconnect the signal from the spectrum analyzer. Leave the adapter cable connected to J370.

NOTE

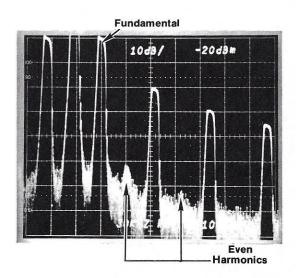
R319, R379, and R389 are readjusted in step 10 to minimize harmonics.

3. Check/Adjust Triangle Amplitude (R389) and Negative-Level Triangle (R379)

- a. Check that parts a and b of the Preliminary Procedure have been performed.
- b. Connect the signal from J370 on the Multiburst Output board via the 50-ohm connector-adapter cable and a 50-ohm termination to the test oscilloscope vertical connector. Use internal triggering for the time base.
- c. Set the TSG6 controls to the same settings as given in part c of step 2 except the FREQUENCY control should remain at approximately 100 kHz. This is the frequency used when completing step 2.



(A) FREQUENCY control set to approximately 4 MHz.



(B) FREQUENCY control set to approximately 100 kHz.

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Fig. 4-3. Spectrum analyzer displays obtained when checking even harmonic attenuation at J370. The TSG6 is operating in the manual mode.

d. CHECK—that the triangle waveform is symmetrical around ground and 80 mV to 120 mV peak-to-peak in amplitude. Figure 4-4 shows a 120 mV peak-to-peak amplitude waveform symmetrical around ground for use as a guide when performing part e of this step.

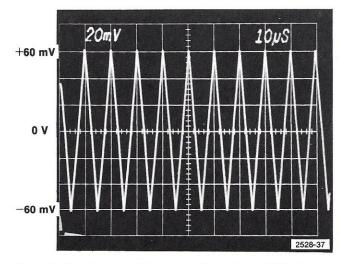


Fig. 4-4. Checking amplitude and dc level of J370 triangle waveform. FREQUENCY control is set to approximately 100 kHz in the manual mode.

CAUTION

Do not perform part e of this step if the signal amplitude is within the 80 mV to 120 mV amplitude range. If R389 and R379 are adjusted, never leave the signal amplitude in excess of +65 mV and -65 mV with respect to ground. This excessive amplitude may damage U390 when U390 is returned to its socket.

- e. ADJUST—if necessary, R389 (Triangle Ampl) so that the top of the triangle waveform is +60 mV above ground. Adjust R379 (Neg Level Triangle) so that the bottom of the triangle waveform is -60 mV below ground as shown in Fig. 4-4.
- f. Disconnect the signal applied to the test oscilloscope. Disconnect the adapter cable from J370.

4. Check/Adjust Residual Subcarrier (R493)

- a. Check that parts a and b of the Preliminary Procedure have been performed.
- b. Apply the TSG6 (Module Output) signal from the 1410 mainframe rear-panel Module Output connector through a 75-ohm coaxial cable to the 1480 Waveform Monitor Ch A Video Input connector. Terminate the other 1480 Ch A Video Input loop-through connector into 75 ohms.

c. Set the TSG6 front-panel controls as follows:

FREQ RANGE LOW **MARKERS** Off

COMPOSITE/

CONTINUOUS COMPOSITE **FULL**

AMPL

MULTIBURST/SWEEP/

MANUAL

FREQUENCY Control BURST

MULTIBURST

As is Off

- d. Set the waveform monitor controls to display the backporch portion of the composite video signal. Set the Volts Full Scale switch to 0.2. Set the Display switch to 10 μ s/Div and the Magnifier switch to 1 (1 μ s/div).
- e. CHECK-for minimum residual subcarrier. See Fig. 4-5.

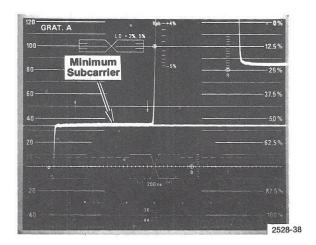


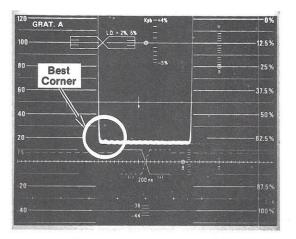
Fig. 4-5. Checking for minimum subcarrier on backporch of TSG6 Module Output signal. BURST pushbutton set to Off.

f. ADJUST-R493 (Residual Subcarrier) for minimum residual subcarrier on the backporch portion of the composite video signal.

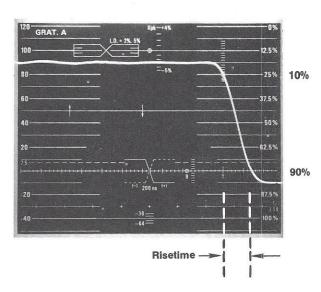
5. Check/Adjust Sync Filter (L535, L537)

- a. Use the same equipment setup and TSG6 control settings as described in parts a through c of step 4.
- b. Check that the waveform monitor Volts Full Scale switch is set to 0.2. Check that the Display and Magnifier switches are set to obtain a 1 µs/div sweep rate. Set the remaining controls to display the horizontal sync pulse portion of the line-rate waveform.
- c. CHECK-for best corner on the leading edge of the sync pulse. See Fig. 4-6A.

- d. ADJUST-L535 and L537 (Sync Filter) for best corner on the leading edge of the sync pulse.
- e. Set the waveform monitor Variable Volts Full Scale control so that the sync pulse displayed amplitude is equivalent to 10 divisions (100 IRE). Set the Magnifier switch to the .1 position (100 ns/div).
- f. CHECK—sync pulse for a risetime of 130 ns, +20 ns -10 ns, as measured between the 10% and 90% amplitude points. See Fig. 4-6B.
- g. Return the waveform monitor Variable Volts Full Scale control to Cal. Set the Volts Full Scale switch to 0.5 and the Magnifier switch to X1.



(A) Checking for best corner.



(B) Checking risetime. Time base: 100 ns/div.

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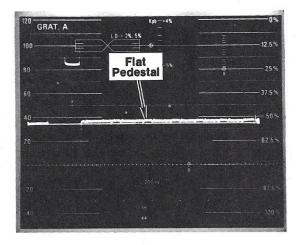
Fig. 4-6. Negative-going horizontal sync pulse.

6. Check/Adjust Luminance Filter (L531, L533), Reduced Amplitude Pedestal Balance (R439), Multiburst Modulator Balance (R459), and Full Amplitude Pedestal Balance (R429)

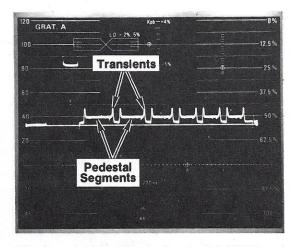
- a. Use the same equipment setup and TSG6 control settings as described in parts a through c of step 4 except as follows: Set the TSG6 AMPL pushbutton to REDUCED.
- b. Set the waveform monitor controls to display the leading top corner of the marker at a sweep rate of 1 μ s/div.
 - c. CHECK—for best leading top corner on the marker.
- d. ADJUST—L531 and L533 (Luminance Filter) for best leading top corner on the marker.
- e. Using the technique described in part e of step 5, set the waveform monitor controls so the marker risetime can be checked.
- f. CHECK—for a risetime of 250 ns ± 50 ns as measured between the 10% and 90% amplitude points.
- g. Set the waveform monitor controls to display the pedestal portion of the waveform. Set the Volts Full Scale switch to 0.2, Variable Volts Full Scale control to Cal, Display switch to 5 μ s/Div, and the Magnifier switch to X1. Check that the Response switch is set to Flat.
 - h. CHECK-for a flat pedestal (see Fig. 4-7A).
- i. ADJUST—R439 (Reduced Ampl Pedestal Bal) to obtain a flat pedestal level. Adjust R459 for minimum transients between pedestal segments. Figure 4-7B shows how the pedestal level becomes distorted when R439 and R459 are misadjusted.
 - j. Set the TSG6 AMPL pushbutton to FULL.
 - k. CHECK-for a flat pedestal.
- I. ADJUST—R429 (Full Ampl Pedestal Bal) to obtain a flat pedestal.

NOTE

To check accuracy of the adjustments, set the AMPL pushbutton to REDUCED and then to FULL. Check for no change in pedestal flatness.



(A) Properly adjusted pedestal.



(B) Improperly adjusted pedestal. R439 and R459 were misadjusted to obtain this waveform.

Fig. 4-7. Checking pedestal flatness in reduced-amplitude composite multiburst mode.

m. Disconnect the signal from the waveform monitor.

7. Check/Adjust Chrominance Bandpass Filter (L475, L485)

- a. Check that parts a and b of the Preliminary Procedure have been performed.
- b. Connect the TSG6 Module Output signal via a 75-ohm coaxial cable to the 520A Vectorscope Ch A input connector. Terminate the other Ch A loop-through connector into 75 ohms.
- c. Disconnect a module output multi-pin connector from an adjacent TSG module and connect this same connector to pins 3 and 4 (Spare Output) of P515 on A61 Multiburst Output board. (In this application, the module output multi-pin connector with its cable is borrowed from the adjacent TSG module. The cable is used to apply the spare signal to one of the 1410 rear-panel Module Output connectors.) Connect this spare TSG6 Module Output signal via a 75-ohm to 50-ohm minimum loss attenuator and a 50-ohm coaxial cable to the spectrum analyzer RF Input connector. See Fig. 4-8.

d. Check that the TSG6 front-panel controls are set as follows:

FREQ RANGE LOW MARKERS Off

COMPOSITE/ CONTINUOUS

ONTINUOUS COMPOSITE
MPL FULL

MULTIBURST/SWEEP/

MANUAL

MULTIBURST

FREQUENCY Control

As is

BURST

On

e. Set the spectrum analyzer controls to display the chrominance (burst) signal using these settings as a guide: Time/Div switch set to 5 ms, Freq Span/Div selector set to 2 MHz, Resolution selector set to 30 kHz, RF Attenuator selector set to 0 dB, and the Gain selector set to -30 dBm reference level.

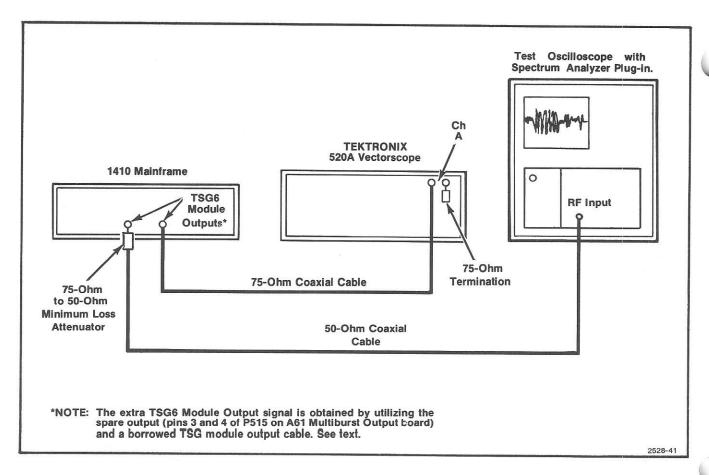
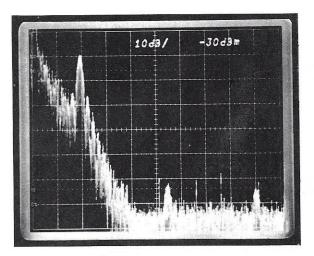
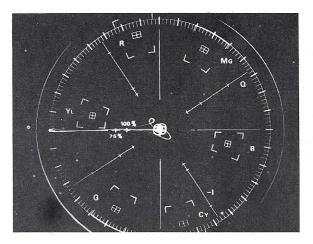


Fig. 4-8. Equipment connections for step 7.

- f. Set the 520A Vectorscope controls as follows: Depress the Ch A, Full Field, A ϕ , and Vector pushbuttons. Check that the ϕ Ref switch is set to Int. Set the Ch A Gain control so that the burst tip reaches the graticule circle. Rotate the Ch A Phase control so that the burst vector is at 180°.
- g. CHECK—that the subcarrierharmonics are at least 30 dB down as displayed on the spectrum analyzer (see Fig. 4-9A). The burst vector, as displayed on the vectorscope, should have good phase transient response; that is, minimum loop opening. See Fig. 4-9B.
- h. ADJUST—L475 and L485 (Chrominance Bandpass Filter) for best harmonic attenuation as displayed on the spectrum analyzer and phase transient response as viewed on the vectorscope.



(A) Checking subcarrier harmonic attenuation.



(B) Checking transient response. 2528-42

Fig. 4-9. Displays obtained when performing step 7.

NOTE

L475 mostly affects phase transient response; L485 mostly affects harmonics. Adjust L485 for equal amplitude 2nd and 3rd harmonics.

i. Disconnect the signals applied to the spectrum analyzer and vectorscope. Disconnect the borrowed multi-pin connector, with attached cable, from pins 3 and 4 of P515. Reconnect this cable to its original connector on the adjacent TSG module.

8. Check/Adjust Burst Phase (C224, L211)

- a. Check that parts a and b of the Preliminary Procedure have been performed.
- b. Connect the 1410 rear-panel Subcarrier output J20 signal via a 75-ohm coaxial cable to the 520A Vectorscope Ext CW ϕ Ref connector. Terminate the other Ext CW ϕ Ref loop-through connector into 75 ohms. Connect the 1410 rear-panel Subcarrier output J21 signal through a 10X attenuator and a 75-ohm cable (in that order) to the vectorscope Ch A input connector. Terminate the other Ch A loop-through connector into 75 ohms. See Fig. 4-10A.
- c. Check that the TSG6 front-panel controls are set to the same settings as given in part d of step 7.
- d. Check that the vectorscope controls are set to the same positions as described in part f of step 7 except set the Ch A Gain control to Cal and the ϕ Ref switch to Ext.
- e. Rotate the vectorscope Ch A Phase control to position the subcarrier vector at 180° for use as a reference.

NOTE

Do not move the vectorscope Ch A Phase control until completing parts f through h of this step.

- f. Disconnect the 75-ohm coaxial cable at the 10X attenuator connection. Connect this same cable, without changing its length, to the TSG6 Module Output connector so that the TSG6 signal is applied to the vectorscope Ch A input connector. See Fig. 4-10B.
- g. CHECK—that the TSG6 color burst vector is at 180° within a tolerance of $\pm 10\%$ (see Fig. 2-11 in Section 2). The TSG6 color burst phase should be the same as the subcarrier phase used as a reference in part e of this step.

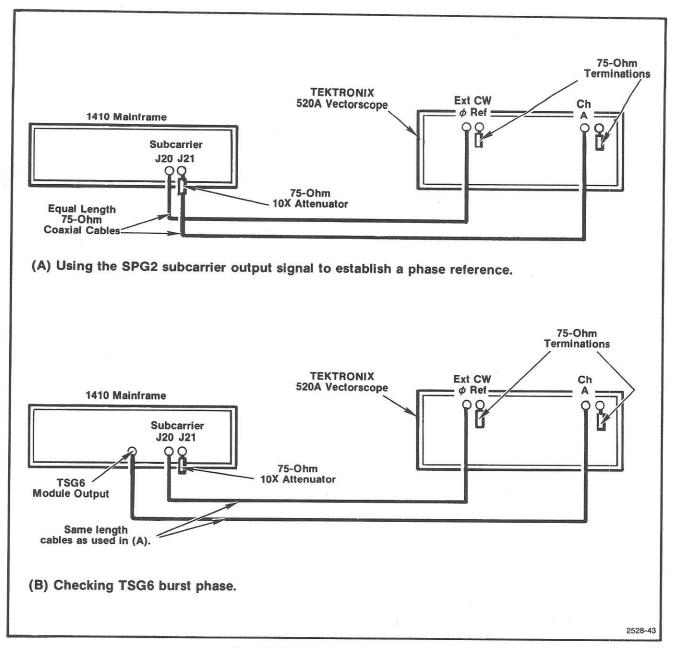


Fig. 4-10. Equipment connections for step 8.

h. ADJUST—C224 (Burst Phase) to obtain the same phase as the reference subcarrier. Location of C224 is on A60 Multiburst Logic board (see Fig. 8-1). This adjustment is accessible without using the Extender board.

NOTE

If C224 has insufficient range, set the 1410 mainframe Power switch to Off, place the A60 Multiburst Logic board on the 1410 Extender. Reinstall A61 Multiburst Output board in the 1410 mainframe. Set the 1410 mainframe Power switch to On, set C224 to the center of its range, and adjust L211 to obtain the same phase as the reference subcarrier. Set the 1410 Power switch to Off, mount the A60 board in the mainframe. Set the 1410 Power switch to On.

i. Disconnect the signals applied to the vectorscope.

9. Check/Adjust Burst Shape (L471)

- a. Check that parts a and b of the Preliminary Procedure have been performed.
- b. Connect the TSG6 Module Output signal via a 75ohm coaxial cable to the 1480 Waveform Monitor Ch A Video Input connector. Terminate the other Ch A loopthrough connector into 75 ohms.
- c. Check that the TSG6 front-panel controls are set to the same settings as described in part d of step 7.
- d. Set the 1480 Waveform Monitor controls to display the back porch portion of the composite video signal. Use these settings: input switch set to A, Dc-Coupled; Response switch set to Flat; DC Restorer switch set to Slow, Backporch; Volts Full Scale switch set to 0.2; Display switch set to 10 μ s/Div; Magnifier switch set to the 0.5 position.
- e. CHECK-for best burst shape while depressing the SPG2 Horiz Unlock button. The shape of the burst envelope should appear similar to the waveform shown in Fig. 4-11.

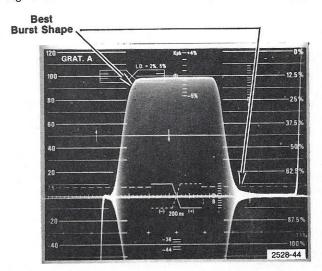


Fig. 4-11. Checking color burst shape. Waveform monitor Volts Full Scale switch set to 0.2.

- f. Adjust-L471 (Burst Shape) for best leading corners while depressing the SPG2 Horiz Unlock button. Also, check that L471 is adjusted for best trailing edge as the burst packet approaches zero.
- g. Set the waveform monitor Magnifier switch to 0.2 (200 ns/div). Set the remaining appropriate waveform monitor controls to perform a burst envelope risetime measurement.

- h. CHECK-burst envelope for a risetime of 400 ns \pm 60 ns as measured between the 10% and 90% amplitude points on the upper half of the envelope. Depress the SPG2 Horiz Unlock button while performing the measurement.
 - i. Disconnect the signal from the waveform monitor.
- j. Set the 1410 mainframe Power switch to Off and insert U390 into its socket. Remove the Extender board and install the A61 Multiburst Output board in the 1410 mainframe. Set the 1410 Power switch to On.
- 10. Check/Adjust Negative Level Triangle (R379), Triangle Amplitude (R389), Delay Compensation (C383), High-Frequency Even Harmonics (R349), and Symmetry (R319)
 - a. Check that part j of step 9 has been performed.
- b. Connect the TSG6 Module Output signal via a 75ohm to 50-ohm minimum loss attenuator and a 50-ohm coaxial cable to the spectrum analyzer RF Input connector.
 - c. Set the TSG6 front-panel controls as follows:

LOW FREQ RANGE Off **MARKERS**

COMPOSITE/

CONTINUOUS CONTINUOUS **FULL** AMPI

MULTIBURST/SWEEP/

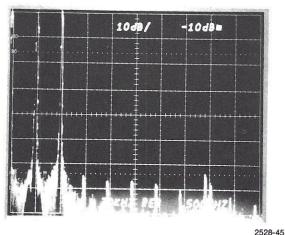
MANUAL MANUAL

Approximately 500 kHz **FREQUENCY Control**

BURST

Off

- d. Set the spectrum analyzer controls to display the signal at 30 kHz resolution, 500 kHz/div, and -10 dBm. Set the RF Attenuator selector to 20 dB.
- e. CHECK-for maximum 2nd through 5th harmonic attenuation. See Fig. 4-12.
- f. READJUST-R379 and R389 for optimum harmonic attenuation. Repeat these adjustments, as necessary, to minimize the harmonics.
- g. Set the TSG6 FREQUENCY control to approximately 4 MHz. Set the spectrum analyzer controls to display the signal at 300 kHz resolution and 2 MHz/div.



2528

Fig. 4-12. Checking harmonic attenuation in continuous manual mode. TSG6 FREQUENCY control set to approximately 500 kHz.

- h. CHECK—for maximum 2nd and 3rd harmonic attenuation.
- i. ADJUST—C383 (Delay Comp) to minimize the 3rd harmonic. Adjust R349 (HF Even Harmonics) to minimize the 2nd harmonic.
- j. READJUST—if the 2nd harmonic is greater in absolute amplitude than the 3rd harmonic, readjust R319 so the 2nd harmonic attenuation is equal to the 3rd harmonic.

NOTE

If R319 is readjusted, set the TSG6 FREQUENCY control to 500 kHz and repeat part e of this step.

k. Disconnect the signal from the spectrum analyzer.

11. Check/Adjust Master Gain (R489)

a. Connect the TSG6 Module Output signal via a 75-ohm coaxial cable to the 1480 Waveform Monitor Ch A Video Input connector. Terminate the other Ch A loop-through connector into 75 ohms.

b. Set the TSG6 front-panel controls as follows:

FREQ RANGE LOW

MARKERS On

COMPOSITE/
CONTINUOUS COMPOSITE

AMPL FULL

MULTIBURST/SWEEP/
MANUAL MULTIBURST

FREQUENCY Control A

MULTIBURST As is

BURST Off

- c. Set the 1480 Waveform Monitor controls as follows: Input switch set to A, Dc-Coupled, Response switch set to Flat, Volts Full Scale switch set to 0.2, DC Restorer button to Off, Display switch set to 10 μ s/Div, and Magnifier switch set to X1. Press in the Cal button while holding the Oper button depressed.
- d. Use the Amplitude dial of the Calibration Fixture to match the top of the lower 500-kHz multiburst packet with the bottom of the upper 500-kHz multiburst packet. (Fig. 2-7 in Section 2 illustrates this technique.)
- e. CHECK—for a 500 kHz multiburst packet amplitude of 643 mV peak-to-peak (90 IRE) ± 20 mV.
- f. ADJUST—R489 (Master Gain) for 643 mV peak-topeak 500-kHz multiburst packet amplitude.

A60 Multiburst Logic Board (see Fig. 8-1)

The following Calibration Procedure for the A60 board also includes instructions for adjusting C336, C505, R349, R359, R369, R429, R442, and R479 that are located on the A61 Multiburst Output board. The A61 board adjustments are accessible without using an extender.

- 12. Check/Adjust Burst Amplitude (R442), Sync Amplitude (R268), Setup Amplitude (R279), Reduced Pedestal Amplitude (R298), and Reduced Marker Amplitude (R289)
- a. Use the same equipment connections as described in part a of step 11.

b. Set the TSG6 front-panel controls as follows:

FREQ RANGE LOW MARKERS On

COMPOSITE/

CONTINUOUS COMPOSITE AMPL REDUCED

MULTIBURST/SWEEP/

MANUAL

MULTIBURST

FREQUENCY Control BURST

As is On

- c. Check that the waveform monitor controls are set the same as described in part c of step 11.
- d. Use the Amplitude dial of the Calibration Fixture to match the top of the lower burst envelope with the bottom of the upper burst envelope (see Fig. 4-13A).
- e. CHECK—Calibration Fixture dial for a burst amplitude reading of 285.7 mV (40 IRE) ± 8.6 mV peak-topeak.
- f. ADJUST—R442 (Burst Ampl) for a burst amplitude of 285.7 mV peak-to-peak.
 - g. Set the TSG6 BURST button to Off if desired.
- h. CHECK—the TSG6 output waveform for the amplitudes that follow. Use the Calibration Fixture to perform the measurements. Use Fig. 4-13 to identify the points on the waveform to be measured. Be sure to set the waveform monitor Volts Full Scale switch to 0.2 for optimum measurement resolution.

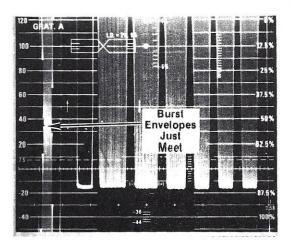
Sync: $-285.7 \text{ mV} (-40 \text{ IRE}) \pm 5.7 \text{ mV}$ from blanking.

Setup: 71.4 mV (10 IRE) \pm 7.1 mV from blanking.

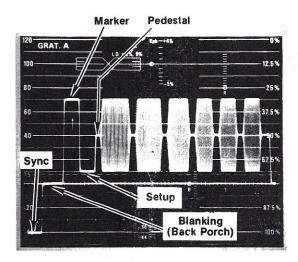
Reduced Pedestal: 214 mV (30 IRE) \pm 2.1 mV from setup.

Reduced Marker: 214 mV (30 IRE) \pm 2.1 mV from the pedestal.

i. ADJUST—R268 (Sync Ampl), R279 (Setup Ampl), R298 (Reduced Pedestal Ampl), and R289 (Reduced Marker Ampl) to obtain the respective amplitudes described in part h of this step.



(A) Checking burst amplitude. TSG6
BURST button set to On. Waveform
monitor Volts Full Scale switch set to
0.2.



(B) Identifying the points on the waveform to be measured in parts h and i of step 12. TSG6 BURST button set to Off and waveform monitor Volts Full Scale switch set to 1.0 for this illustration. 2528-46

Fig. 4-13. Checking the TSG6 output waveform amplitudes.

13. Check/Adjust Full Pedestal Amplifude (R299) and Full Marker Amplitude (R288)

a. Use the same equipment connections as described in part a of step 11.

b. Check that the TSG6 front-panel controls are set to the same positions as given in part b of step 12 except set the AMPL pushbutton to FULL. The BURST pushbutton can be set to either On or Off.

Calibration—TSG6

c. CHECK—the TSG6 output waveform for the amplitudes that follow. Use the technique described in step 11 to make the measurement.

Full Pedestal: 321.5 mV (45 IRE) \pm 3.22 mV from setup.

Full Marker: 321.5 mV (45 IRE) $\pm 3.22 \ \text{mV}$ from pedestal.

- d. ADJUST—R299 (Full Pedestal Ampl) and R288 (Full Marker Ampl) to obtain the respective amplitudes given in part c of this step.
- e. Press in the waveform monitor Oper button to release the Cal button. Set the DC Restorer switch to Slow. Disconnect the signal from the waveform monitor.

14. Check/Adjust Continuous DC Level (R479) and Composite Backporch Level (R278)

- a. Apply the TSG6 Module Output signal via a 75-ohm coaxial cable and a 75-ohm feed-through termination to the test oscilloscope vertical input connector. Externally trigger the time base using the 1410 rear-panel V Drive signal.
 - b. Set the TSG6 front-panel controls as follows:

FREQ RANGE

LOW

MARKERS

On

COMPOSITE/

CONTINUOUS

CONTINUOUS

AMPI

FULL

MULTIBURST/SWEEP/

MANUAL

SWEEP

FREQUENCY Control

As is

BURST

Off

- c. Set the test oscilloscope Vertical Input switch to Gnd, Volts/Div switch to 50 mV, the Time/Div switch to 5 ms, and position the trace to graticule center.
- d. Change the test oscilloscope Vertical Input switch to DC.
- e. CHECK—that the dc level between the sine-wave packets is at 0 V ± 50 mV.
- f. ADJUST—R479 (Cont DC Level; see Fig. 8-2) so that the dc level between sine-wave packets is at 0 V dc.

- g. Set the TSG6 MULTIBURST/SWEEP/MANUAL switch to MULTIBURST.
- h. Use the 1410 rear-panel H Drive signal to externally trigger the test oscilloscope time base. Set the test oscilloscope controls to display the waveform at 10 μ s/div.
- i. CHECK—that the backporch or blanking level is at 0 V dc ± 50 mV.
- j. ADJUST—R278 (Comp Backporch Level) for 0 V dc backporch level.
- k. Disconnect the signals applied to the test oscilloscope.

15. Check/Adjust Hi/Lo Range Ratio (C336)

- a. Apply the TSG6 Module Output signal via a 75-ohm coaxial cable and a 75-ohm feed-through termination to the frequency counter input connector.
- b. Set the TSG6 front-panel controls to the same settings as given in part b of step 14 except set the MULTIBURST/SWEEP/MANUAL switch to MANUAL.

NOTE

If the TSG6 is VITS keyed (either by the TSP1 or an external signal applied to the 1410 rear-panel Remote connector), it is necessary to ground Interface line 57. This is accomplished by using one of the following methods: (1) Set the remote control unit Calibrate switch to On; (2) If the remote control unit is not available or not connected to the 1410 rearpanel Remote connector, connect pin 57 on the Interface board to ground, or (3) connect test point 57 on the Extender board to ground.

- c. Set the TSG6 FREQUENCY control to obtain a readout of 3.00 MHz on the counter and then set the FREQ RANGE pushbutton to HIGH.
- d. CHECK—for a 9.90 MHz to 10.10 MHz readout on the counter.
- e. ADJUST—C336 (Hi/Lo Range Ratio) to obtain 10.00 MHz readout on the counter.

f. INTERACTION—Set the FREQ RANGE pushbutton to LOW and repeat parts c and d of this step to obtain the proper ratio.

g. Disconnect the signal applied to the counter. Unground Interface line 57 if it was grounded.

16. Check/Adjust Sweep Start Frequency (R138) and Field Sweep Rate (R139)

a. Apply the TSG6 Module Output signal via a 75-ohm coaxial cable to the 1480 Waveform Monitor Ch A Video Input connector. Terminate the remaining Ch A Video Input connector into 75 ohms.

b. Connect the output signal from the sine-wave generator via a 50-ohm coaxial cable to a bnc T adapter. Connect the bnc T adapter to the digital counter input connector. Connect another 50-ohm coaxial cable from the bnc T connector to the 1480 Waveform Monitor Ch B Video Input connector. Leave the other Ch B connector unterminated. See Fig. 4-14.

c. Connect the 1410 mainframe or SPG2 Comp Sync signal via a 75-ohm coaxial cable to the 1480 Waveform Monitor Ch A External Sync input connector. Terminate the other loop-through connector into 75 ohms.

d. Set the TSG6 and test equipment controls as follows:

TSG6

FREQ RANGE LOW MARKERS On

COMPOSITE/

CONTINUOUS COMPOSITE AMPL FULL

MULTIBURST/SWEEP/

MANUAL SWEEP
FREQUENCY Control As is
BURST Off

Sine Wave Generator

Output Frequency 500 kHz

Output Amplitude Approximately 200 mV

(28 IRE)

1480 Waveform Monitor

Input A-B, DC-Coupled
Response Flat
Volts Full Scale 1.0
DC Restorer Off, Backporch
Oper/Cal Oper
Display 2 Field
Magnifier X1

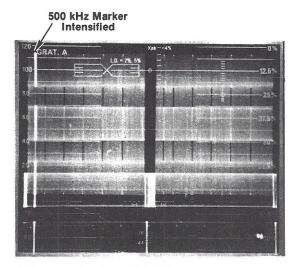
Field 1
Line Selector Variable
Sync Ext, AFC

TEKTRONIX TM 503 Mainframe Sine-Wave **TEKTRONIX 1480** Video Input Generator **Waveform Monitor** Digital Counter Ch B Ch A 1410 Mainframe TSG6 Comp Sync Module Input Output Output ਰ 75-Ohm Ext Sync A Terminations 50-Ohm Coaxial 75-Ohm Coaxial Cables Cables 2528-47

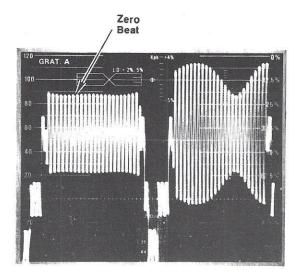
Fig. 4-14. Equipment connections for step 16.

Calibration-TSG6

- e. Set the waveform monitor Variable Line Selector control to intensify the first marker (500 kHz) as shown in Fig. 4-15A. Set the Display switch to 10 μ s/Div and note the marker location on the waveform monitor display.
- f. Set the TSG6 MARKERS button to Off. Slowly rotate the sine-wave generator Variable Frequency control until a null or zero beat is obtained at the location of the 500-kHz marker (see Fig. 4-15B).



(A) Locating the 500 kHz marker.
Waveform monitor Display switch set to 2 Field.



(B) Zero beat at 500 kHz marker location.
Display switch set to 10 μs/Div and
TSG6 MARKERS button set to Off. 2528-48

Fig. 4-15. Typical waveforms obtained when checking 500 kHz marker frequency. Waveform monitor Input switch set to A-B, DC Coupled.

- g. CHECK—for a digital counter readout of 500 kHz, $\pm 3\%$ or 515 kHz to 485 kHz, within one television line either side of the marker. For example, if the readout is 516 kHz at the marker location, obtain a zero beat on the television line located to the left of the marker. Then, obtain a zero beat on the television line to the right of the marker. (The TSG6 MARKERS button can be set to On while making these checks.) If the readout is 515 kHz or lower at one of these television line locations, the marker meets the performance requirement.
- h. Set the TSG6 MARKERS button to Off. Set the sinewave generator for an output frequency of 500 kHz.
- i. ADJUST—R138 (Sweep Start Freq) for a zero beat at the location of the 500 kHz marker.
- j. Set the TSG6 MARKERS button to On. Set the waveform monitor Display switch to 2 Field.
- k. Set the sine-wave generator to 3.0 MHz. Using the same technique as described in part e of this step, set the waveform monitor Variable Line Selector control to intensify the 4th marker (3.0 MHz). Set the Display switch to 10 μ s/Div and note the location of the marker on the waveform monitor display.
- I. Set the TSG6 MARKERS button to Off. Slowly rotate the sine-wave generator Variable Frequency control to obtain a zero beat at the 3.0 MHz marker location.
- m. CHECK—for a digital counter readout of 3.0 MHz, $\pm 3\%$ or 3.09 MHz to 2.91 MHz, within one television line either side of the marker.
- n. Set the sine-wave generator for an output frequency of 3 MHz. Check that the TSG6 MARKERS button is set to Off.
- o. ADJUST—R139 (Field Sweep Rate) for a zero beat at the location of the 3 MHz marker.
- q. INTERACTION—Set the sine-wave generator to 500 kHz and repeat parts e, h, i, j, k, n, and o, until R138 and R139 are properly adjusted.

17. Check/Adjust High-Range Linearity (R359, R369)

- a. Use the same equipment connections as described in parts a through c of step 16 and as shown in Fig. 4-14.
- b. Set the TSG6 and test equipment controls to the same settings given in part d of step 16 except as follows:

TSG6

FREQ RANGE

HIGH

Sine Wave Generator

Output Frequency

15 MHz

c. Set the waveform monitor Variable Line Selector control to intensify the portion of the display centered between the 14 MHz and 16 MHz markers as shown in Fig. 4-16.

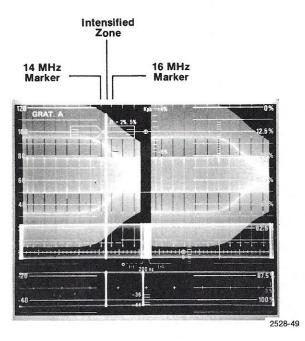


Fig. 4-16. Intensified zone centered between the 14 MHz and 15 MHz markers. Waveform monitor Input switch set to A-B, DC Coupled; Display switch set to 2 Field.

- d. Set the waveform monitor Magnifier switch to X10 or X20 and recheck that the intensified zone is centered as closely as possible between the 14 MHz and 16 MHz markers.
- e. CHECK—for a zero beat centered between the 14 MHz and 16 MHz markers. To observe the zero beat,

you may prefer to depress the Line Selector Digital button so that the intensified zone is not present. Requirement is 15 MHz, $\pm 6\%$ or 15.9 MHz to 14.1 MHz.

- f. Set the sine-wave generator so that the output frequency is exactly 15 MHz.
- g. ADJUST—if necessary, R359 (High Range Linearity; see Fig. 8-2) to obtain a 15 MHz zero beat at a point centered between the 14 MHz and 16 MHz markers.
- h. Set the sine-wave generator output frequency to 20 MHz.
- i. Use the waveform monitor Horizontal Position control to position the last marker (20 MHz) into view. Check that the Line Selector Variable button is pressed in. Set the Variable Line Selector control to intensify the 20 MHz marker. Set the TSG6 MARKERS button to Off.
- j. CHECK—for a zero beat at the 20 MHz marker location. Requirement is 20 MHz, $\pm 7\%$ or 21.4 MHz to 18.6 MHz. The difference frequency between the 20 MHz and 18 MHz markers must be within 2 MHz ± 400 kHz.
- k. Set the sine-wave generator for an output frequency of 20 MHz.
- I. ADJUST—R369 (High Range Linearity; see Fig. 8-2) for zero beat at the 20 MHz marker location.
- m. Disconnect all the signals applied to the test equipment.
- 18. Check/Adjust Low-Range Multiburst Frequencies (R109, R108, R119, R118, R129, R128), 1.25 MHz Range (R112), and Manual Stop Frequency (R146)

NOTE

It is possible to perform the following step without using the Extender board. That is, the jumpers can be moved without removing the A60 Multiburst Logic board. If the Extender is not used, omit parts a and j of the following step.

a. Set the 1410 mainframe Power switch to Off. Mount the A60 Multiburst Logic board on the Extender. Set the 1410 mainframe Power switch to On.

Calibration—TSG6

- b. Connect the TSG6 Module Output signal via a 75-ohm coaxial cable and a 75-ohm feed-through termination to the frequency counter.
 - c. Set the TSG6 front-panel controls as follows:

FREQ RANGE

LOW

MARKERS

Off

COMPOSITE/ CONTINUOUS

CONTINUOUS

AMPL

FULL

MULTIBURST/SWEEP/

MANUAL

MULTIBURST

FREQUENCY Control

6 MHz (fully cw)

BURST

Off

d. Connect Interface line 57 to ground. To accomplish this, use one of the three methods described in the NOTE in part b of step 15. Grounding Interface line 57 changes the TSG6 Module Output multiburst signal to a continuous sine-wave signal for driving the digital counter.

- e. Remove the jumper from P104; connect this jumper to P132. Leave jumpers intalled on P105, P114, P115, P125, and P132 until instructed to move them in part h, Table 4-2, of this procedure.
- f. CHECK—for a 500-kHz, $\pm 3\%$, or 515-kHz to 485-kHz readout on the digital counter.
- g. ADJUST—R109 (500 kHz) for a readout of 500 kHz on the digital counter.

NOTE

Be sure that R138 in step 16 has been properly adjusted before adjusting R109.

h. CHECK/ADJUST—using the procedure given in Table 4-2.

Table 4-2
STEP 18h CHECKS & ADJUSTMENTS
(Interface line 57 grounded)

Procedure	Check Counter Readout for:	Adjust R112 (1.25 MHz)	
Set TSG6 FREQ RANGE switch to HIGH	1.25 MHz, ±3%, or 1.0375 MHz to 0.9625 MHz		
Set TSG6 FREQ RANGE switch to LOW Move jumper from P105 to P104	1.25 MHz, ±3%, or 1.2875 MHz to 1.2125 MHz	R108 (1.25 MHz)	
Move jumper from P114 to P105	2.00 MHz, ±3%, or 2.06 MHz to 1.94 MHz	R119 (2.00 MHz)	
Move jumper from P115 to P114	3.00 MHz, \pm 3%, or 3.09 MHz to 2.91 MHz	R118 (3.00 MHz)	
Move jumper from P125 to P115	3.58 MHz, ±3%, or 3.6874 MHz to 3.4726 MHz	R129 (3.58 MHz)	
Move jumper from P132 to P125	4.10 MHz, ±3%, or 4.223 MHz to 3.977 MHz	R128 (4.10 MHz)	
Set TSG6 MULTIBURST/SWEEP/MANUAL switch to MANUAL. Remaining control settings are same as given in part c of this step.	6.00 MHz, ±10%, or 6.60 MHz to 5.40 MHz	R146 (Manual Stop Freq; 6.00 MHz)	

- i. Unground Interface line 57.
- j. Set the 1410 mainframe Power switch to Off. Remove the Extender board and install the A60 Multiburst Logic board in the 1410 mainframe. Set the 1410 Power switch to On.
- k. Disconnect the TSG6 Module Output signal applied to the digital counter.

19. Readjust Reduced and Full Amplitude Pedestal Balance (R439, R429)

- a. Apply the TSG6 Module Output signal via a 75-ohm coaxial cable to the 1480 Waveform Monitor Ch A Video Input connector. Terminate the other 1480 Ch A Video Input loop-through connector into 75 ohms.
- b. Set the TSG6 and 1480 Waveform Monitor frontpanel controls as follows:

TSG6

FREQ RANGE	LOW
MARKERS	Off
COMPOSITE/ CONTINUOUS	COMPOSITE
AMPL	REDUCED
MULTIBURST/SWEEP/ MANUAL	MULTIBURST
FREQUENCY Control	As is
BURST	Off

1480 Waveform Monitor

Input	A, DC-Coupled
Response	Low Pass
Volts Full Scale	0.2
DC Restorer	Slow, Backporch
Oper/Cal	Oper
Display	5 μs/Div
Magnifier	X1
Field	1
Line Selector	Off
Sync	Int, AFC
ADDRESS AND ADDRESS OF THE ADDRESS O	

- c. Use the waveform monitor Vertical Position control to position the pedestal portion of the waveform into view.
- d. READJUST—R439 slightly to obtain a flat pedestal (see Fig. 4-17).
 - e. Set the TSG6 AMPL pushbutton to FULL.

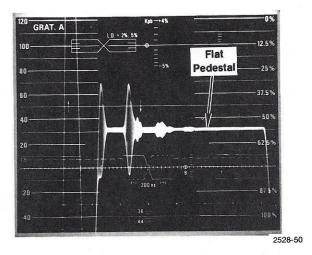


Fig. 4-17. Properly adjusted pedestal. Waveform monitor Response switch set to Low Pass.

- f. READJUST-R429 slightly to obtain a flat pedestal.
- g. Disconnect the signal from the waveform monitor.

20. Readjust HF Even Harmonics (R349)

- a. Use the same test equipment and connections as described in part a of step 19.
 - b. Set the TSG6 front-panel controls as follows:

FREQ RANGE	HIGH
MARKERS	Off
COMPOSITE/ CONTINUOUS AMPL	COMPOSITE FULL
MULTIBURST/SWEEP/	-
MANUAL FREQUENCY Control	SWEEP As is
BURST	Off

- c. Set the waveform monitor controls to the same settings as given in part b of step 19 except as follows: Set the Response switch to IRE and the Display switch to 2 Field.
- d. READJUST—R349 (see Fig. 8-2) slightly for best high-frequency symmetry around the pedestal axis. See Fig. 4-18.
- e. ADJUST C328 for minimum disturbance around pedestal axis in range 14 mHz to 20 mHz.
 - f. Disconnect the signal from the waveform monitor.

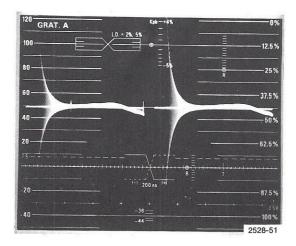


Fig. 4-18. Checking high-frequency symmetry around the pedestal axis. Waveform monitor Response switch set to IRE.

21. Check/Adjust High-Range Frequency Compensation (C505)

Preferred Method (Using Video Detector)

a. Connect the input of the video detector directly to the TSG6 Module Output connector. Connect the output cable from the video detector to the +Input connector on the differential comparator plug-in unit of the test oscilloscope (see Fig. 4-19). Externally trigger the time base using the 1410 mainframe rear-panel V Drive signal.

- b. Set the video detector slide switch to the Normal position. Set the TSG6 front-panel controls to the same settings as given in part b of step 20 except set the COMPOSITE/CONTINUOUS switch to CONTINUOUS.
- c. Set the test oscilloscope controls to establish a ground reference at graticule center. Set the differential comparator +Input Mode switch to DC and the -Input Mode switch to Vc. Set the Volts/Div switch to 5 mV and the Time/Div switch to 2 ms. Set the Comparison Voltage (Vc) control to approximately 0.39 V to position the top of the waveform to graticule center as shown in Fig. 4-20A.
- d. CHECK—for flatness of the brightened top portion of the waveform as follows: Within 15 mV up to a frequency of 12 MHz; within 20 mV from 12 MHz to 20 MHz. To locate the 12 MHz and 20 MHz points, set the MARKERS button to On as shown in Fig. 4-20B.
 - e. Set the MARKERS button to Off.

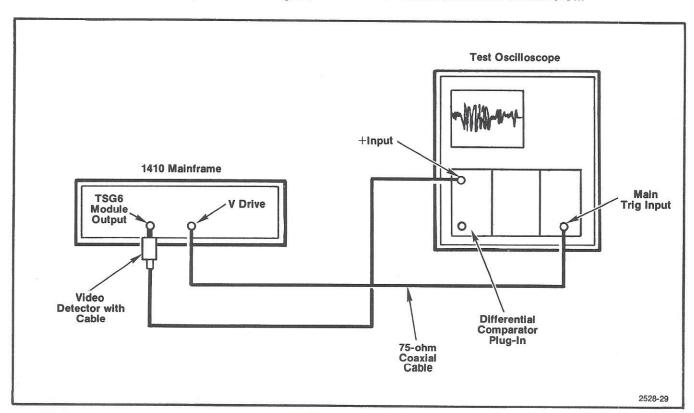
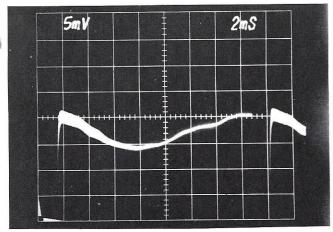
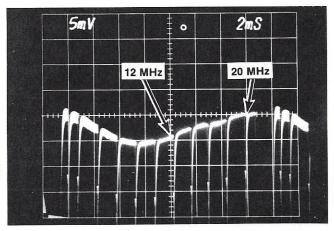


Fig. 4-19. Equipment connections for step 21 Preferred Method.



(A) TSG6 Spare Output connector terminated and MARKERS button set to OFF.



(B) TSG6 Spare Output connector terminated and MARKERS button set to ON. 2528-52A

Fig. 4-20. Typical waveforms obtained when checking high-range frequency compensation using a video detector.

f. ADJUST—C505 (Hi-Range Freq Comp) for minimum total deviation within the requirements given in part d of this step. Use Fig. 4-20A as a guide.

NOTES

Figures 4-20A and 4-20B show the waveforms obtained when the TSG6 Spare Output signal is working into a 75-ohm load such as the TSP1 module and C505 is properly adjusted.

Because of the high sensitivity in the area above C505, the installation of the cover changes the high-frequency compensation slightly. Readjust C505, as necessary, to compensate for the metal cover.

g. Disconnect all the signals applied to the test oscilloscope. Disconnect the video detector from the TSG6 Module Output connector.

Alternate Method (Using a 100 MHz Bandwidth Oscilloscope)

- h. Connect the TSG6 Module Output signal via a 75-ohm coaxial cable and 75-ohm feed-through termination to the 100 MHz bandwidth test oscilloscope vertical input connector. Externally trigger the time base using the 1410 mainframe rear-panel V Drive signal.
- i. Set the TSG6 controls to the same settings as given in part b of step 20 except set the MARKERS button to On and the COMPOSITE/CONTINUOUS switch to COMPOSITE.
- j. Set the test oscilloscope controls to display the waveform at a vertical deflection factor of 200 mV/div and a sweep rate of 2 ms/div.
- k. CHECK—for optimum flat frequency response as shown in Fig. 4-21.

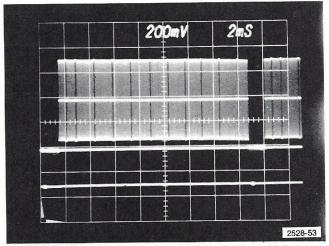


Fig. 4-21. Typical waveform obtained when checking high-range frequency compensation using a 100-MHz bandwidth test oscilloscope.

I. ADJUST—C505 (Hi-Range Freq Comp) for optimum high-frequency response.

NOTE

For consistency, always use the same test oscilloscope when performing this alternate method. The waveform obtained in parts j through I of this step may not appear the same if a different 100 MHz test oscilloscope is used.

Calibration—TSG6

m. Disconnect all the signals applied to the 100 MHz test oscilloscope.

h. Return the borrowed module output cable to its original TSG connector.

Optional Check Procedure

22. Check Isolation

a. Connect the TSG6 Module Output signal via a 75ohm coaxial cable and a 75-ohm feed-through termination to the test oscilloscope vertical input. Use the 1410 mainframe H Drive signal to externally trigger the time

b. Set the TSG6 front-panel controls as follows:

FREQ RANGE MARKERS COMPOSITE/ CONTINUOUS

COMPOSITE

LOW

Off

AMPL

FULL

MULTIBURST/SWEEP/ MANUAL

MULTIBURST

FREQUENCY Control

provided in part c of step 7.

As is On

BURST

c. Use a module output cable borrowed from an adjacent TSG module to apply the spare module output signal from the TSG6 to one of the 1410 mainframe rear-

panel Module Output connectors. Further information is

- d. Alternately terminate and unterminate the spare TSG6 signal that is applied to the Module Output connector.
- e. CHECK-for 1% or less change in amplitude of the signal displayed on the test oscilloscope crt. (An alternate method would be to terminate and short the spare TSG6 module output signal and check for a 1% or less change.)
- f. Connect a terminated 500 mV, 3.58 MHz, sine-wave signal to the spare TSG6 module output connector.
- g. CHECK-for 5 mV or less 3.58 MHz sine waves superimposed on the test oscilloscope waveform display.

Optional Performance Check

After completing the Calibration Procedure, it is recommended that the TSG6 be checked for the performance requirements given in Table 4-3. The procedure for these checks can be found by referring to the Performance Check procedure in Section 2 of this manual.

Table 4-3 **OPTIONAL PERFORMANCE CHECK**

Section 2 Performance Check Step No.	Check			
1	All high-range multiburst frequencies except 1.25 MHz.			
2	All low-range marker frequencies except 500 kHz and 3.0 MHz.			
	III high-range marker frequencies except 0 MHz.			
5	First multiburst-packet amplitude in the Reduced mode:			
	Low Range 428 mV \pm 12 mV High Range 428 mV \pm 16 mV			
6	Multiburst-packet risetime: 400 ns ± 60 ns.			
9	Reduced amplitude continuous sweep flatness:			
	Low Range 10 mV or less High Range 15 mV to 12 MHz; 20 mV to 20 MHz			
10	Return loss: 30 dB or more to 20 MHz. Equivalent to 16 mV or less in amplitude when using 500 mV as the reference amplitude.			

THEORY OF OPERATION

This section of the manual is divided into two parts. The first, an overview, provides a basic insight into the operation of the TSG6 by means of the block diagram. The second part provides detailed discussion of the individual circuits.

This circuit description is divided by diagrams. The circuit diagrams are blocked off according to circuit function. Circuit block titles serve as topics in the circuit description.

The block diagram and schematic diagrams are located on the foldout pages at the rear of the manual. Refer to the appropriate diagram when reading the circuit description.

BLOCK DIAGRAM

Circuits in the TSG6 employ power supplies of the 1410 and use the subcarrier, sync, blanking, and other timing signals from the installed SPG. The TSG6 circuits can be grouped in two main categories: Multiburst Logic (A60) and Multiburst Output (A61). These circuits are physically located on the corresponding circuit boards. The blocks will be described first for the Multiburst Output and then for the Multiburst Logic board.

MULTIBURST OUTPUT BOARD

Voltage-Controlled Oscillator

The voltage-controlled oscillator is the central block within the TSG6. The block accepts voltage-control and enable inputs, and generates a triangle-shaped waveform suitable for driving the function generator. The oscillator consists of a voltage-controlled current source which charges or discharges a capacitor. The direction of the current is determined by a set of comparators which compare the triangle voltage with set voltage limits. The front-panel FREQ RANGE switch parallels the timing capacitor with an additional capacitance in the low range.

Function Generator

The function generator is a piece-wise linear approximation to a sinusoidal waveform. It is accomplished with ten breakpoints (five positive and five negative) using Schottky barrier diodes. The diodes and resistive thin-film

network are contained in a custom hybrid integrated circuit. A dual-tracking 3.00 V power supply for the hybrid is included in the block. The input to the hybrid is a linear voltage from -6 V to +6 V, and the output from it is a sinusoidal current into a virtual ground.

Attenuator Network

The attenuator network selects full or reduced amplitude of multiburst, manual, or sweep sine-wave amplitudes. This circuit determines which output of the diode-shaper network is connected to the output circuit.

Envelope Shaping

The burst-packet modulator amplitude modulates the continuous-wave input from the attenuator network. A balanced modulator is used to obtain the controlled risetime and falltime of the burst packets. Sinusoidal shaping of these edges is approximated.

Color-Burst Modulator

The color burst is generated by a balanced modulator with switching input driven by a regenerated color subcarrier and the linear input driven by a filtered burst gate. The output is bandpass filtered and resistively coupled to the output buffer amplifier.

Sync and Luminance Filters, and Buffer Amplifier

Five-pole low-pass filters are used to shape sync and luminance currents from the Multiburst Logic board. The risetime of the sync filter is 130 ns, and the risetime of the luminance filter is 250 ns. Plug jumpers on the Multiburst Logic board allow for steering the sync and luminance into either filter. Luminance information consists of markers and pedestal in COMPOSITE mode and markers in CONTINUOUS mode. The filters are resistively coupled to the buffer amplifier.

Output Amplifier

The sine-wave component of the output is connected directly to the input stage of the output amplifier. The sync, luminance, and color burst are connected through the buffer amplifier to reduce interference with the sweep signal. The output amplifier will drive two loads.

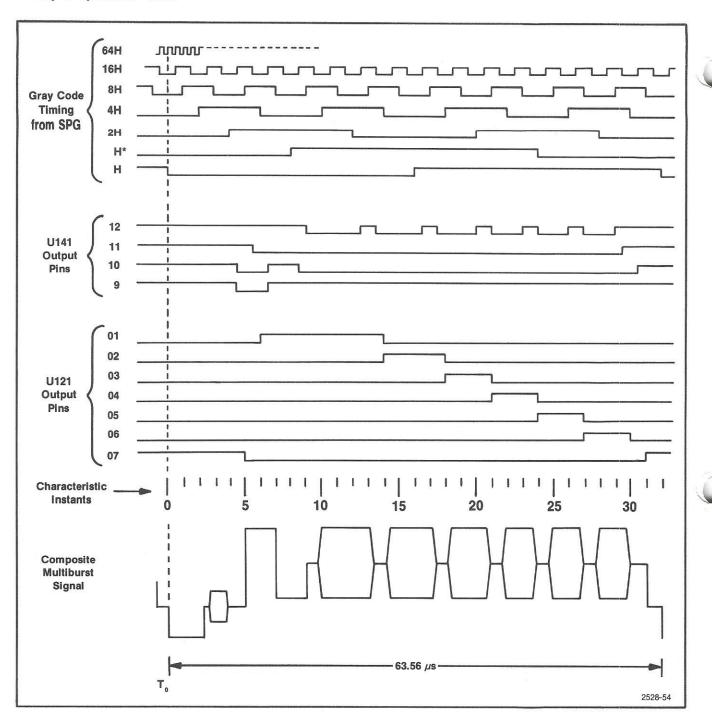


Fig. 5-1. Timing diagram for line timing of the TSG6 multiburst signal.

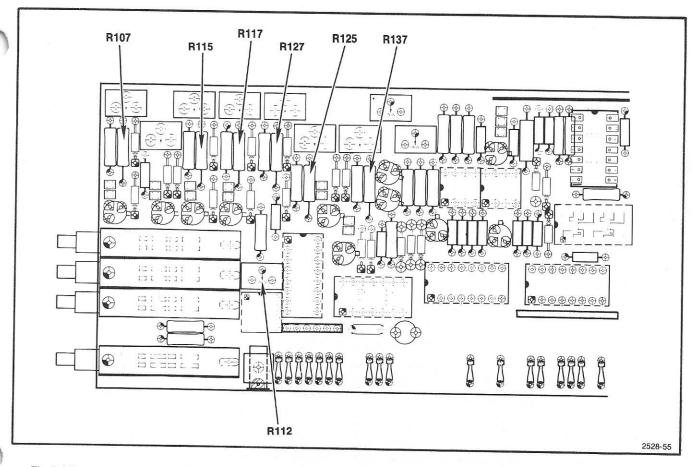


Fig. 5-2. Location of resistors that control high-range multiburst packet frequencies. Partial view of A60 Multiburst Logic board.

Luminance Current Source Selection

The Luminance Current Sources consist of Q275, Q286, Q284, Q287, Q285, Q294, and Q295. Q275 is the current driver for sync. The other transistors are connected in parallel for generation of setup and FULL/REDUCED AMPLitude markers. P280 and P281 allow for connection of these nodes to either filter. Each current source has been made adjustable to allow for minimization of circuits in the path of the sine-wave output from the hybrid U390 on diagram 2. (Adjustment of the output amplifier master gain R489 to obtain the desired

sine-wave amplitude may require readjustment of these current sources.)

Subcarrier Limiter

Color subcarrier from the SPG is buffered by Q193 and Q213. Q214 drives the tank circuit consisting of L211, R222, C223, C224, C222, and R232. Q223 serves as both a limiter and gate for regenerated subcarrier. Subcarrier is gated on across the interface only during horizontal blanking.

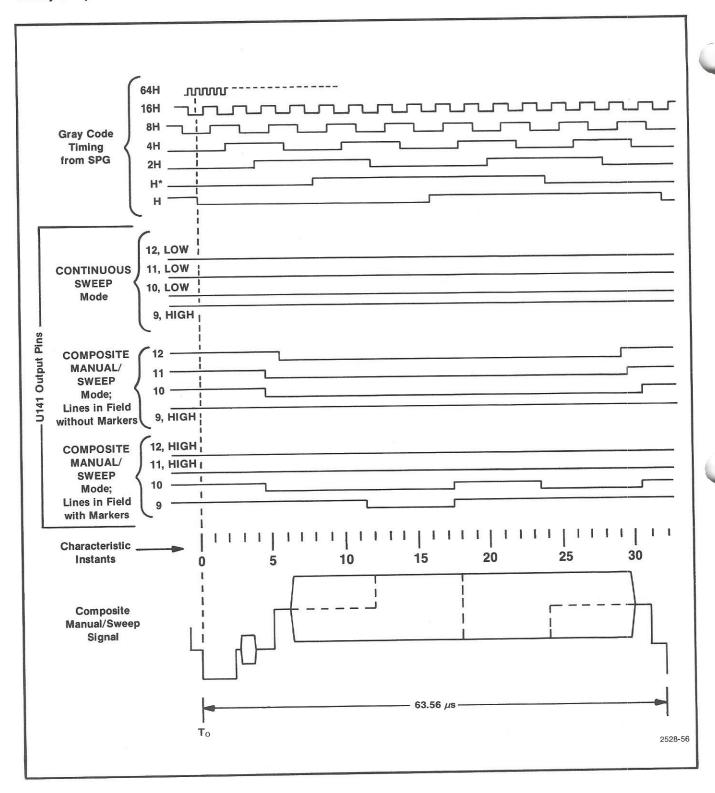


Fig. 5-3. Timing diagrams for line timing of the TSG6 composite manual/sweep signal.

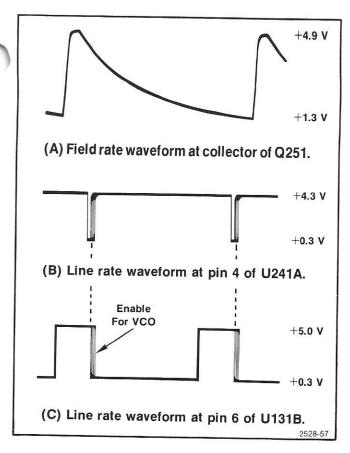


Fig. 5-4. Illustrating U241A circuit operation.

MULTIBURST OUTPUT DIAGRAM



Voltage-Controlled Oscillator

The Voltage-Controlled Oscillator consists of: (1) a paraphase input amplifier, (2) unswitched current source of value I, (3) switched current source of value 2I, (4) current switches, (5) slew-rate limiting capacitors, (6) amplification stages, (7) level-sense latching comparators, and (8) start/stop logic. The operation of the VCO will be discussed first in terms of the simplified diagram (see Fig. 5-5) and then by schematic diagram.

The triangle waveform is generated by charging or discharging a grounded capacitor from a current source. A steady current is always flowing into the capacitor from the current source (I). A current source (2I) is switched in to discharge the capacitor at the same rate as which it is charged (I-2I=-I). The complementary voltage sources (V) are derived from the input by paraphase amplification.

The voltage across the capacitor is amplified by a unity-gain amplifier with FET input and bipolar output. The output of the amplifier is attenuated and compensated to drive a pair of latching comparators. One comparator senses the positive excursion of the triangle and the other senses the negative excursion. The comparators then drive the switch to establish charging or discharging of the capacitor.

The input to the VCO is a current source from the Multiburst Logic board. This current source drives a 3.01 k Ω resistance (R305) to -15 V, establishing the voltage input to the VCO. The input stage consists of U305 and Q315. It generates the voltage inputs to the controlled current sources. The I current source consists of U315 and Q325. Q344 is a buffer stage to isolate Q325 from the large voltage swings occurring on the capacitor and also to compensate for current loss in the switch. The 2I current source consists of U308 and Q348. Adjustments are provided to compensate for offset voltage in U308 and current ratio.

Q345 and Q346 are the current switches. When Q346 is active, the 2I current source is steered away from the capacitor. C345 and C336 set the HIGH range capacitance while C344, switched in on LOW range, establishes the ratio between HIGH and LOW range. Q343A and Q343B are a unity-gain FET amplifier to buffer the capacitor at low currents. Q352 and Q362 provide the current necessary to drive the diode function generator and the feedback network around the VCO. This feedback network, consisting of R384, R374, C383, R383, and R386, level shift and attenuate the triangle output to drive the ECL comparators, U357 and U354. Figure 5-6 is a timing diagram showing the operation of the comparators. Use is made of latching inputs and open-emitter output features of these comparators. The trip levels for the comparators are set by a dual-tracking power supply (U365).

A cycle of the VCO occurs as follows: Assume that the triangle signal at the output of J370 is starting to go positive. See Fig. 5-6. At this time, Q345 is turned off and Q346 is turned on; U354 is latched and U357 is unlatched. As the triangle signal goes through the positive trip voltage, $Q_{\rm A}$ (pin 7 of U357) goes high and unlatches U354. The unlatching of U354 causes $\overline{Q_{\rm B}}$ (pin 8 of U354) to go low. The low at $\overline{Q_{\rm B}}$ latches U357. At this time, Q345 is on and Q346 is off. This action causes the triangle signal at J370 to start going in a negative direction. As the triangle signal goes through the negative trip level, $\overline{Q_{\rm B}}$ goes high and unlatches U357, thereby causing $Q_{\rm A}$ to go low. Q345 turns off, Q346 turns on, and the triangle signal starts going positive to repeat the cycle.

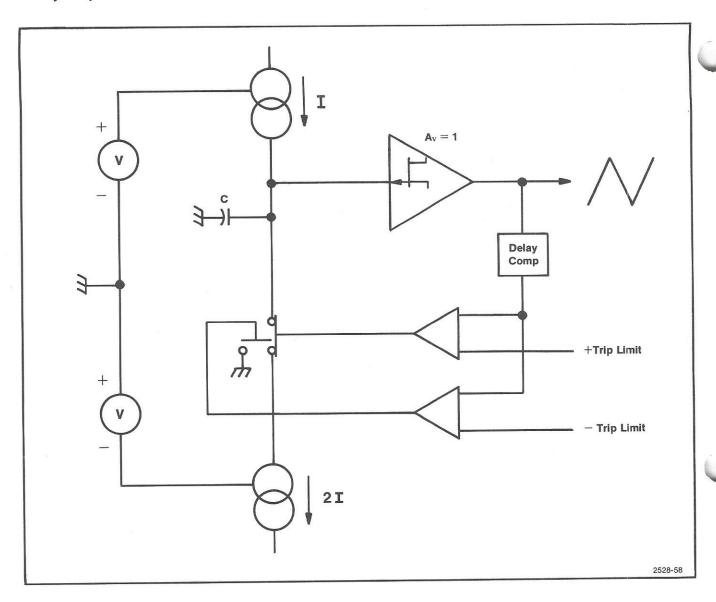


Fig. 5-5. Simplified diagram of Voltage-Controlled Oscillator.

In HIGH range mode, a correction signal from the input voltage is fed back into the power supply (U365) to compensate for comparator delay. U336, Q331, Q332, Q321, Q342, Q347, and Q339 provide start/stop operation of the VCO. Under normal operating conditions, either Q345 or Q346 is conducting. The EXCLUSIVE-OR operation (U336) senses the base voltages and forces this condition should both transistors become active simultaneously (such as on power-up). To disable the VCO, both transistors are turned on, both comparators are unlatched, and the capacitor is shorted to ground by Q342.

Function Generator

The diode function generator is contained in a custom hybrid integrated circuit (U390). The triangle output of the VCO is connected directly to the input (pin 23) of the hybrid. The hybrid operates off of symmetrical (+ and -) 3.00 V power supplies. The dual-tracking supplies are generated by U397; the positive from Q415, the negative from Q395. The hybrid provides two sets of outputs designed to drive a virtual ground. These outputs are set such as to produce the correct FULL/REDUCED AMPLitude ratio. Straps are inserted into the board according to the ratio selected for the generator (90/60 for NTSC).

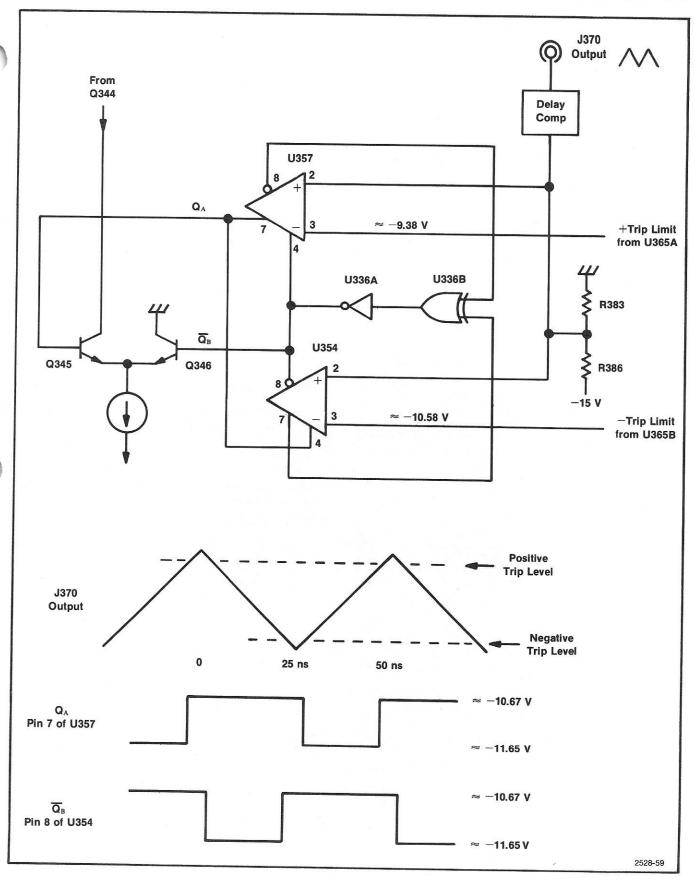


Fig. 5-6. Simplified schematic and timing diagrams showing the operation of the comparators.

Theory of Operation—TSG6

NOTE

Pins 10 and 12 have been removed from the socket for U390 to reduce capacitive loading on unused outputs.

Attenuator Network

The attenuator network steers the selected output of the hybrid (U390) to the envelope shaping circuit. The full amplitude signal passes through Q424, while the reduced amplitude signal passes through Q426. Q432, Q433, and Q434 drive diode switches to U447. This IC, with associated circuitry, provides bias current in addition to the sine-wave signal current.

Envelope Shaping

The envelope shaping circuit is realized by a balanced modulator configuration with a monolithic transistor array U447. The shaped edges of the burst packets result from driving the upper set of transistors through the switching region with a ramp of controlled risetime and amplitude. As with the VCO, an I and 2I current-source configuration charges a capacitor to generate a ramp voltage. Q456 through R454 is the 2I current source, whereas R445 is the I current source. These currents and C444 set the risetime of the ramp. Q453 prevents the sine wave from running into vertical sync at the start of field 2. Q449 minimizes feed-through transients during the transition.

Color Burst Modulator

The color burst modulator is a balanced circuit using a standard modulator IC (U484). The switching input is driven directly from regenerated subcarrier on the Multiburst Logic board. The linear input is driven from the SPG burst gate through a three-pole low-pass filter. External current sources are used on the modulator to obtain required residual subcarrier specification. The output of the modulator is bandpass filtered and connected to the output buffer.

Sync and Luminance Filters, and Buffer Amplifier

Two filters, which are five-pole approximations to sinsquared shaping, are contained on the Multiburst Output board. One filter has a risetime of 130 ns, while the other has a risetime of 250 ns. The selection of filters is determined by jumpers on the Logic board. Factory-set positions are: (1) sync driver jumpered to 130 ns filter, and (2) luminance (markers and pedestal) jumpered to the 250 ns filter. These filters are terminated in 500 Ω to a buffer amplifier. The buffer amplifier (Q469 and Q524) isolates the filters (sync, luminance, and chrominance) from the sine-wave input to the output amplifier. The buffer amplifier also provides the dc bias current for the output amplifier stage.

Output Amplifier

Q448, Q478, Q506, Q508, and Q504 form a high open-loop gain, transimpedance amplifier with near zero input and output impedance. The closed-loop gain, Vout/Vin, is set by R477 and R489. The output amplifier combines the sweep and buffered sync, luminance, and chrominance signals to provide a composite video signal to the Module Output connector on the 1410 rear panel. The output amplifier is capable of driving two 75-ohm loads simultaneously; however, when two cables are connected to the module, unterminating one cable will interfere with the output from the other cable.

MAINTENANCE

INTRODUCTION

This section is divided into three parts: Maintenance, Troubleshooting, and Repair.

Maintenance includes inspection, cleaning, and recalibration. Troubleshooting contains information for isolating a trouble to a component. Repair includes procedures for removing and replacing components.

MAINTENANCE

A regular schedule of maintenance can improve instrument reliability. How often the maintenance is performed should be determined by the severity of the operating environment.

Cleaning

WARNING

Turn off the insturment power and remove the power cord before cleaning.

Dust accumulating on the circuit boards acts as an insulating blanket, preventing efficient heat dissipation, and possibly causing overheating and component breakdown. A layer of dust can also provide an electrical conduction path especially under high humidity conditions.

CAUTION

Avoid the use of chemical cleaning agents that might damage the plastics used in this instrument. Avoid chemicals that contain benzene, toluene, xylene, or similar solvents.

The best way to remove heavy accumulations of dust is to blow it off with dry, low-velocity air jet. Remaining dust can be removed with a small brush followed by a soft cloth dampened in a mild detergent and water solution. A cotton-tipped applicator is useful in tight places.

WARNING

THE FOLLOWING SHOULD BE PERFORMED BY QUALIFIED SERVICE PERSONNEL ONLY.

Visual Inspection

Visually inspect the circuit boards during the maintenance routine for such defects as broken connectors, loose or disconnected pin connectors, improperly seated transistors and integrated circuits, and damaged components. Make sure that the boards are properly seated on the 1410 mainframe Interface pins. The boards should be parallel to each other and held firmly by the spacer bars provided for this purpose.

The corrective procedure for most visible defects is obvious; however, care must be taken to determine and correct the cause of heat-damaged components. Heat damage is sometimes an indication of trouble elsewhere in the instrument.

Static-Sensitive Parts

CAUTION

STATIC DISCHARGE CAN DAMAGE ANY SEMICONDUC-TOR COMPONENTS USED IN THIS INSTRUMENT.

This instrument contains electrical components which are susceptible to damage from static charges; see Table 6-1. Observing the following precautions will aid in avoiding the breakdown of these parts. When returning static-sensitive parts to Tektronix, Inc., package them in antistatic or conductive material. Static voltages of 1 to 30 kV are common in unprotected environments.

Table 6-1

Dalotino

Comiconductor

Semiconductor Categories	De	Relative gradation Level ^a
MOS or CMOS microcircuits or discretes or linear microcircuits with MOS Inputs	1	(most sensitive)
ECL	2	
Schottky signal diodes	3	
Schottky TTL	4	
High-frequency bipolar transistors .	5	
JFETS	6	
Linear Microcircuits	7	
Low-power Schottky TTL	8	
TTL	9	(least sensitive)

 $^{\rm a}$ Voltage equivalent for item: 1 = 100 to 500 V; 2 = 200 to 500 V; 3 = 250 V; 4 = 500 V; 5 = 400 to 600 V; 6 = 600 to 800 V; 7 = 400 to 1000 V (est); 8 = 900 V; 9 = 1200 V. Volts on 100 pF capacitor discharged through series resistance of 100 ohms.

CAUTIONS TO BE AWARE OF IN SERVICING STATIC-SENSITIVE EQUIPMENT

- 1. Minimize the handling of static-sensitive parts.
- Transport and store static-sensitive parts in their original containers, on a metal rail, or on conductive foam. Label any container having a static sensitive assembly or device.
- Discharge the static charge on yourself by using a wrist strap before handling these devices. It is recommended that servicing of static-sensitive assemblies or devices be performed only at a static-free work station by qualified personnel.
- Nothing capable of generating or holding a static charge should be allowed on the work station surface.
- 5. Keep the leads shorted together whenever possible.
- 6. Pick up the part by the body, never by the leads.
- Do not subject the part to sliding movements over any surface.
- 8. Avoid handling parts in areas having a floor or work surface covering that contributes to the generation of a static charge.

- Use a soldering iron that has a connection to earth ground.
- 10. Use any special anti-static suction type desoldering tool, such as Silverstat Soldapulit, or a wick-type desoldering device.

Recalibration

The length of time between recalibration depends on the amount of use the circuitry receives, the nature of the environment, and the change in performance when some components are replaced.

In general, a partial recalibration is necessary if the components replaced affect the board calibration. Complete recalibration is recommended if the board is not operating to its full capability. To ensure correct and accurate operation, performance should be checked at regular intervals; for example, after 1000 hours of operation if used continuously, or every six months if used infrequently.

A Performance check is given in Section 2 and a Calibration Procedure is given in Section 4.

TROUBLESHOOTING

Information contained here may be used as a guide in locating circuit failures. The schematic diagrams, theory of operation, and calibration sections should be referred to for fast, efficient location and repair of defects.

Diagrams

The schematic diagrams are shown on the foldout pages in Section 9, the circuit and electrical value of each component is shown on the diagrams. Important waveforms are also shown.

Circuit Boards

The circuit boards are outlined in black on the schematic diagrams. Circuit board illustrations are provided on the back of the foldout pages that precede the diagrams. The assembly number (for example, A60) assigned to each circuit board is an abbreviated method for identifying the board. The TSG6 contains two etched-circuit board assemblies: A60 Multiburst Logic and A61 Multiburst Output.

When troubleshooting the circuit boards in the TSG6, the use of an extender board facilitates access to the board connections and components. Placing the suspected circuit board on the extender board will save time in looking for faults. Carefully align the board pin connectors to ensure good contact.

CAUTION

Be sure that the pins on the Interface board are not bent. Forcing a bent pin into a connector may permanently damage the connector.

Circuit numbers are assigned on a grid system to facilitate component location. Low numbers start at the lower front corner of the board increasing to the rear and top.

The TSG6 circuit-board illustrations and schematic diagrams are arranged for simultaneous usage. The foldout page containing the circuit-board illustration opens to the left while the schematic diagram foldout page opens to the right. See Fig. 6-2.

Wire Color Code

Insulated wires are color-coded to facilitate circuit tracing.

Resistor Color Code

Color stripes on resistors signify electrical values, tolerances, etc., according to the EIA standard color code. Refer to the color code illustration in the Maintenance section of the 1410 mainframe manual. Resistors not color-coded usually have the value imprinted on the body.

Capacitor Markings

The capacitance value of a common disc capacitor or small electrolytic is marked in microfarads on the side of the component body. White ceramic capacitors are color coded in picofarads using a modified EIA code. The "tear drop" capacitors are color-coded in microfarads using a modified EIA code with the dot indicating both temperature and positive (+) side. See the color code illustrations provided in the Maintenance section of the 1410 mainframe manual.

Transistor and Integrated-Circuit Lead Configuration

Figure 6-1 illustrates the lead configurations for the socket-mounted transistors and integrated circuits (IC) used on the circuit board.

The socket for U390, located on A61 Multiburst Output board, was modified before the socket was installed on the board. Socket pin terminals No. 10 and 12 were removed to reduce capacitive loading on the unused outputs.

IC Diagrams

Positive logic functions of the ICs are shown in Section 9 of this manual.

Troubleshooting Equipment

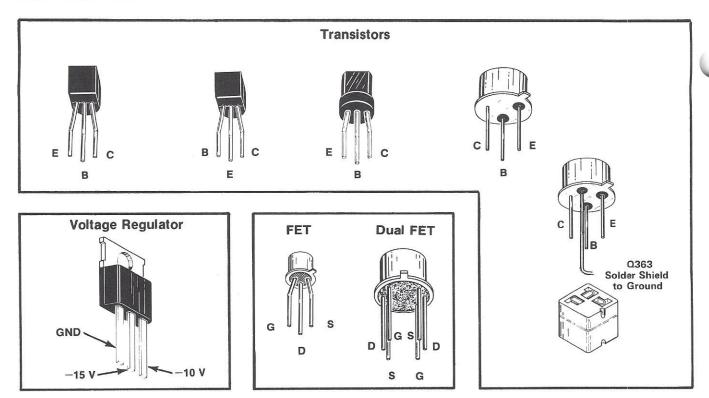
The following test equipment is useful for troubleshooting the TSG6 circuit boards. Before using any test equipment to make measurements on static-sensitive devices, be certain that any voltage or current supplied by that test equipment to a circuit under test does not exceed the limits of the device to be tested.

- 1. Test Oscilloscope. For viewing waveforms at various test points in the circuit. Frequency response: dc to at least 50 MHz. It should be equipped with a 10X probe.
- 2. **DVM and Ohmmeter.** For measuring dc voltages and resistances accurately. The ohmmeter is also required for checking continuity.
- **3. Semiconductor Tester.** Some means of testing the transistors and diodes is helpful. A transistor-curve tracer such as the TEKTRONIX Type 577 will give the most complete information.

Troubleshooting Procedure

This procedure starts with simple, but sometimes taken-for-granted problem areas and proceeds to detailed troubleshooting.

- 1. Check Control Settings. Incorrect control settings or wrong internal jumper positions can indicate a trouble that does not exist. If there is any question about the correct function or operation of any control or jumper, refer to the Operating Instructions (Section 1) and Installation (Section 3).
- 2. Check Associated Boards. Before troubleshooting the TSG6 circuit boards, check that the 1410 mainframe is operating properly. Check that the TSG6 circuit boards are making good contact through the interconnecting pins. Make sure that other boards on the Interface board are not defective. Check that the test oscilloscope probe, if used, is not defective and is properly compensated.



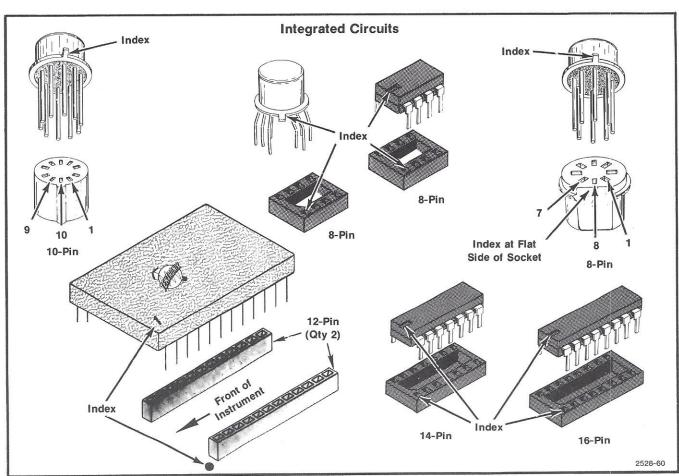


Fig. 6-1. Basing diagrams for semiconductors.

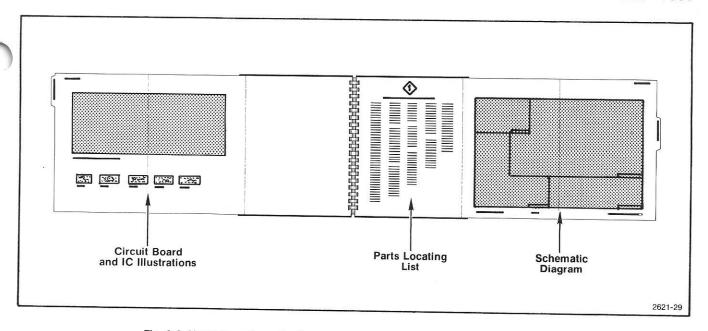


Fig. 6-2. Using the schematic diagram and circuit board illustration simultaneously.

- 3. Isolate Trouble to a Circuit. Symptoms will often identify the circuit in which the trouble is located. Incorrect operation of all circuits often means trouble in the power supply section of the mainframe. Consider this possibility if voltages are incorrect. Make sure that all board pin connectors are making good contact before proceeding with trouble isolation.
- 4. Visual Check. Visually check the portion of the board in which the trouble is suspected. Some troubles can be located by checking for unsoldered connections. broken wires, loosely-seated transistors, loose-fitting connectors, damaged components, or damaged circuit boards.
- 5. Check Voltages and Waveforms. Often the defective component or stage can be located by checking for the correct voltage or waveform in the circuit. Typical waveforms are given near the diagram. To obtain operating conditions similar to those used to take these waveforms, refer to the instructions at the start of the diagram section.

CAUTION

Due to component density on the circuit board, special care should be exercised when using meter leads and tips. Accidental shorts can cause abnormal voltages or transients that may destroy many components.

- 6. Check Individual Components. After the trouble has been isolated to one circuit or stage, the next step is to isolate the trouble to one component or part. Components that are soldered in place are best checked by disconnecting one end to isolate the measurement from the effects of surrounding circuitry. The following methods are provided for checking individual electrical components in the module.
- a. TRANSISTORS. The best check of transistor operation is actual performance under operating conditions. If a transistor is suspected of being defective, it can be checked by substituting a new component or one which has been checked previously. However, be sure that the circuit conditions are not such that a replacement transistor might also be damaged. If substitute transistors are not available, use a dynamic tester (such as the TEKTRONIX Type 577) to check the transistor.
- b. INTEGRATED CIRCUITS. Integrated circuits should not be replaced unless they are actually defective. The best method for checking these devices is by direct substitution with a new component or one which is known to be good. Be sure that circuit conditions are not such that a replacement component might be damaged.
- c. DIODES. A diode can be checked for an open or shorted condition by measuring the resistance between terminals. Use an ohmmeter, set to the 1 k scale to keep from damaging the diode, for measuring the diode

resistance. The resistance should be very high in one direction and very low when the ohmmeter leads are reversed.

- d. RESISTORS. Resistors can be checked with an ohmmeter. Check the Replaceable Electrical Parts list for the tolerance of the resistors used in the instrument. Resistors normally do not need to be replaced unless the measured value varies widely from the specified value.
- e. INDUCTORS. Check for an open circuit by checking continuity with an ohmmeter.
- f. CAPACITORS. A leaky or shorted capacitor can best be detected by checking the resistance with an ohmmeter on the highest scale. Do not exceed the voltage rating of the capacitor. An open capacitor can best be detected with a capacitance meter or by checking whether the capacitor passes ac signals.

CORRECTIVE MAINTENANCE

Corrective maintenance consists of component replacement and circuit board repair. Special techniques required to replace components in this instrument are given here.

Obtaining Replacement Parts

Most electrical and mechanical parts can be obtained through your local Tektronix field office or representative. However, you should be able to obtain many of the standard electronic components from a local commercial source in your area. Before you purchase or order a part from a source other than Tektronix, Inc., please check the electrical parts list for the proper value, rating, tolerance, and description.

Parts Location

The exploded-view drawings associated with the Replaceable Mechanical Parts list (at the rear of the manual) are helpful in the removal or disassembly of components or subassemblies. Circuit-board illustrations are provided on the backs of foldout pages in the Diagrams section of this manual.

Selected Components

During calibration at the factory, the values of some resistors located on A60 Multiburst Logic board (diagram 1) are selected, if necessary, to make the TSG6 meet performance requirements. Table 6-2 lists these components, their value limits, and the reason for selection.

Table 6-2
SELECTED COMPONENTS

Circuit		Value	O de la Charle
Number	Nominal	Limits	Select to Obtain
R115	54.9 kΩ	±3%	3.50 MHz high-range multiburst frequency.
R117	28.0 kΩ	±3%	5.50 MHz high-range multiburst frequency.
R127	15.8 kΩ	±3%	8.00 MHz high-range multiburst frequency.
R125	15.8 kΩ	±5%	10.0 MHz high-range multiburst frequency.
R137	17.4 kΩ	±5%	12.0 MHz high-range multiburst frequency.
R252	7.68 kΩ	±10%	Optimum filled-in appearance of 500 kHz multiburst packet.
R169	16.5 kΩ	±10%	>4.5 MHz stop frequency in low-range last burst variable mode.
R167	30.9 kΩ	±10%	<3.8 MHz start frequency in low-range last burst variable mode.
R367	2.0 kΩ	1.0 kΩ to 2.0 kΩ	Minimizes 2nd harmonics in high range-mode.
R373	10 kΩ	10 kΩ to 100 kΩ	Minimizes 3rd harmonics in low range manual mode at 6 MHz.

Circuit Board Replacement

If a circuit board is damaged beyond repair, the entire assembly, including all components, can be replaced. Tektronix part numbers are given in the Replaceable Electrical Parts list.

Circuit Board Removal

In order to work on one of the circuit boards in the TSG6, it is necessary to extend it above the 1410 Mainframe. An Extender board is provided with the 1410 for this purpose. It will allow access to components while retaining connection to the 1410 power supplies and signal interface lines.

To remove a TSG6 circuit board for mounting on an Extender board, proceed as follows:

1. Note the location of the multi-pin connector on the board. Disconnect the multi-pin connector from the board.

- 2. Grasp the TSG6 board at both ends and pull straight up from the Interface board until the physical connections between the Interface pins and the TSG6 board connectors are disconnected. Remove the board by tilting the rear of the board upward and pulling up and back.
- 3. Install the Extender board in the location of the removed TSG6 board.
- 4. Mount the removed board on the Extender board. Do not allow the Extender board pins to protrude above the TSG6 board female connectors; otherwise, the pins may contact components on the TSG6 board. Reconnect the multi-pin connector(s) to the TSG6 board.
- 5. To re-install the TSG6 board on the 1410 Interface board, reverse the order of removal. Use the mating plastic guides to align the TSG6 board connectors with the Interface board pins. Seat the TSG6 board firmly on the Interface board. Re-connect the multi-pin connector to the TSG6 board.

Extracting Integrated Circuits

An extracting tool should be used to remove the packaged integrated circuits used in the TSG6. A tool for this purpose is available from Tektronix, Inc. Order Tektronix Part No. 003-0619-00. If an extracting tool is not available, use care to avoid damaging the pins. Pull slowly and evenly on both ends of the IC. Try to avoid having one end of the IC disengage from the socket before the other.

Pushbutton Switch Replacement

Use the following procedure to remove a pushbutton switch.

 Before removing a single pushbutton switch, such as the BURST switch, check that the pushbutton is set to the out (released) position. This position causes the pushbutton actuating arm to move forward so it will clear the rear retainer clip (see Fig. 6-3). Before removing a self-canceling switch assembly such as the MULTIBURST/SWEEP/MANUAL switch, be sure that all the pushbuttons for this type of switch are set to their out position.

- 2. Remove the switch extender(s) by pulling it straight off.
- 3. For a single pushbutton switch, such as the BURST switch, carefully pry back the rear retainer clip with the tip of a small screwdriver. Remove the switch by lifting the switch body up and back from the front retainer clip. To remove a self-canceling switch assembly such as the MULTIBURST/SWEEP/MANUAL switch, all three switch bodies must be released from their rear retainer clips to remove the complete switch assembly.

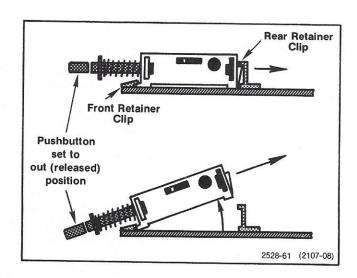


Fig. 6-3. Removing a pushbutton switch.

REPLACEABLE ELECTRICAL PARTS

PARTS ORDERING INFORMATION

Replacement parts are available from or through your local Tektronix, Inc. Field Office or representative.

Changes to Tektronix instruments are sometimes made to accommodate improved components as they become available, and to give you the benefit of the latest circuit improvements developed in our engineering department. It is therefore important, when ordering parts, to include the following information in your order: Part number, instrument type or number, serial number, and modification number if applicable.

If a part you have ordered has been replaced with a new or improved part, your local Tektronix, Inc. Field Office or representative will contact you concerning any change in part number.

Change information, if any, is located at the rear of this manual.

SPECIAL NOTES AND SYMBOLS

X000 Part first added at this serial number
00X Part removed after this serial number

ITEM NAME

In the Parts List, an Item Name is separated from the description by a colon (:). Because of space limitations, an Item Name may sometimes appear as incomplete. For further Item Name identification, the U.S. Federal Cataloging Handbook H6-1 can be utilized where possible.

ABBREVIATIONS

ACTR	ACTUATOR	PLSTC	PLASTIC
ASSY	ASSEMBLY	QTZ	QUARTZ
CAP	CAPACITOR	RECP	RECEPTACLE
CER	CERAMIC	RES	RESISTOR
CKT	CIRCUIT	RF	RADIO FREQUENCY
COMP	COMPOSITION	SEL	SELECTED
CONN	CONNECTOR	SEMICOND	SEMICONDUCTOR
ELCTLT	ELECTROLYTIC	SENS	SENSITIVE
ELEC	ELECTRICAL	VAR	VARIABLE
INCAND	INCANDESCENT	WW -	WIREWOUND
LED	LIGHT EMITTING DIODE	XFMR	TRANSFORMER
NONWIR	NON WIREWOUND	XTAL	CRYSTAL

CROSS INDEX—MFR. CODE NUMBER TO MANUFACTURER

Mfr. Code	Manufacturer	Address	City, State, Zip
00853	SANGAMO ELECTRIC CO., S. CAROLINA DIV.	P O BOX 128	PICKENS, SC 29671
01121	ALLEN-BRADLEY COMPANY	1201 2ND STREET SOUTH	MILWAUKEE, WI 53204
01295	TEXAS INSTRUMENTS, INC., SEMICONDUCTOR	P O BOX 5012, 13500 N CENTRAL	in contestant in terrescolor solution (COMP) in the COMP (COMP) (
	GROUP	EXPRESSWAY	DALLAS, TX 75222
02111	SPECTROL ELECTRONICS CORPORATION	17070 EAST GALE AVENUE	CITY OF INDUSTRY, CA 91745
02735	RCA CORPORATION, SOLID STATE DIVISION	ROUTE 202	SOMERVILLE, NY 08876
03508	GENERAL ELECTRIC COMPANY, SEMI-CONDUCTOR		
	PRODUCTS DEPARTMENT	ELECTRONICS PARK	SYRACUSE, NY 13201
04222	AVX CERAMICS, DIVISION OF AVX CORP.	P O BOX 867, 19TH AVE. SOUTH	MYRTLE BEACH, SC 29577
04713	MOTOROLA, INC., SEMICONDUCTOR PROD. DIV.	5005 E MCDOWELL RD, PO BOX 20923	PHOENIX, AZ 85036
07263	FAIRCHILD SEMICONDUCTOR, A DIV. OF		
20222	FAIRCHILD CAMERA AND INSTRUMENT CORP.	464 ELLIS STREET	MOUNTAIN VIEW, CA 94042
09023	CORNELL-DUBILIER ELECTRONIC DIVISION	0.550 017 017/07 07	24.VECDD NO 072220
10007	FEDERAL PACIFIC ELECTRIC CO.	2652 DALRYMPLE ST.	SANFORD, NC 27330
12697	CLAROSTAT MFG. CO., INC.	LOWER WASHINGTON STREET	DOVER, NH 03820
14193	CAL-R, INC.	1601 OLYMPIC BLVD.	SANTA MONICA, CA 90404
14552	MICRO SEMICONDUCTOR CORP.	2830 E FAIRVIEW ST.	SANTA ANA, CA 92704
17856	SILICONIX, INC.	2201 LAURELWOOD DRIVE	SANTA CLARA, CA 95054
18324	SIGNETICS CORP.	811 E. ARQUES	SUNNYVALE, CA 94086
24546	CORNING GLASS WORKS, ELECTRONIC	SEA HIGH CERRET	PRADEORD DA 16701
27014	COMPONENTS DIVISION	550 HIGH STREET	BRADFORD, PA 16701
32997	NATIONAL SEMICONDUCTOR CORP.	2900 SEMICONDUCTOR DR.	SANTA CLARA, CA 95051
34335	BOURNS, INC., TRIMPOT PRODUCTS DIV.	1200 COLUMBIA AVE.	RIVERSIDE, CA 92507
52769	ADVANCED MICRO DEVICES SPRAGUE GOODMAN ELEC., INC.	901 THOMPSON PL. 134 FULTON AVENUE	SUNNYVALE, CA 94086 GARDEN CITY PARK, NY 11040
56289	SPRAGUE ELECTRIC CO.	87 MARSHALL ST.	NORTH ADAMS, MA 01247
57668	R-OHM CORP.	16931 MILLIKEN AVE.	IRVINE, CA 92713
59660		2155 N FORBES BLVD	TUCSON, AZ 85705
72982	ERIE TECHNOLOGICAL PRODUCTS, INC.	644 W. 12TH ST.	ERIE, PA 16512
73138	BECKMAN INSTRUMENTS, INC., HELIPOT DIV.		FULLERTON, CA 92634
74970	JOHNSON, E. F., CO.	299 10TH AVE. S. W.	WASECA, MN 56093
80009	TEKTRONIX, INC.	P O BOX 500	BEAVERTON, OR 97077
91637	DALE ELECTRONICS, INC.	P. O. BOX 609	COLUMBUS, NE 68601
0 0 1	and and an	I. O. DOM DOY	000011000, 110 00001

Ckt No.	Tektronix Part No.	Serial/Mod Eff	el No. Dscont	Name & Description	Mfr Code	Mfr Part Number
						Ture Number
A60	670-5507-00			CKT BOARD ASSY: MULTIBURST LOGIC	80009	670-5507-00
A61	670-5508-00		B010610	CKT BOARD ASSY: MULTIBURST OUTPUT	80009	
A61	670-5508-01	B010611		CKT BOARD ASSY: MULTIBURST OUTPUT	80008	
C130 '	290-0745-00			CAP., FXD, ELCTLT: 22UF, +50-10%, 25V	56289	502D225
C131	283-0028-00			CAP., FXD, CER DI:0.0022UF, 20%, 50V	56289	
C151	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V	04222	
C157	285-0808-00			CAP., FXD, PLSTC:0.1UF, 10%, 50V	56289	
C191	281-0812-00			CAP., FXD, CER DI:1000PF, 10%, 100V	72982	
C192	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V	04222	SA205E104MAA
C193 C221	283-0000-00 281-0773-00			CAP., FXD, CER DI:0.001UF, +100-0%, 500V	59660	0831610Y5P0102D
C222				CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	
2223	283-0615-00 283-0637-00			CAP., FXD, MICA D:33PF, 5%, 500V	00853	D155E330J0
2224	281-0226-00			CAP., FXD, MICA D:20PF, 2.5%, 100V	00853	D151E200D0
2230	281-0812-00			CAP., VAR, PLSTC: 5.5-65PF, 100V	52769	
	201-0012-00			CAP., FXD, CER DI:1000PF, 10%, 100V	72982	8035D9AADX7R102F
C240 C243	281-0773-00 283-0646-00			CAP., FXD, CER DI:0.01UF,10%,100V	04222	
2244	281-0812-00			CAP., FXD, MICA D:170PF, 1%, 100V	00853	D151E171F0
2263	290-0517-00			CAP., FXD, CER DI:1000PF, 10%, 100V	72982	
290	290-0745-00			CAP., FXD, ELCTLT: 6.8UF, 20%, 35V		196D685X0035KA1
291	290-0745-00			CAP.,FXD,ELCTLT:22UF,+50-10%,25V CAP.,FXD,ELCTLT:22UF,+50-10%,25V	56289 56289	
292	290-0745-00			CAP., FXD, ELCTLT: 22UF, +50-10%, 25V	56289	5020225
306	283-0639-00			CAP., FXD, MICA D:56PF, 1%, 100V	00853	502D225
307	283-0164-00			CAP., FXD, CER DI:2.2UF, 20%, 25V	04222	[18] [18] [18] [18] [18] [18] [18] [18]
308	281-0773-00			CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	3431-025E-225M
311	283-0649-00			CAP., FXD, MICA D:105PF, 1%, 300V		SA201C103KAA D153F1050F0
321	283-0164-00			CAP., FXD, CER DI:2.2UF, 20%, 25V	04222	3431-025E-225M
323	283-0615-00			CAP., FXD, MICA D:33PF, 5%, 500V	00853	D155E330J0
324	283-0615-00			CAP., FXD, MICA D:33PF, 5%, 500V		D155E330J0
328	281-0221-00	XB010611		CAP., VAR, CER DI:2-10PF.100V	59660	513-013A 2 0-10
331	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V	04222	SA205E104MAA
332 336	283-0616-00			CAP., FXD, MICA D:75PF, 5%, 500V		D155E750J0
	281-0139-00			CAP., VAR, CER DI:2.5-9PF, 100V		518-023 A 2.5-9
	283-0601-00			CAP., FXD, MICA D:22PF, 10%, 300V	00053	D1520000000
	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V	00853	D153C220K0
	283-0706-00			CAP., FXD, MICA D:91PF, +/-1PF,500V	04222 00853	SA205E104MAA
	283-0637-00			CAP., FXD, MICA D:20PF, 2.5%, 100V	00853	D155F910F0
	283-0363-00			CAP., FXD, CER DI:2.2PF, 0.25%, 2KV	72982	D151E200D0
356	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V		838-000C0K229C SA205E104MAA
	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V	04222	SA205E104MAA
	283-0164-00			CAP., FXD, CER DI:2.2UF, 20%, 25V	04222	3431-025E-225M
	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V	04222	SA205E104MAA
	281-0788-00			CAP., FXD, CER DI:470PF.10%.100V	72982	8005H9AADW5R471K
	281-0198-00 283-0059-00			CAP., VAR, AIR DI:1.7-11PF, 250V CAP., FXD, CER DI:1UF, +80-20%, 50V	74970	187-0306-105
393	281-0773-00				72982	8131N031Z5U0105Z
04	283-0084-00			CAP., FXD, CER DI:0.01UF, 10%, 100V CAP., FXD, CER DI:270PF, 5%, 1000V	04222	
05	283-0084-00			CAP.,FXD,CER DI:270PF,5%,1000V	59660	838 533X5F0 2715
	281-0773-00			CAP., FXD, CER DI:270PF, 5%, 1000V	59660	838 533X5F0 2715
	283-0059-00			CAP., FXD, CER DI:10.010F, 10%, 100V	04222	SA201C103KAA
.17 2	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V	72982 04222	8131N031Z5U0105Z SA205E104MAA
20 2	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V		
28 2	283-0024-00			CAP., FXD, CER DI:0.1UF.+80-20%.50V		SA205E104MAA
41 2	283-0597-00			CAP., FXD, MICA D:470PF, 10%, 300V		8121N083Z5U0104Z
	281-0775-00			CAP., FXD, CER DI:0.1UF, 20%, 50V		D153E471K0
	83-0119-00			CAP., FXD, CER DI:2200PF, 5%, 200V		SA205E104MAA 855-536Y5E0222J
	81-0773-00			CAP., FXD, CER DI:0.01UF, 10%, 100V	2,000	SA201C103KAA

Ckt No.		Serial/Model No. Eff Dscont	Name & Description	Mfr Code	Mfr Part Number
			CAP.,FXD,CER DI:0.1UF,+80-20%,50V	72982	8121N083Z5U0104Z
C468	283-0024-00		CAP., FXD, MICA D:250PF, 1%, 500V	09023	CD15FD251F03
C470	283-0785-00		CAP., FXD, MICA D:20PF, 2.5%, 100V	00853	D151E200D0
C472	283-0637-00		CAP., FXD, MICA D:87PF, 1%, 100V	00853	D151E870F0
C475	283-0632-00		CAP., FXD, MICA D:214PF, 1%, 500V		D155F2140F0
C485	283-0725-00		CAP., FXD, MICA D:214FF, 1%, 500V CAP., FXD, CER DI:0.1UF, 20%, 50V	04222	
C486	281-0775-00		CAP., FAD, CER DI.O. 101, 20%, 300		
C488	283-0164-00		CAP., FXD, CER DI:2.2UF, 20%, 25V	04222 04222	3431-025E-225M SA201C103KAA
C490	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	
C492	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	56289	500D149
C495	290-0748-00		CAP., FXD, ELCTLT: 10UF, +50-10%, 20V	56289	502D225
C501	290-0745-00	K	CAP., FXD, ELCTLT: 22UF, +50-10%, 25V	56289	502D225
C502	290-0745-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 25V	30207	J020223
C504	283-0164-00	i i	CAP., FXD, CER DI:2.2UF, 20%, 25V	04222	3431-025E-225M
	281-0209-00		CAP., VAR, AIR DI:1.3-5.4PF, 250V	74970	187-0303-105
C505			CAP. FXD.ELCTLT: 22UF, +50-10%, 25V	56289	502D225
C511	290-0745-00		CAP. FXD.MICA D:16.8PF,+/-0.5PF,500V	00853	
C514	283-0663-00 283-0663-00		CAP. FXD.MICA D:16.8PF,+/-0.5PF,500V	00853	
C515 C525	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	04222	SA205E104MAA
				09023	CD15FD251F03
C531	283-0785-00		CAP., FXD, MICA D:250PF, 1%, 500V CAP., FXD, MICA D:27PF, 5%, 500V	09023	
C532	283-0781-00		CAP., FXD, MICA D:12/PF, 3%, 300V	00853	
C533	283-0728-00)	CAP., FXD, MICA D:120PF, 1%, 500V	00853	
C534	283-0600-00		CAP., FXD, MICA D:43PF, 5%, 500V CAP., FXD, MICA D:16.8PF, +/-0.5PF, 500V	00853	
C535	283-0663-00	0	CAP., FXD, MICA D:150PF, 17,500V		D155F151F0
C536	283-0644-00	0	CAP., FXD, MICA D:150PF, 1%, 500V		
C537	283-0634-0	0	CAP., FXD, MICA D:65PF, 1%, 100V		D151E650F0
C538	283-0601-0		CAP., FXD, MICA D:22PF, 10%, 300V	00853	D153C220K0
		4() (0)	SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
CR104	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA		1N4152R
CR105	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA		1N4152R
CR106	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
CR107	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	
CR114	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
CR115	152-0141-0	2			
CR116	152-0141-0	2	SEMICOND DEVICE: SILICON, 30V, 150MA		1N4152R
CR117	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	
CR124	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA		1N4152R
CR127	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	
CR132	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R 1N4152R
CR133	152-0141-0		SEMICOND DEVICE:SILICON, 30V, 150MA	01293	1141321
	150 01/1 0		SEMICOND DEVICE:SILICON, 30V, 150MA		1N4152R
CR134	152-0141-0		SEMICOND DEVICE:SILICON,30V,150MA	01295	1N4152R
CR135	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA		1N4152R
CR136	152-0141-0		SEMICOND DEVICE:SILICON, 30V, 150MA		5 1N4152R
CR141	152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	
CR142 CR163	152-0141-0 152-0141-0		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	5 1N4152R
ONIOS	152 01.1	+1		01295	5 1N4152R
CR165	152-0141-0	02	SEMICOND DEVICE: SILICON, 30V, 150MA	01295	
CR196	152-0141-0	02	SEMICOND DEVICE: SILICON, 30V, 150MA	0129	
CR228	152-0141-0	02	SEMICOND DEVICE: SILICON, 30V, 150MA	0129	
CR232	152-0141-0	02	SEMICOND DEVICE: SILICON, 30V, 150MA	0129	
CR233	152-0141-0		SEMICOND DEVICE:SILICON,30V,150MA SEMICOND DEVICE:SILICON,30V,150MA	0129	
CR234	152-0141-	02	DEMICOND DEVICE: BILLION, 507, 13011		
CD225	152-0141-	02	SEMICOND DEVICE: SILICON, 30V, 150MA	0129	
CR235			SEMICOND DEVICE: SILICON, 30V, 150MA	0129	
CR244 CR251	152-0141		SEMICOND DEVICE: SILICON, 30V, 150MA	0129	
CR253			SEMICOND DEVICE: SILICON, 30V, 150MA	0129	A350.2020
CR263			SEMICOND DEVICE: SILICON, 30V, 150MA	0129	201 2020
CR264			SEMICOND DEVICE: SILICON, 30V, 150MA	0129	5 1N4152R
			SEMICOND DEVICE: SILICON, 30V, 150MA	0129	5 1N4152R
CR271	152-0141-	UZ	DELITORIE DE LETE		

CR272 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA SEMICOND DEV	01295 01295	5 1N4152R	
CR273 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR274 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR280 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR281 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR281 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR282 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR283 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR284 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR285 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR286 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR291 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR292 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR293 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR455 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V,	01295 01295		
CR274 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR280 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR281 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR282 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR283 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR284 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR285 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR286 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR291 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR292 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR293 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR297 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR298 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR299 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR425 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR426 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 114-0310-00 COIL, RF:12-43UH, CORE 276-0568-00 COIL, RF:VARIABLE, 22-80UH	01295		
CR280 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR281 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR282 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR283 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR284 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR285 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR286 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR291 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR292 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR293 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR425 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR426 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR463 152-0141-02 SEMICOND DEVICE:SILICON, 30V,		5 1N4152R 5 1N4152R	
CR281 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR282 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR283 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR284 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR285 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR286 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR291 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR292 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR293 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR297 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR298 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR299 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR290 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR291 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR291 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR301 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR301 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR401 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR402 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR401 152-0141-02 SEMICOND DEVICE:SILICON, 30V,		1N4152R	
CR282 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR283 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR284 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR285 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR286 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR291 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR292 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR293 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR425 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR426 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA			
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CR286 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR291 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR292 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR293 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR455 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 14-0310-00 COIL, RF:12-43UH, CORE 276-0568-00 COIL, RF:VARIABLE, 22-80UH	01295		
CR291 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR292 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR293 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR455 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 14-0310-00 COIL, RF:12-43UH, CORE 276-0568-00 COIL, RF:VARIABLE, 22-80UH	01295		
CR292 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR293 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR425 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR463 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR464 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR465 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA	01295		
CR293 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR294 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR425 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR463 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR464 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR465 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR463 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR464 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR465 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR466 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR467 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR468 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR469 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V,		1N4152R	
CR294 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR425 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 114-0280-00 COIL, RF:12-43UH, CORE 276-0568-00 L471 114-0310-00 COIL, RF:VARIABLE, 22-80UH	01295	1N4152R	
CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR425 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR463 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR464 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR465 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR463 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR464 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR465 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR466 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR467 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR468 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR469 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V,	01295	1N4152R	
CR295 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR296 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR363 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR455 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 114-0280-00 COIL, RF:12-43UH, CORE 276-0568-00 L471 114-0310-00 COIL, RF:VARIABLE, 22-80UH	01295	1N4152R	
CR363 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR371 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR455 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 114-0280-00 COIL,RF:12-43UH,CORE 276-0568-00 L471 114-0310-00 COIL,RF:VARIABLE,22-80UH	01295	1N4152R	
CR371 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR423 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR455 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 114-0280-00 COIL,RF:12-43UH,CORE 276-0568-00 L471 114-0310-00 COIL,RF:VARIABLE,22-80UH	01295	1N4152R	
CR423 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR424 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR425 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 144-0280-00 COIL,RF:12-43UH,CORE 276-0568-00 L471 114-0310-00 COIL,RF:VARIABLE,22-80UH	01295		
CR424 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR455 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA L211 114-0280-00 COIL,RF:12-43UH,CORE 276-0568-00 L471 114-0310-00 COIL,RF:VARIABLE,22-80UH	01295	1N4152R	
CR424 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR455 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA L211 114-0280-00 COIL, RF:12-43UH, CORE 276-0568-00 L471 114-0310-00 COIL, RF:VARIABLE, 22-80UH	01295	1N4152R	
CR455 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR456 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 COIL, RF:12-43UH, CORE 276-0568-00 L471 114-0310-00 COIL, RF:VARIABLE, 22-80UH		1N4152R	
CR456 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR460 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA L211 114-0280-00 COIL,RF:12-43UH,CORE 276-0568-00 L471 114-0310-00 COIL,RF:VARIABLE,22-80UH	01295		
CR460 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR461 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON,30V,150MA L211 114-0280-00 COIL,RF:12-43UH,CORE 276-0568-00 L471 114-0310-00 COIL,RF:VARIABLE,22-80UH		1N4152R	
CR461 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA CR462 152-0141-02 SEMICOND DEVICE:SILICON, 30V, 150MA L211 114-0280-00 COIL, RF:12-43UH, CORE 276-0568-00 L471 114-0310-00 COIL, RF:VARIABLE, 22-80UH		1N4152R	
L211 114-0280-00 COIL,RF:12-43UH,CORE 276-0568-00 L471 114-0310-00 COIL,RF:VARIABLE,22-80UH	01295		
L471 114-0310-00 COIL, RF: VARIABLE, 22-80UH	01295	1N4152R	
L471 114-0310-00 COIL,RF:VARIABLE,22-80UH	80009	114-0280-00	
	80009		
	80009		
L485 114-0280-00 COIL.RF:12-43UH.CORE 276-0568-00	80009		
L531 114-0310-00 COIL.RF: VARIABLE, 22-8011H	80009		
L533 114-0254-00 COIL, RF: 30-60UH, CORE NOT REPLACEABLE	80009		
L535 114-0280-00 COIL,RF:12-43UH,CORE 276-0568-00	80009	114-0280-00	
L537 114-0280-00 COIL, RF:12-43UH, CORE 276-0568-00	80009		
P515 119-1158-00 RES-CONN ASSY:	80009	119-1158-00	
Q104 151-0188-00 TRANSISTOR:SILICON, PNP	04713	CDC(9/ 0#	
Q105 151-0188-00 TRANSISTOR:SILICON,PNP			
Q114 151-0188-00 TRANSISTOR:SILICON,PNP	04713		
Q115 151-0188-00 TRANSISTOR:SILICON,PNP	04713		
Q122 151-0188-00 TRANSISTOR:SILICON,PNP		SPS6868K	
Q132 151-0188-00 TRANSISTOR:SILICON,PNP	04713	SPS6868K SPS6868K	
0126 151 0122 00			
O127 151 0100 00	04713	SPS6868K	
O1/O	04713	SPS6868K	
OLFO LEI CLOOK, FINE	04713	SPS6868K	
Olso 151 0007 00	04713	SPS6868K	
Q172 151-0223-00 TRANSISTOR: SILICON, NPN TRANSISTOR: SILICON, NPN	03508 04713	X32D6191 SPS8026	
0102 151 0100 00			
O212 151 0100 00	07263		
O21/	07263		
2002	07263		
O251 151 0100 00	01295	SKA6516	
TRANSISTOR.SILICON, FNF	04713	SPS6868K	
Q264 151-0190-00 TRANSISTOR: SILICON, NPN	07263	S032677	
Q275 151-0273-00 TRANSISTOR:SILICON,NPN	80009	151-0273-00	
Q284 151-0273-00 TRANSISTOR: SILICON, NPN	80009	151-0273-00	
Q285 151-0273-00 TRANSISTOR:SILICON,NPN	80009		

		erial/Mode			Mfr	BAG. Doub Number
Ckt No.	Part No. Et	ff	Dscont	Name & Description	Code	Mfr Part Number
	151 0070 00			TRANSFERD CLITCON NRN	80009	151-0273-00
Q286	151-0273-00			TRANSISTOR: SILICON, NPN		151-0273-00
Q287	151-0273-00			TRANSISTOR: SILICON, NPN		151-0273-00
Q294	151-0273-00			TRANSISTOR: SILICON, NPN		151-0273-00
Q295	151-0273-00			TRANSISTOR: SILICON, NPN		
Q315	151-0192-00			TRANSISTOR: SILICON, NPN, SEL FROM MPS6521	04713	
Q321	151-0220-00			TRANSISTOR: SILICON, PNP	07263	S036228
Q325	151-0220-00			TRANSISTOR: SILICON, PNP	07263	
Q331	151-0220-00			TRANSISTOR: SILICON, PNP	07263	S036228
Q332	151-0223-00			TRANSISTOR: SILICON, NPN	04713	SPS8026
Q339	151-0220-00			TRANSISTOR: SILICON, PNP	07263	S036228
Q342	151-1022-00			TRANSISTOR: FET, N-CHAN, SI, F1782, T0-18	17856	FN1234
Q343	151-1032-00			TRANSISTOR: SILICON, FET, DUAL	17856	DN399
Q344	151-0220-00			TRANSISTOR: SILICON, PNP	07263	
Q345	151-0198-00			TRANSISTOR: SILICON, NPN, SEL FROM MPS918	04713	SPS8802-1
Q346	151-0198-00			TRANSISTOR: SILICON, NPN, SEL FROM MPS918	04713	
Q347	151-0220-00			TRANSISTOR: SILICON, PNP	07263	S036228
Q348	151-0437-00			TRANSISTOR: SILICON, NPN, SEL FROM 2N5769	80009	151-0437-00
Q352	151-0367-00			TRANSISTOR: SILICON, NPN, SEL FROM 3571TP	01295	SKA6516
Q362	151-0367-00			TRANSISTOR:SILICON, NPN, SEL FROM 3571TP	01295	SKA6516
Q363	151-0333-00	B010100	B010222	TRANSISTOR: SILICON, NPN, SEL FROM MPS918	04713	SPS1752
Q363	151-0313-00	B010100	D010222	TRANSISTOR:SILICON, NPN	04713	SRF 518
	151-0212-00	B010223		TRANSISTOR: SILICON, PNP	07263	S036228
Q371 Q395	151-0220-00			TRANSISTOR: SILICON, PNP	07263	S036228
Q415	151-0220-00			TRANSISTOR:SILICON, NPN, SEL FROM MPS6521	04713	SPS8801
0/0/	151 0/29 00			TRANSISTOR: SILICON, PNP, SEL FROM SPS6927	80009	151-0438-00
Q424	151-0438-00			TRANSISTOR: SILICON, PNP		S036228
Q426	151-0220-00			TRANSISTOR: SILICON, NPN		s032677
Q427	151-0190-00			TRANSISTOR: SILICON, NPN		SPS8026
Q432	151-0223-00				04713	
Q433	151-0188-00			TRANSISTOR: SILICON, PNP	04713	
Q434	151-0188-00			TRANSISTOR: SILICON, PNP		
Q435	151-0188-00			TRANSISTOR: SILICON, PNP	04713	
Q440	151-0220-00			TRANSISTOR: SILICON, PNP	07263	
Q449	151-0190-00			TRANSISTOR: SILICON, NPN		S032677
Q453	151-0223-00			TRANSISTOR: SILICON, NPN		SPS8026
Q456	151-0188-00			TRANSISTOR: SILICON, PNP	04713	
Q463	151-0192-00			TRANSISTOR: SILICON, NPN, SEL FROM MPS6521	04713	SPS8801
Q469	151-0216-00			TRANSISTOR: SILICON, PNP	04713	
Q478	151-0367-00			TRANSISTOR: SILICON, NPN, SEL FROM 3571TP	01295	
Q488	151-0438-00			TRANSISTOR: SILICON, PNP, SEL FROM SPS6927	80009	
Q504	151-0411-00			TRANSISTOR: SILICON, NPN		SRF709
Q506	151-0438-00			TRANSISTOR: SILICON, PNP, SEL FROM SPS6927		151-0438-00
Q508	151-0410-00			TRANSISTOR: SILICON, PNP	80009	151-0410-00
Q524	151-0190-00			TRANSISTOR: SILICON, NPN	07263	S032677
R101	321-0289-00			RES., FXD, FILM: 10K OHM, 1%, 0.125W	91637	
R102	321-0289-00			RES., FXD, FILM: 10K OHM, 1%, 0.125W	91637	
R106	321-0338-00			RES., FXD, FILM: 32.4K OHM, 1%, 0.125W	91637	
R107	321-0634-00			RES., FXD, FILM:84.65K OHM, 0.25%, 0.125W	91637	
R108	311-1245-00			RES., VAR, NONWIR: 10K OHM, 10%, 0.50W	73138	
R109	311-1245-00			RES., VAR, NONWIR: 10K OHM, 10%, 0.50W	73138	72-28-0
R112	311-1240-00			RES., VAR, NONWIR: 25K OHM, 10%, 0.50W	73138	
R113	321-0370-00			RES., FXD, FILM: 69.8K OHM, 1%, 0.125W	91637	
R114	321-0285-00			RES., FXD, FILM: 9.09K OHM, 1%, 0.125W	91637	the contract of the contract o
R115	321-0360-00			RES., FXD, FILM: 54.9K OHM, 1%, 0.125W	91637	
R116	321-0273-00			RES., FXD, FILM: 6.81K OHM, 1%, 0.125W	91637	
R117	321-0332-07			RES., FXD, FILM: 28K OHM, 0.1%, 0.125W	91637	MFF1816C28001B
R118	311-1237-00			RES., VAR, NONWIR: 1K OHM, 10%, 0.50W	32997	3386X-T07-102
0.00001570000						

Ckt No.	Tektronix Part No.	Serial/Mod Eff	el No. Dscont	Name & Description	Mfr Code	Mfr Part Numbe
R119	311-1239-00	THE PROPERTY OF		RES., VAR, NONWIR: 2.5K OHM, 10%, 0.50W	701.00	
R120	307-0540-00			RES, NTWK, FXD, FI: (5) 1K OHM, 10%, 0.7W	73138	
R123	315-0472-00			DEC EVD CMDCN / 7K OWN 5% 0 05%	01121	
R124	321-0248-00			RES.,FXD,CMPSN:4.7K OHM,5%,0.25W	01121	
R125	321-0651-00			RES., FXD, FILM: 3.74K OHM, 1%, 0.125W	91637	
R126	321-0631-00			RES.,FXD,FILM:15.8K OHM,0.25%,0.125W RES.,FXD,FILM:4.64K OHM,1%,0.125W	91637 91637	
R127	221 0651 00				71037	
R128	321-0651-00			RES.,FXD,FILM:15.8K OHM,0.25%,0.125W	91637	
R129	311-1237-00			RES., VAR, NONWIR: 1K OHM, 10%, 0.50W	32997	
R133	311-1237-00 315-0512-00			RES., VAR, NONWIR: 1K OHM, 10%, 0.50W	32997	
R134	321-0357-00			RES.,FXD,CMPSN:5.1K OHM,5%,0.25W	01121	
R136	321-0241-00			RES., FXD, FILM:51.1K OHM, 1%, 0.125W	91637	
	321 0241 00			RES., FXD, FILM: 3.16K OHM, 1%, 0.125W	91637	MFF1816G31600F
R137 R138	321-0674-00			RES.,FXD,FILM:17.4K OHM,0.5%,0.125W	24546	NC55C1742D
R139	311-1242-00			RES., VAR, NONWIR: 200K OHM, 10%, 0.50W	02111	63X-204-T602
R141	311-1243-00 315-0103-00			RES., VAR, NONWIR: 500K OHM, 10%, 0.50W	73138	
R142	315-0101-00			RES.,FXD,CMPSN:10K OHM,5%,0.25W	01121	
R143	321-0373-00			RES.,FXD,CMPSN:100 OHM,5%,0.25W	01121	CB1015
	521 05/5 00			RES., FXD, FILM: 75K OHM, 1%, 0.125W	91637	MFF1816G75001F
R144 R145	321-0216-00			RES., FXD, FILM:1.74K OHM, 1%, 0.125W	91637	MFF1816G17400F
146	321-0222-00			RES., FXD, FILM: 2K OHM, 1%, 0.125W	91637	MFF1816G20000F
147	311-1237-00			RES., VAR, NONWIR: 1K OHM, 10%, 0.50W	32997	3386X-T07-102
148	321-0294-00 321-0240-00			RES., FXD, FILM:11.3K OHM, 1%, 0.125W	91637	MFF1816G11301F
149	321-0240-00			RES., FXD, FILM: 3.09K OHM, 1%, 0.125W	91637	MFF1816G30900F
147	321-0414-00			RES., FXD, FILM: 200K OHM, 1%, 0.125W	91637	MFF1816G20002F
151	315-0101-00			RES., FXD, CMPSN:100 OHM, 5%, 0.25W	01121	CB1015
152	315-0102-00			RES., FXD, CMPSN:1K OHM, 5%, 0.25W	01121	CB1025
153	315-0103-00			RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	CB1035
156	311-1460-00	B010100	B010292	RES., VAR NONWIR: 10K OHM, 20%, 1W	01121	73J1G040L103M
156	311-2061-00	B010293		RES., VAR, NONWIR: PNL, 10K OHM, 10%, 0.5W	01121	73J1G040L103U
157	315-0102-00			RES., FXD, CMPSN:1K OHM, 5%, 0.25W	01121	CB1025
158	315-0333-00			RES., FXD, CMPSN: 33K OHM, 5%, 0.25W	01121	CB3335
160	307-0445-00			RES NTWK, FXD, FI:4.7K OHM, 20%, (9) RES	91637	MSP10A01-472M
162	315-0682-00			RES., FXD, CMPSN: 6.8K OHM, 5%, 0.25W	01121	CB6825
163	315-0682-00			RES., FXD, CMPSN: 6.8K OHM, 5%, 0.25W	01121	CB6825
164 166	131-0566-00			BUS CONDUCTOR: DUMMY RES, 2.375, 22 AWG	57668	JWW-0200E0
100	315-0112-00			RES.,FXD,CMPSN:1.1K OHM,5%,0.25W	01121	CB1125
167	321-0336-00			RES.,FXD,FILM:30.9K OHM,1%,0.125W	91637	MFF1816G30901F
168	315-0472-00			(NOMINAL VALUE, SELECTED)		
169	321-0310-00			RES.,FXD,CMPSN:4.7K OHM,5%,0.25W	01121	CB4725
10)				RES., FXD, FILM:16.5K OHM, 1%, 0.125W	91637	MFF1816G16501F
170	315-0103-00			(NOMINAL VALUE, SELECTED) RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	CB1035
172	315-0102-00					
	315-0103-00			RES., FXD, CMPSN:1K OHM, 5%, 0.25W		CB1025
	321-0303-00			RES., FXD, CMPSN:10K OHM, 5%, 0.25W	01121	CB1035
	315-0470-00			RES., FXD, FILM:14K OHM, 1%, 0.125W	91637	MFF1816G14001F
	315-0470-00			RES.,FXD,CMPSN:47 OHM,5%,0.25W RES.,FXD,CMPSN:47 OHM,5%,0.25W	01121	CB4705
	315-0103-00			RES., FXD, CMPSN:147 OHM, 5%, 0.25W	01121 01121	CB4705 CB1035
190	315-0101-00			RES.,FXD,CMPSN:100 OHM,5%,0.25W		
191	315-0332-00			RES., FXD, CMPSN:3.3K OHM, 5%, 0.25W		CB1015
	315-0100-00			RES., FXD, CMPSN:10 OHM, 5%, 0.25W	01121	CB3325
	315-0103-00			RES., FXD, CMPSN:10K OHM, 5%, 0.25W	01121	CB1005
	315-0470-00	a =		RES., FXD, CMPSN:47 OHM, 5%, 0.25W	01121	CB1035
	307-0540-00			RES, NTWK, FXD, FI: (5) 1K OHM, 10%, 0.7W		CB4705 206A102
	321-0208-00			RES., FXD, FILM: 1.43K OHM, 1%, 0.125W		
					91637	MFF1816G14300F
	321-0289-00			RES., FXD, FILM: 10K OHM, 1%, 0.125W	91637	MFF1816G10001F

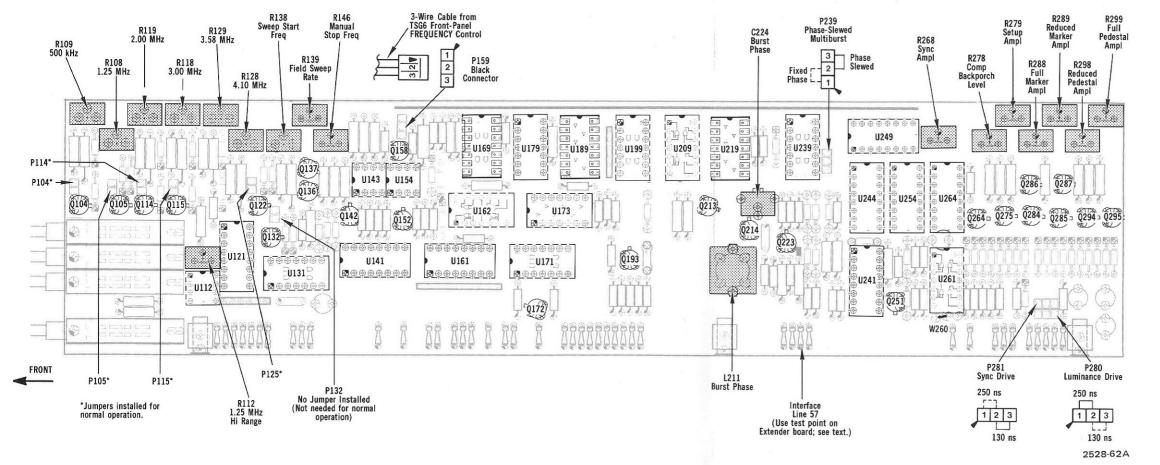
Ckt No.	Tektronix Part No.	Serial/Model No. Eff Dscont	Name & Description	Mfr Code	Mfr Part Number	_
R222	221-0222-00		RES.,FXD,FILM:2K OHM,1%,0.125W	91637	MFF1816G20000F	
	321-0222-00		RES.,FXD,CMPSN:2.2K OHM,5%,0.25W	15	CB2225	
R224 R225	315-0222-00 315-0272-00		RES., FXD, CMPSN: 2.7K OHM, 5%, 0.25W		CB2725	
R227	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025	
R228	315-0472-00		RES., FXD, CMPSN: 4.7K OHM, 5%, 0.25W	01121	CB4725	
R230	315-0471-00		RES., FXD, CMPSN: 470 OHM, 5%, 0.25W	01121	CB4715	
R232	321-0181-00		RES., FXD, FILM: 750 OHM, 1%, 0.125W		MFF1816G750R0F	
R234	315-0361-00		RES., FXD, CMPSN: 360 OHM, 5%, 0.25W		CB3615	
R240	315-0912-00		RES., FXD, CMPSN: 9.1K OHM, 5%, 0.25W		CB9125	
R242	321-0257-00		RES., FXD, FILM: 4.64K OHM, 1%, 0.125W		MFF1816G46400F	
R243	321-0289-00		RES., FXD, FILM: 10K OHM, 1%, 0.125W		MFF1816G10001F	
R251	315-0471-00	6	RES., FXD, CMPSN: 470 OHM, 5%, 0.25W		CB4715	
R252	321-0278-00		RES.,FXD,FILM:7.68K OHM,1%,0.125W (NOMINAL VALUE,SELECTED)		MFF1816G76800F	
R253	315-0100-00	Î	RES., FXD, CMPSN:10 OHM, 5%, 0.25W		CB1005	
R254	315-0751-00		RES., FXD, CMPSN: 750 OHM, 5%, 0.25W		CB7515	
R260	315-0202-00		RES., FXD, CMPSN: 2K OHM, 5%, 0.25W		CB2025	
R261	315-0361-00)	RES., FXD, CMPSN: 360 OHM, 5%, 0.25W	01121	CB3615	
R262	315-0361-00)	RES., FXD, CMPSN: 360 OHM, 5%, 0.25W	01121	CB3615	
R263	315-0361-00)	RES., FXD, CMPSN: 360 OHM, 5%, 0.25W		CB3615	
R265	315-0102-00)	RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025	
R268	311-1245-00)	RES., VAR, NONWIR: 10K OHM, 10%, 0.50W		72-28-0 CB3615	
R270	315-0361-00		RES., FXD, CMPSN: 360 OHM, 5%, 0.25W		CB3615	
R271	315-0361-00)	RES.,FXD,CMPSN:360 OHM,5%,0.25W			
R272	315-0361-00)	RES., FXD, CMPSN: 360 OHM, 5%, 0.25W		CB3615	
R275	321-0329-00)	RES., FXD, FILM: 26.1K OHM, 1%, 0.125W	91637		
R276	321-0367-00)	RES., FXD, FILM: 64.9K OHM, 1%, 0.125W	91637		
R277	321-0387-00)	RES., FXD, FILM: 105K OHM, 1%, 0.125W	91637	MFF1816G10502F 63X-503-T602	
R278	311-1246-00		RES., VAR, NONWIR: 50K OHM, 10%, 0.50W	02111		
R279	311-1246-00)	RES., VAR, NONWIR: 50K OHM, 10%, 0.50W	02111		
R280	315-0101-00)	RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	ACCUSATION AND ADDRESS OF THE PARTY AND ADDRES	
R286	311-0325-00	0	RES., VAR, NONWIR: 2.5M OHM, 20%	12697 73138		
R288	311-1245-00		RES., VAR, NONWIR: 10K OHM, 10%, 0.50W	73138		
R289	311-1245-00		RES., VAR, NONWIR:10K OHM, 10%, 0.50W RES., FXD, CMPSN:100 OHM, 5%, 0.25W	01121		
R291	315-0101-00		RES., FXD, FILM: 37.4K OHM, 1%, 0.125W	91637		
R295	321-0344-00	U				
R296	321-0344-00	0	RES., FXD, FILM: 37.4K OHM, 1%, 0.125W	91637		
R297	321-0325-00	0	RES., FXD, FILM: 23.7K OHM, 1%, 0.125W	91637		
R298	311-1245-00		RES., VAR, NONWIR: 10K OHM, 10%, 0.50W		72-28-0	
R299	311-1245-00		RES., VAR, NONWIR: 10K OHM, 10%, 0.50W	73130	72-28-0 MFF1816G30100F	
R305 R306	321-0239-00 315-0202-00		RES., FXD, FILM: 3.01K OHM, 1%, 0.125W RES., FXD, CMPSN: 2K OHM, 5%, 0.25W	01121		
000	313-0202-0	O.	4000000 to \$1000000000000000000000000000000000000	01101	CP2025	
R308	315-0202-0		RES., FXD, CMPSN: 2K OHM, 5%, 0.25W	01121		
R309	311-1241-0		RES., VAR, NONWIR: 100K OHM, 10%, 0.5W	32997 01121		
R311	315-0132-0		RES.,FXD,CMPSN:1.3K OHM,5%,0.25W RES.,FXD,CMPSN:2K OHM,5%,0.25W	01121		
R312	315-0202-0		RES., FXD, CMPSN: 2K OHM, 5%, 0.25W	01121		
R313	315-0302-0		RES., FXD, FILM: 2K OHM, 1%, 0.125W	91637		
R314	321-0222-0	U		01/27	WEE1 01 4 04 2 P/AF	
R315	321-0078-0		RES., FXD, FILM: 63.4 OHM, 1%, 0.125W	91637 01121	MFF1816G63R40F CB1035	
R316	315-0103-0		RES., FXD, CMPSN: 10K OHM, 5%, 0.25W		MFF1816G20000F	
R317	321-0222-0		RES., FXD, FILM: 2K OHM, 1%, 0.125W	01121		
R318	315-0101-0		RES.,FXD,CMPSN:100 OHM,5%,0.25W RES.,VAR,NONWIR:10K OHM,10%,0.50W	73138		
R319	311-1245-0		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121		
R322	315-0102-0	TU .				
R323	315-0682-0		RES., FXD, CMPSN: 6.8K OHM, 5%, 0.25W	01121		
R324	315-0272-0		RES., FXD, CMPSN: 2.7K OHM, 5%, 0.25W	01121 01121		
R325	315-0202-0	00	RES., FXD, CMPSN: 2K OHM, 5%, 0.25W	01121	322023	

Ckt No.	Tektronix Part No.	Serial/Model No. Eff Dscont	Name & Description	Mfr Code	Mfr Part Numb
D226	215 0100 05				20 10 10 10 10 10 10 10 10 10 10 10 10 10
R326	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
R327	321-0174-00		RES., FXD, FILM: 634 OHM, 1%, 0.125W	91637	MFF1816G634R0F
R328	321-0105-00		RES., FXD, FILM: 121 OHM, 1%, 0.125W	91637	MFF1816G121R0F
R329	315-0272-00		RES., FXD, CMPSN: 2.7K OHM, 5%, 0.25W		CB2725
R331	315-0101-00		RES., FXD, CMPSN:100 OHM, 5%, 0.25W		
R332	315-0682-00		RES., FXD, CMPSN: 6.8K OHM, 5%, 0.25W		CB1015
2001				01121	CB6825
R334 R335	315-0122-00		RES., FXD, CMPSN:1.2K OHM, 5%, 0.25W		CB1225
R336	315-0332-00		RES., FXD, CMPSN: 3.3K OHM, 5%, 0.25W	01121	CB3325
R337	315-0391-00		RES., FXD, CMPSN: 390 OHM, 5%, 0.25W	01121	CB3915
	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025
R339	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025
R340	315-0182-00		RES., FXD, CMPSN:1.8K OHM, 5%, 0.25W		CB1825
R341	315-0512-00		RES., FXD, CMPSN: 5.1K OHM, 5%, 0.25W	01121	CDE 1 25
R342	315-0201-00		RES., FXD, CMPSN: 200 OHM, 5%, 0.25W		CB5125
R346	315-0271-00		RES., FXD, CMPSN: 270 OHM, 5%, 0.25W		CB2015
R348	315-0511-00		DES TYD CMDCN.510 OUN 5% 0.05		CB2715
R349	311-1920-00		RES., FXD, CMPSN: 510 OHM, 5%, 0.25W		CB5115
R350	315-0200-00		RES., VAR, NONWIR: 500 OHM, 10%, 0.50W		72-190-0
			RES.,FXD,CMPSN:20 OHM,5%,0.25W	01121	CB2005
R351	315-0101-00		RES., FXD, CMPSN:100 OHM, 5%, 0.25W	01121	CB1015
R352	321-0103-00		RES., FXD, FILM: 115 OHM, 1%, 0.125W		MFF1816G115R0F
R353	315-0200-00		RES., FXD, CMPSN: 20 OHM, 5%, 0.25W	01121	CB2005
R354	315-0201-00		RES., FXD, CMPSN: 200 OHM, 5%, 0.25W		CB2005
R359	311-1918-00		RES., VAR, NONWIR: 2K OHM, 10%, 0.50W		72-199-0
R360	315-0511-00		RES., FXD, CMPSN:510 OHM, 5%, 0.25W		CB5115
R361	221 0102 00			01121	CD3113
	321-0103-00		RES., FXD, FILM: 115 OHM, 1%, 0.125W	91637	MFF1816G115R0F
R364	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W		CB1015
R365	321-0222-07		RES., FXD, FILM: 2K OHM, 0.1%, 0.125W		MFF1816C20000B
R366	315-0511-00		RES., FXD, CMPSN:510 OHM, 5%, 0.25W		CB5115
R367	321-0222-07		RES., FXD, FILM: 2K OHM, 0.1%, 0.125W		
			(NOMINAL VALUE, SELECTED)	91037	MFF1816C20000B
R368	321-0703-00		DEC EVD ETIM 2 10V OWN 0 05W 0 105W	AMMAN TERMS AT	
R369	311-1917-00		RES., FXD, FILM: 2.19K OHM, 0.25%, 0.125W		NE55E2191C
R370	315-0103-00		RES., VAR, NONWIR: TRMR, 5K OHM, 10%, 0.5W	73138	72-198-0
R372			RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	CB1035
R372	315-0331-00		RES., FXD, CMPSN: 330 OHM, 5%, 0.25W		CB3315
6167	315-0103-00		RES., FXD, CMPSN: 10K OHM, 5%, 0.25W		CB1035
			(NOMINAL VALUE, SELECTED)		021033
R374	315-0101-00		RES.,FXD,CMPSN:100 OHM,5%,0.25W	01101	
R375	315-0202-00		RES., FXD, CMPSN: 2K OHM, 5%, 0.25W		CB1015
R376	321-0830-03		RES FYD ETIMO AND ONE OF THE OFFICE O		CB2025
R377	321-0257-09		RES., FXD, FILM: 2.41K OHM, 0.25%, 0.125W		MFF1816D24100C
R378	321-0256-07		RES., FXD, FILM: 4.64K OHM, 1%, 0.125W		MFF1816C46400F
R379	311-1920-00		RES., FXD, FILM: 4.53K OHM, 0.1%, 0.125W		MFF1816C45300B
,	J.1 1720-00		RES., VAR, NONWIR: 500 OHM, 10%, 0.50W		72-190-0
R380	321-0771-01		RES.,FXD,FILM:50 OHM,0.5%,0.125W	01627	MEELOLGE COOK
R381	321-0231-00		RES., FXD, FILM: 2.49K OHM, 1%, 0.125W		MFF1816G50R00D
R383	321-0208-00		RES., FXD, FILM: 1.43K OHM, 1%, 0.125W		MFF1816G24900F
R384	321-0242-00		RES.,FXD,FILM:1.45K OHM,1%,0.125W		MFF1816G14300F
R385	315-0621-00		RES EVD CMBCN. 620 OW 5%	91637	MFF1816G32400F
R386	321-0612-00		RES., FXD, CMPSN: 620 OHM, 5%, 0.25W	01121	CB6215
			RES.,FXD,FILM:500 OHM,1%,0.125W	91637	MFF1816G500R0F
R387	321-1645-03		RES., FXD, FILM: 841 OHM, 0.25%, 0.125W	91637	MFF1816D84100C
	315-0821-00		RES., FXD, CMPSN: 820 OHM, 5%, 0.25W		
	311-1920-00		RES., VAR, NONWIR: 500 OHM, 10%, 0.50W		CB8215
R393	315-0100-00		RES., FXD, CMPSN:10 OHM, 5%, 0.25W		72-190-0
R394	315-0100-00	31	RES EXD CMPCN.10 OWN 5% 0.25W		CB1005
	315-0101-00		RES., FXD, CMPSN:10 OHM, 5%, 0.25W RES., FXD, CMPSN:100 OHM, 5%, 0.25W		CB1005
				01121	CB1015
	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
ハンフフ	311-1236-00 315-0431-00		RES., VAR, NONWIR: 250 OHM, 10%, 0.50W RES., FXD, CMPSN: 430 OHM, 5%, 0.25W		72-22-0
R402					

	Tektronix	Serial/Model No.		Mfr	9	
Ckt No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number	
R403	315-0431-00		RES., FXD, CMPSN: 430 OHM, 5%, 0.25W	01121	CB4315	
R405	321-0222-07		RES., FXD, FILM: 2K OHM, 0.1%, 0.125W	91637		
R406	321-0222-07		RES., FXD, FILM: 2K OHM, 0.1%, 0.125W	91637		
R407	315-0821-00		RES., FXD, CMPSN:820 OHM, 5%, 0.25W	01121		
R408	315-0101-00		RES., FXD, CMPSN:100 OHM, 5%, 0.25W	01121	CB1015	
R409	315-0202-00		RES., FXD, CMPSN: 2K OHM, 5%, 0.25W	01121	CB2025	
R415	321-0277-00		RES., FXD, FILM: 7.5K OHM, 1%, 0.125W	91637	MFF1816G75000F	
R416	321-0276-00		RES., FXD, FILM: 7.32K OHM, 1%, 0.125W	91637	MFF1816G73200F	
R417	315-0621-00		RES., FXD, CMPSN: 620 OHM, 5%, 0.25W	01121	CB6215	
R418	315-0512-00		RES., FXD, CMPSN: 5.1K OHM, 5%, 0.25W	01121		
R420	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025	
R421	315-0103-00		RES., FXD, CMPSN:10K OHM, 5%, 0.25W	01121	CB1035	
R422	315-0152-00		RES., FXD, CMPSN:1.5K OHM, 5%, 0.25W	01121		
R425	321-0291-00		RES., FXD, FILM: 10.5K OHM, 1%, 0.125W	91637		
R427	321-0233-00		RES., FXD, FILM: 2.61K OHM, 1%, 0.125W	91637		
R429	311-1920-00		RES., VAR, NONWIR: 500 OHM, 10%, 0.50W		72-190-0	
R430	315-0332-00		RES., FXD, CMPSN: 3.3K OHM, 5%, 0.25W		CB3325	
R434	321-0257-00		RES., FXD, FILM: 4.64K OHM, 1%, 0.125W	91637	MFF1816G46400F	
R435	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025	
R436	321-0215-00		RES., FXD, FILM: 1.69K OHM, 1%, 0.125W	91637	MFF1816G16900F	
R437	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121		
R438	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W		CB1015	
R439	311-1244-00		RES., VAR, NONWIR: 100 OHM, 10%, 0.50W	32997		
R440	315-0102-00	1	RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025	
R441	315-0432-00	ı	RES., FXD, CMPSN: 4.3K OHM, 5%, 0.25W	01121		
R442	311-1245-00)	RES., VAR, NONWIR: 10K OHM, 10%, 0.50W		72-28-0	
R443	315-0102-00)	RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025	
R444	315-0101-00)	RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121		
R445	321-0313-00		RES., FXD, FILM: 17.8K OHM, 1%, 0.125W		MFF1816G17801F	
R446	315-0101-00)	RES.,FXD,CMPSN:100 OHM,5%,0.25W	01121	CB1015	
R447	315-0101-00)	RES., FXD, CMPSN: 100 OHM, 5%, 0.25W		CB1015	
R448	315-0101-00)	RES., FXD, CMPSN:100 OHM, 5%, 0.25W		CB1015	
R450	315-0102-00)	RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025	
R451	315-0302-00)	RES., FXD, CMPSN: 3K OHM, 5%, 0.25W		CB3025	
R452	315-0472-00)	RES., FXD, CMPSN: 4.7K OHM, 5%, 0.25W	01121		
R454	321-0237-00)	RES., FXD, FILM: 2.87K OHM, 1%, 0.125W	91637	MFF1816G28700F	
R455	315-0472-00)	RES.,FXD,CMPSN:4.7K OHM,5%,0.25W		CB4725	
R456	315-0102-00)	RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025	
R457	315-0162-00		RES., FXD, CMPSN: 1.6K OHM, 5%, 0.25W		CB1625	
R458	315-0152-00		RES., FXD, CMPSN: 1.5K OHM, 5%, 0.25W		CB1525 72-28-0	
R459	311-1245-00		RES., VAR, NONWIR: 10K OHM, 10%, 0.50W	73138	MFF1816G10001F	
R460	321-0289-00)	RES.,FXD,FILM:10K OHM,1%,0.125W	91037	HITTOTOGTOOOTI	
R462	315-0472-00)	RES., FXD, CMPSN: 4.7K OHM, 5%, 0.25W	01121		
R463	315-0101-00)	RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015	
R464	315-0512-00)	RES., FXD, CMPSN: 5.1K OHM, 5%, 0.25W	01121		
R465	315-0101-00)	RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121		
R466	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121		
R467	315-0162-00)	RES.,FXD,CMPSN:1.6K OHM,5%,0.25W	01121	CB1625	
R469	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W	01121		
R471	321-0164-00		RES., FXD, FILM: 499 OHM, 1%, 0.125W	91637		
R474	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121 91637	CB1015 MFF1816C11500C	
R476	321-0199-0		RES., FXD, FILM: 1.15K OHM, 0.25%, 0.125W	91637	MFF1816G11500F	
R477	321-0199-00		RES.,FXD,FILM:1.15K OHM,1%,0.125W RES.,FXD,FILM:200 OHM,1%,0.125W	91637		
R478	321-0126-0	U				
R479	311-1140-0	0	RES., VAR, NONWIR: TRMR, 100 OHM, 0.5W	32997	The state of the s	
R480	315-0101-0	0	RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121		
R481	315-0391-0	0	RES., FXD, CMPSN: 390 OHM, 5%, 0.25W	01121	CB3915	

Ckt No.	Tektronix Part No.	Serial/Model No. Eff Dscont	Name & Description	Mfr Code	Mfr Part Number
R482	315-0222-00				
R483	315-0511-00		RES.,FXD,CMPSN:2.2K OHM,5%,0.25W RES.,FXD,CMPSN:510 OHM,5%,0.25W		CB2225
R484	321-0812-07		RES., FAD, CMPSN: 510 OHM, 5%, 0.25W		CB5115
R485	321-0312-07		RES., FXD, FILM: 455 OHM, 0.1%, 0.125W		MFF1816C455R0B
R487			RES., FXD, FILM: 200 OHM, 1%, 0.125W		MFF1816G200R0F
R489	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W	01121	CB4705
R489	311-1236-00		RES., VAR, NONWIR: 250 OHM, 10%, 0.50W	73138	72-22-0
R490	315-0222-00		RES., FXD, CMPSN: 2.2K OHM, 5%, 0.25W	01121	CB2225
R491	315-0472-00		RES., FXD, CMPSN: 4.7K OHM, 5%, 0.25W	01121	CB4725
R492	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015
R493	311-1936-00		RES., VAR, NONWIR: CKT BD, 50 OHM, 20%, 0.5W	73138	MODEL 72X
R494	321-0812-07		RES., FXD, FILM: 455 OHM, 0.1%, 0.125W	91637	MFF1816C455R0B
R495	315-0622-00		RES., FXD, CMPSN: 6.2K OHM, 5%, 0.25W	01121	CB6225
R496	321-0256-00		RES., FXD, FILM: 4.53K OHM, 1%, 0.125W	91637	MFF1816G45300F
R497	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W	01121	
R498	321-0289-00		RES., FXD, FILM: 10K OHM, 1%, 0.125W		MFF1816G10001F
R501	315-0472-00		RES., FXD, CMPSN: 4.7K OHM, 5%, 0.25W		CB4725
R507	321-0251-00		RES., FXD, FILM: 4.02K OHM, 1%, 0.125W		MFF1816G40200F
R508	315-0302-00		RES., FXD, CMPSN: 3K OHM, 5%, 0.25W	01121	CB3025
R512	308-0076-00		RES.,FXD,WW:300 OHM.5%,3W	14193	SA30300 OHM 5%
R513	321-0085-00		RES., FXD, FILM: 75 OHM, 1%, 0.125W		MFF1816G75R00F
R514	321-0085-00		RES., FXD, FILM: 75 OHM, 1%, 0.125W	91637	MFF1816G75R00F
R516	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W		CB4705
R517	315-0681-00		RES., FXD, CMPSN: 680 OHM, 5%, 0.25W		CB6815
R518	321-0277-00		RES., FXD, FILM: 7.5K OHM, 1%, 0.125W		MFF1816G75000F
R519	321-0277-00		RES., FXD, FILM: 7.5K OHM, 1%, 0.125W		
R522	321-0277-00			91637	MFF1816G75000F
R523	321-0277-00		RES.,FXD,FILM:7.5K OHM,1%,0.125W RES.,FXD,FILM:7.5K OHM,1%,0.125W	91637	MFF1816G75000F
R525	315-0392-00		RES., FXD, CMPSN: 3.9K OHM, 5%, 0.25W	91637	MFF1816G75000F
R527	321-0612-00		RES., FXD, FILM: 500 OHM, 1%, 0.125W	01121	CB3925
R528	321-0612-00		RES.,FXD,FILM:500 OHM,1%,0.125W	91637	MFF1816G500R0F MFF1816G500R0F
S100 S102)	263-0010-00		SWITCH PB ASSY:1 PUSH,7.5MM,W/2 CONTACTS	80009	263-0010-00
S103 S104	263-0015-02		SWITCH PB ASSY:3 LCH,7.5MM,6 CONTACTS	80009	263-0015-02
\$300 \$302	263-0010-00		SWITCH PB ASSY:1 PUSH,7.5MM,W/2 CONTACTS	80009	263-0010-00
S303 S335					
T474	120-1070-00		TRANSFORMER, RF: TOROID, 12 TURNS QUADFILAR	80009	120-1070-00
U112	156-0158-00		MICROCIRCUIT, LI: DUAL OPERATIONAL AMPLIFIER	18324	MC1458N
U121	160-0157-00		MICROCIRCUIT, DI: 32 X 8 PROM, PROGRAMMED	80009	160-0157-00
U131	156-0382-00		MICROCIRCUIT, DI: QUAD 2-INPUT NAND GATE	01295	
U141	160-0159-00		MICROCIRCUIT, DI: 256 X 4 PROM, PROGRAMMED	80009	SN74LSOO(N OR J) 160-0159-00
U143	156-0158-00		MICROCIRCUIT, LI: DUAL OPERATIONAL AMPLIFIER	18324	
U154	156-1114-00		MICROCIRCUIT, LI: OPERATIONAL AMPLIFIER	02735	MC1458N CA3160E
U161	156-0392-00				
U162	156-0383-00		MICROCIRCUIT, DI:QUAD LATCH W/CLEAR MICROCIRCUIT, DI:QUAD 2-INPUT NOR GATE	34335	SN74LS175N OR J
U169	156-0480-00		MICROCIRCUIT, DI QUAD 2-INPUT NOR GATE	80009	156-0383-00
U171	156-0382-00		MICROCIRCUIT, DI:QUAD 2-INPUT AND GATE MICROCIRCUIT, DI:QUAD 2-INPUT NAND GATE	01295	SN74LSO8(N OR J)
U173	156-0385-00		MICROCIRCUIT, DI: HEX. INVERTER	01295	SN74LS00(N OR J)
U179	156-0644-00		MICROCIRCUIT, DI: HEX. INVERTER MICROCIRCUIT, DI: QUAD BILATERAL SWITCH	80009 80009	156-0385-00 156-0644-00
U189	156-0093-00				
U199	156-0382-00		MICROCIRCUIT, DI: HEX. INVERTER	80009	156-0093-00
U209	156-0383-00		MICROCIRCUIT, DI:QUAD 2-INPUT NAND GATE	01295	SN74LSOO(N OR J)
U219	156-0385-00		MICROCIRCUIT, DI:QUAD 2-INPUT NOR GATE	80009	156-0383-00
U239	156-0382-00		MICROCIRCUIT, DI:HEX. INVERTER	80009	156-0385-00
			MICROCIRCUIT, DI: QUAD 2-INPUT NAND GATE	01295	SN74LS00(N OR J)

Ckt No.	Tektronix Part No.	Serial/Mode	el No. Dscont	Name & Description	Mfr Code	Mfr Part Number
			DSCOIL			156-0733-00
U241	156-0733-00			MICROCIRCUIT, DI: DUAL MONOSTABLE MV	80009	
U244	156-0784-00	B010100	B010747	MICROCIRCUIT, DI:SYNC 4 BIT BINARY COUNTER	01295	SN74LS163AN
U244	156-0784-02	B010748		MICROCIRCUIT, DI: SYNC 4 BIT BINARY COUNTER	27014	DM74LS163ANA+
U249	160-0158-00)		MICROCIRCUIT, DI: 32 X 8 PROM, PROGRAMMED	80009	160-0158-00
U254	156-0784-00	в010100	B010747	MICROCIRCUIT, DI: SYNC 4 BIT BINARY COUNTER	01295	SN74LS163AN
U254	156-0784-02	В010748		MICROCIRCUIT, DI:SYNC 4 BIT BINARY COUNTER	27014	DM74LS163ANA+
U261	156-0383-00)		MICROCIRCUIT, DI: QUAD 2-INPUT NOR GATE	80009	156-0383-00
U264	156-0784-00		B010747	MICROCIRCUIT.DI:SYNC 4 BIT BINARY COUNTER	01295	SN74LS163AN
U264	156-0784-02			MICROCIRCUIT, DI:SYNC 4 BIT BINARY COUNTER	27014	DM74LS163ANA+
U305	156-0921-00			MICROCIRCUIT, LI: OPERATIONAL AMPLIFIER	02735	CA3140S
U308	156-0686-00			MICROCIRCUIT, LI: OPNL AMPL, HIGH IMPEDANCE	02735	CA3130S
U315	156-0770-00			MICROCIRCUIT, LI: OPERATIONAL AMPLIFIER	27014	LF356H
U336	156-0295-00	1		MICROCIRCUIT, DI:TRIPLE EXCL OR EXCL NOR	80009	156-0295-00
U338	156-0277-00			MICROCIRCUIT, LI: VOLTAGE REGULATOR	07263	MICROA7805UC
U354	156-0362-00			MICROCIRCUIT, LI:ECL COMPARATOR	34335	AM685HL
U357	156-0362-00			MICROCIRCUIT, LI:ECL COMPARATOR	34335	AM685HL
U365	156-1191-00			MICROCIRCUIT, LI:BI-FET OPNL AMPL	01295	TL072ACP
U390	155-0195-00			MICROCIRCUIT, LI: HYBRID SHAPERCIRCUIT	80009	155-0195-00
U397	156-0158-00	2		MICROCIRCUIT, LI: DUAL OPERATIONAL AMPLIFIER	18324	MC1458N
			в010967	MICROCIRCUIT, LI: DUAL DIFF AMPL, 14 LD DIP	80009	156-0534-00
U447 U447	156-0534-00 156-0534-01		8010907	MICROCIRCUIT, LI: DUAL DIFF AMPL, BURN-IN	02735	CA3102EX
		T	B010747	MICROCIRCUIT, LI: MODULATOR DEMODULATOR	80009	156-0130-00
U484 U484	156-0130-00 156-0130-00		8010747	MICROCIRCUIT, LI: MODULATOR/DEMODULATOR, SCRN	04713	SC77162GH
VR164	152-0662-00	n		SEMICOND DEVICE: ZENER, 0.4W, 5V, 1%	04713	SZG195
VR325	152-0395-00			SEMICOND DEVICE: ZENER, 0.4W, 4.3V, 5%	14552	TD332317
VR325 VR356	152-0689-0			SEMICOND DEVICE: ZENER, 0.4W, 5%, 3.9V	80009	152-0689-00
	152-0869-00			SEMICOND DEVICE: ZENER, 0.4W, 24V, 5%	04713	SZG35009K8
VR360				SEMICOND DEVICE: ZENER, 0.25W, 6.2V, 5%	80009	152-0486-00
VR387 VR393	152-0486-00 152-0279-00			SEMICOND DEVICE: ZENER, 0.4W, 5.1V, 5%	04713	SZG35010RL
WD/12	152 0270 0	0		SEMICOND DEVICE: ZENER, 0.4W, 5.1V, 5%	04713	SZG35010RL
VR412	152-0279-0			SEMICOND DEVICE: ZENER, 0.4W, 7.5V, 5%	04713	SZG35009K2
VR442	152-0127-0	U		SERITORIA DEVICE. VENEV. O. +w, 1. 74, 7%	0 1.13	



SERVICING ILLUSTRATIONS

The circuit board illustrations in this section serve as an aid to the service technician who selects the jumper positions and performs the calibration procedure.

Solid lines for the jumpers are the factory-set positions. Dotted lines indicate the other choices.

The connecting information and circuit number of the multi-pin connectors are given as an aid when installing or servicing the TSG6.

FIG. 8-1. A60 MULTIBURST LOGIC ADJUSTMENT AND JUMPER LOCATIONS.

NOTE

The Module Output multi-pin connector, that connects to pins 1 and 2 of P515, and its coaxial cable are EIA color coded accor-Module Location Number: Module Location 1 = Brown, Module Location 2 = Red, etc. This coding method matches the 1410 rearpanel Module Output connector numbering sequence: J1 = Module Location 1, J2 = Module Location 2, etc. Knowing this information enables the user to easily identify the source of the 1410 Module Output signal.

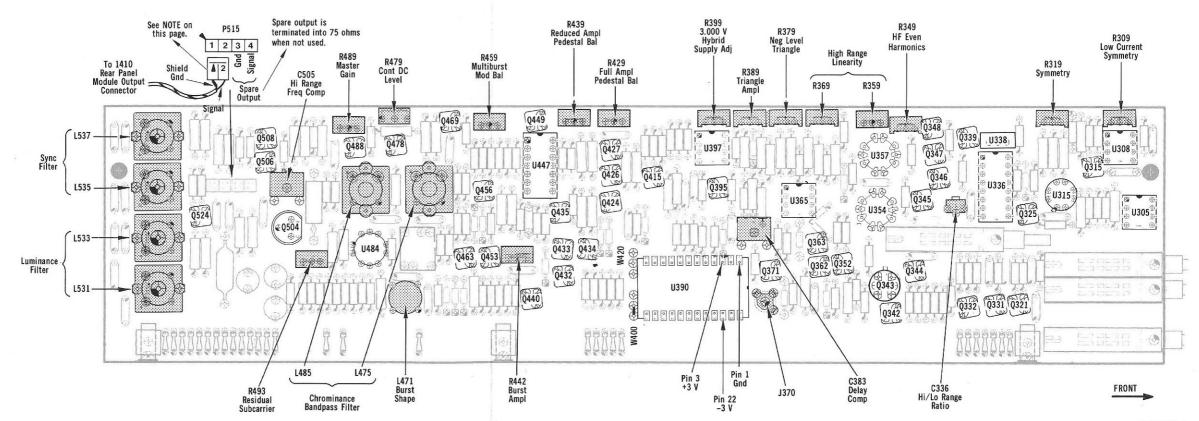
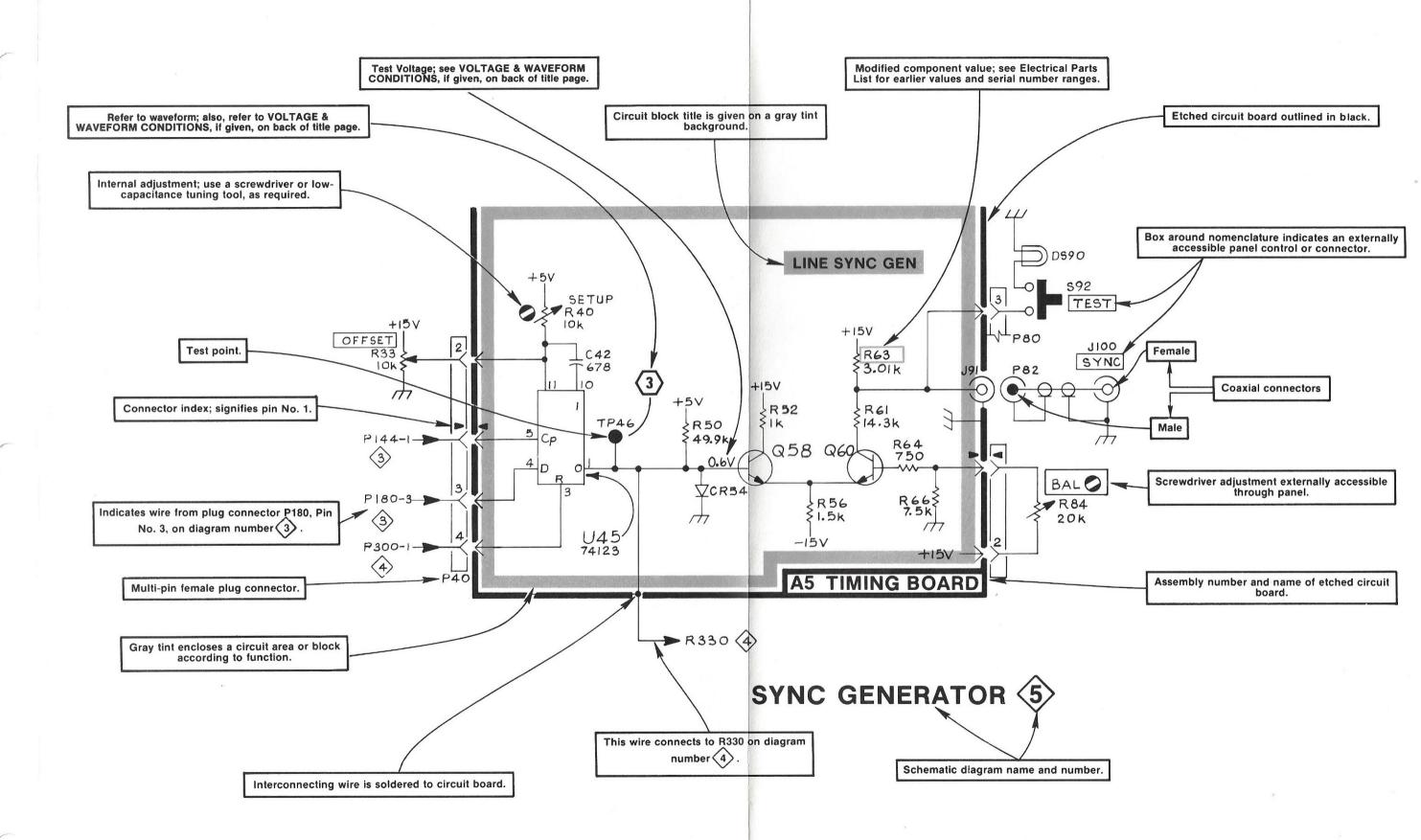


FIG. 8-2. A61 MULTIBURST OUTPUT ADJUSTMENT LOCATIONS.

REV A DEC 1979



SCHEMATIC EXAMPLE

DIAGRAMS & CIRCUIT BOARD ILLUSTRATIONS

This section of the manual contains block and schematic diagrams with waveforms, and etched circuit board illustrations.

Symbols

Symbols used on the diagrams are based on ANSI Y32.2-1975 and IEEE No. 315 March 1971. Logic symbology is based on ANSI Y32.14-1973 (IEEE Std. 91-1973). Logic symbols depict the logic function performed and may differ from the manufacturer's data.

Component values

Electrical components shown on the diagrams are in the following units unless noted otherwise:

Capacitors = Values one or greater are in picofarads (pF). Values less than one are in microfarads (μ F).

Resistors = Ohms (Ω) .

Semiconductor Types

Refer to the Replaceable Electrical Parts list.

Reference Designators

The following letters are used as reference designators to identify components or assemblies on Tektronix, Inc. schematic diagrams.

A AT B BT C CR DH DL DS E F L H HR	Assembly, separable or repairable (circuit board, etc.) Attenuator, fixed or variable Motor Battery Capacitor, fixed or variable Diode, signal or rectifier Decoupling Hybrid Delay Line Indicating device (lamp) Spark Gap Fuse Filter Heat dissipating device (heat sink, heat radiator, etc.) Heater	LR M P Q R RT S T TC TP U	Inductor/resistor combination Meter Connector, movable portion Transistor, silicon-controlled rectifier, or programmable unijunction transistor Resistor, fixed or variable Thermistors Switch Transformer Thermocouple Test Point Assembly, inseparable or non-repairable (integrated circuit, etc.) Electron tube
		100	
HR	Heater	-	
J	Connector, stationary portion	VR	Voltage regulator (zener diode, etc.)
K	Relay	Υ	Crystal
L	Inductor, fixed or variable		

Partial Schematic Diagram With Explanations

The partial diagram at the left is an example of the various symbols and other information provided on Tektronix, Inc. diagrams.

WAVEFORM CONDITIONS

Waveform photographs in this section were taken with a TEKTRONIX C-59 Oscilloscope Camera mounted on a TEKTRONIX 7603 Oscilloscope. Plug-in units for the 7603 Oscilloscope are as follows: 7A13 Differential Comparator, 7A26 Dual-Trace Amplifier, and a 7B53A Dual Time Base. To obtain the four-trace logic timing waveforms, another 7A26 Dual-Trace Amplifier was used in place of the 7A13.

All Waveforms in this section were photographed as shown. The TSG6 front-panel controls were set as follows except when indicated above the waveform:

FREQ RANGE

MARKERS

COMPOSITE/CONTINUOUS

AMPL

MULTIBURST/SWEEP/MANUAL

FREQUENCY Control

BURST

LOW

On

COMPOSITE

FULL

MULTIBURST

Fully ccw

On

External triggering from the 1410 Comp Sync signal was used. The oscilloscope Triggering Level control was used to obtain line rate or field rate triggering, depending on the signal repetition rate.

The dc offset feature of the 7A13 differential Comparator was used to position those waveforms having high dc levels into view and to obtain the dc levels recorded at the right side of the waveform. All waveforms were dc coupled except as indicated below the waveform.

NOTE

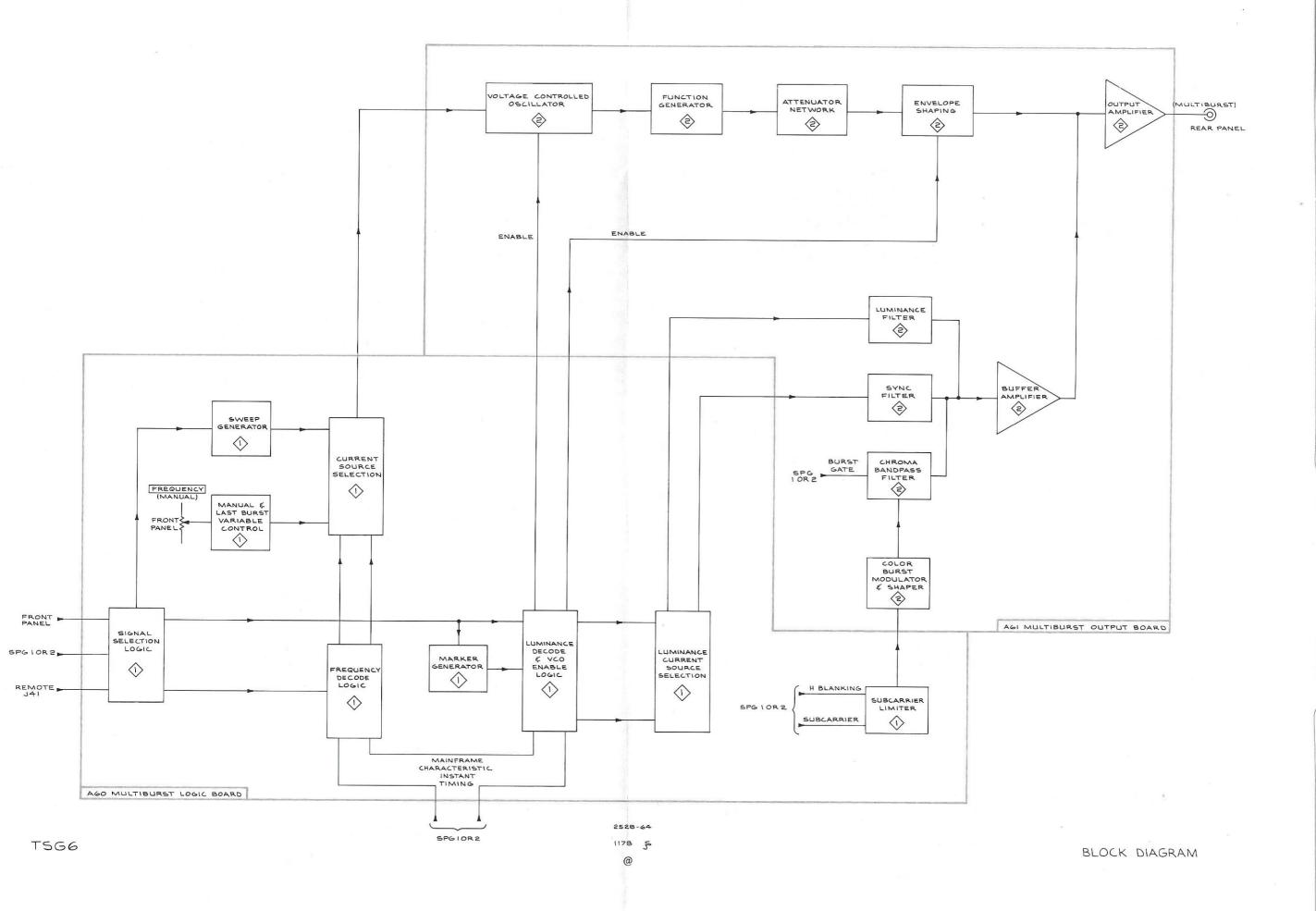
Additional waveforms and logic timing diagrams are provided in Section 5, Theory of Operation.

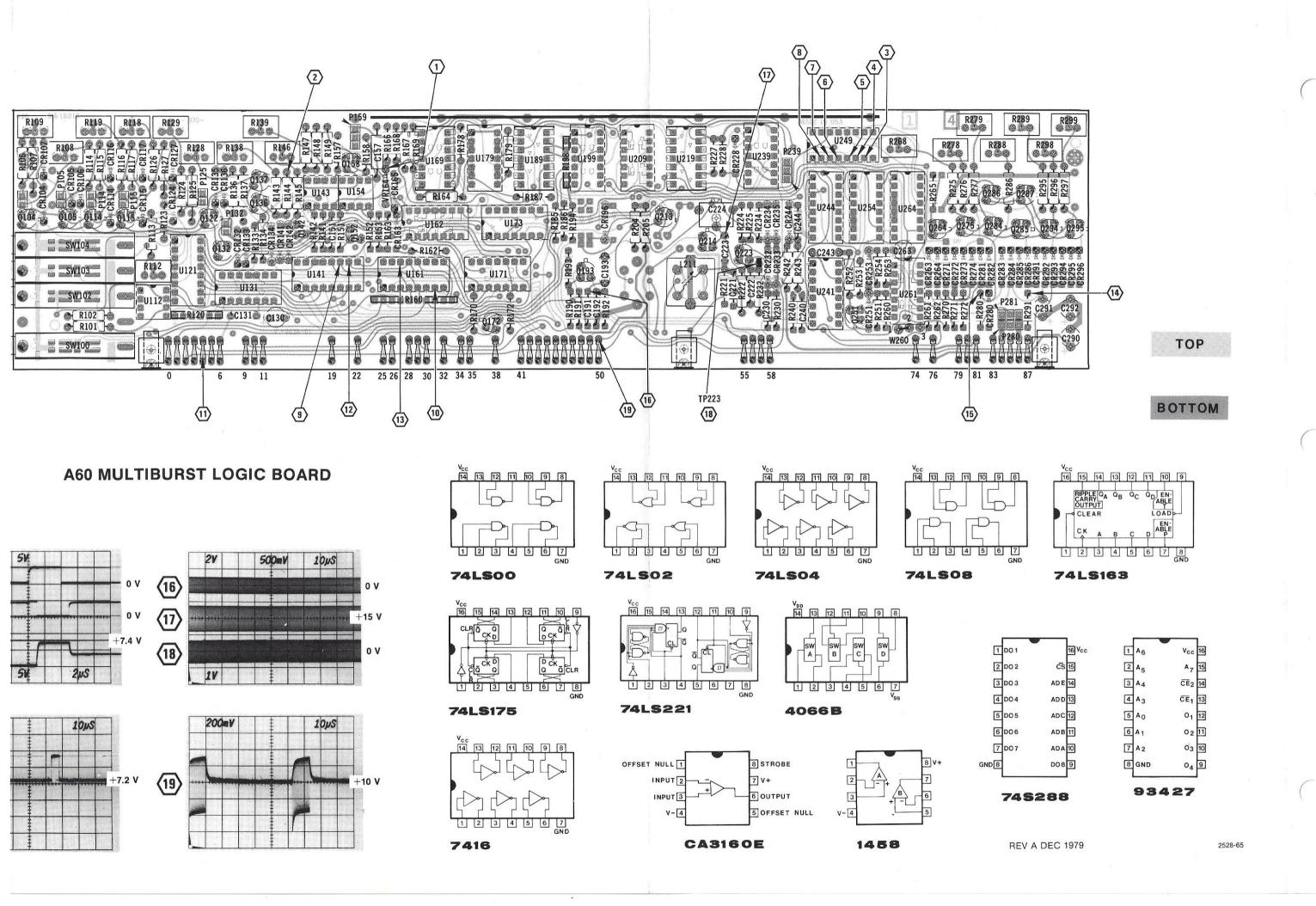
All waveforms and dc levels are not absolute, and may vary between instruments because of component and calibration tolerances.

All internal jumpers have been set to their factory-set positions.

CAUTION

Avoid accidental shorts that may damage components when connecting the oscilloscope probes to the circuit board component leads; particularly, when connecting the probe to the emitter of Q352. Set the 1410 mainframe Power switch to Off while making connections.





MULTIBURST LOGIC



MULTIBURST LOGIC PARTS LOCATING CHART

C130	E8	CR274	E6	R101	D7	R160H	D5	R275	F7	U173A	B 4
C131	E6	CR280	E6	R102	D7	R160I	D5	R276	F7	U173B	B2
C151	C7	CR281	E6	R106	B8	R162	B6	R277	E7	U173C	B2
C157	B6	CR282	E7	R107	B7	R163	B5	R278	F7	U173D	F2
C191	E2	CR283	E7	R108	B8	R164	A5	R279	F7	U173E	E5
C192	E2	CR284	E6	R109	B8	R166	B6	R280	F7	U173F	A3
C193	E2	CR285	E7	R112	D6	R167	B6	R286	E7	U179A	A6
C221	E3	CR286	E7	R113	D6	R168	B2	R288	E7	U179B	A5
C222	E3	CR291	E7	R114	B8	R169	A6	R289	E7	U179C	B 5
C223	E3	CR292	E7	R115	B7	R170	C4	R291	F8	U179D	B 6
C224	F3	CR293	D7	R116	B8	R172	B5	R295	E7	U189A	A4
C230	E4	CR294	D7	R117	B7	R178	A4	R296	E7	U189B	B2
C240	B5	CR295	D7	R118	C8	R179	B5	R297	D7	U189C	B3
C243	D6	CR296	D7	R119	B8	R185	B1	R298	E7	U189D	F1
C244	F4			R120A	E2	R186	B1	R299	D7	U189E	B2
C263	D6	L211	E3	R120B	C2	R187	A5			U189F	F2
C290	E8			R120D	F2	R190	E1	S100	F1	U199A	E4
C291	E8	P104	B7	R120E	A4	R191	E2	S102	A1	U199B	E4
C292	E8	P105	B7	R123	B7	R192	E2	S103	C1	U199C	E5
	_	P114	B7	R124	C8	R193	E1	S104	B1	U199D	B2
CR104	B7	P115	C7	R125	C7	R194	B1	S300A	D1	U209A	C4
CR105	B7	P125	C7	R126	C8	R198A	F1	S300B	D1	U209B	B3
CR106	B7	P132	C7	R127	C7	R198B	F2	S302	C1	U209C	B 3
CR107	B7	P159	B5	R128	C8	R198C	B2	S303	E1	U209D	B3
CR114	C7	P239	E5	R129	C8	R198D	B2	S335A	A1	U219A	C3
CR115	C7	P280	F8	R133	C6	R198E	B2	S335B	A1	U219B	F5
CR116	C7	P281	F8	R134	D6	R204	E2			U219C	E6
CR117	C7	0404		R136	C8	R205	E2	TP223	E4	U219D	E6
CR124	C7	Q104	B8	R137	C7	R221	E3			U219E	F5
CR127	C7	Q105	B8	R138	B6	R222	E3	U112A	D7	U219F	E3
CR132	C7	Q114	C8	R139	B6	R224	E3	U112B	C7	U239A	E 6
CR133	B7	Q115	C8	R141	C6	R225	E3	U121	C5	U239B	C4
CR134	C7	Q122	C8	R142	C6	R227	D2	U131A	F2	U239C	B 4
CR135 CR136	C7 C7	Q132 Q136	C8	R143	B6	R228	D2	U131B	D6	U239D	C3
CR141	B6	Q137	B7 A6	R144	B6	R230	E5	U131C	B2	U241A	D6
CR141	A6	Q142	C6	R145	A6	R232	F4	U131D	B2	U241B	B5
CR142	B6	Q152	C6	R146	B6	R234	F2	U141	D5	U244	D2
CR165	B5	Q152	B6	R147	C5	R240	B5	U143A	C6	U249	D2
CR196	E2	Q172	C5	R148	C5	R242	F4	U143B	B6	U254	D3
CR228	D2	Q193	E2	R149	B6	R243	F4	U154	B6	U261A	E 6
CR232	F3	Q213	E2	R151	C6	R251	D5	U161	D5	U261B	E2
CR233	F3	Q214	E3	R152 R153	B6	R252	D5	U162A	B3	U261C	F5
CR234	F3	Q223	E4	R156	C6	R253	D6	U162B	C3	U261D	F6
CR235	F3	Q251	D6		B5	R254	D6	U162C	B2	U264	D3
CR244	F4	Q264	D8	R157 R158	B6	R260	D5	U162D	B2	WB464	
CR251	D6	Q275	F7		B6	R261	D6	U169A	E4	VR164	B 6
CR253	D6	Q284	E7	R160A R160B	C2 D5	R262 R263	E6 F6	U169B	E4	Woos	
CR263	F7	Q285	E7	R160C	B3	R265		U169C	C3	W260	F5
CR264	F7	Q286	F7	R160D	D5	R268	D8 F7	U169D	B3		
CR271	F7	Q287	E7	R160E	D5			U171A U171B	B3		
CR272	F6	Q294	E7	R160F	A2	R270	E6	U171C	B3 A3		
CR273		Q295	D7	R160G	R2	R271	F6	U171C			

CR273 E7

Q295

D7

R160G B2

R272

E6

U171D E5

5

2

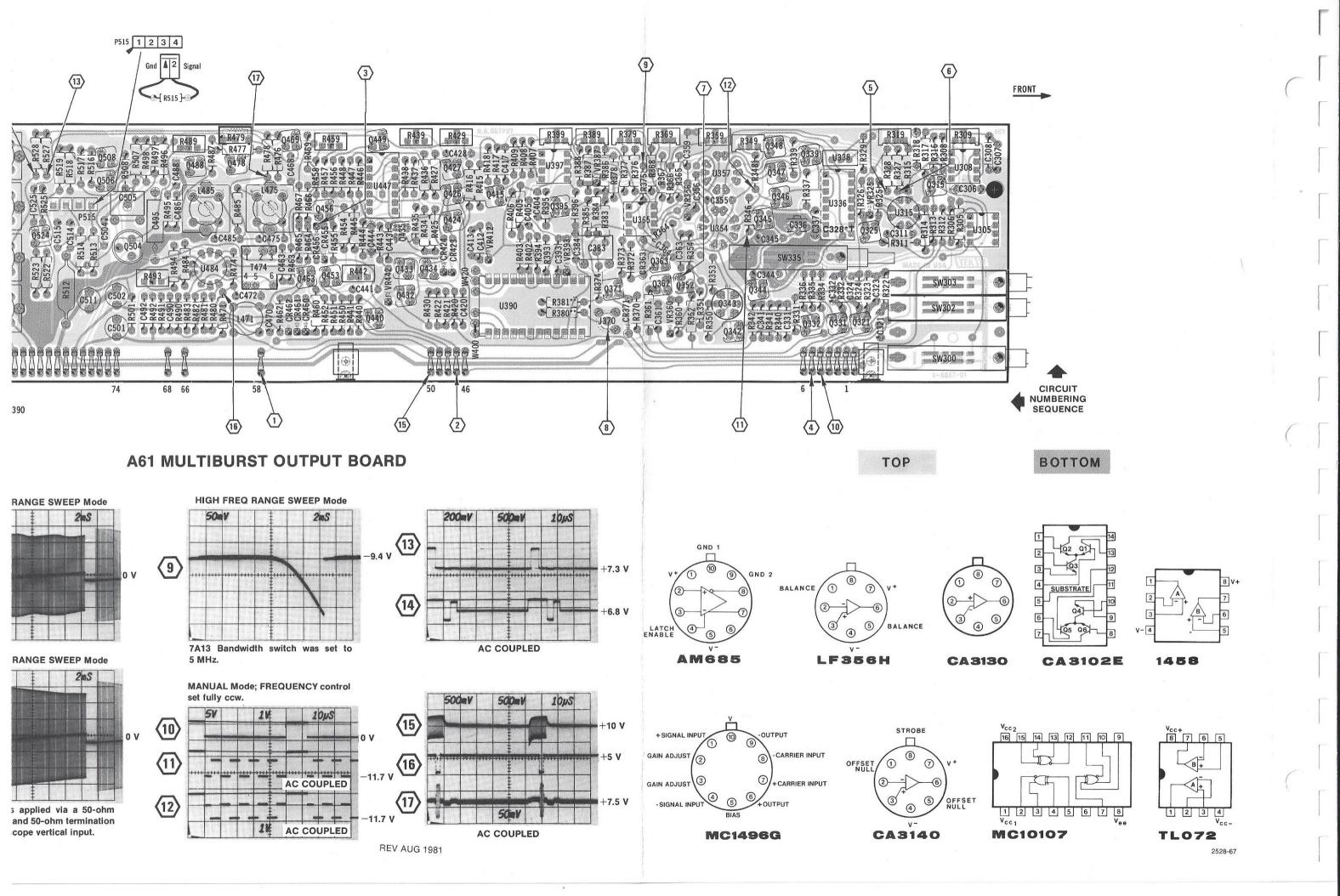
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 \Diamond

MULTIBURST LOGIC

8

A61 MULTIBURST OUTPUT & WAVEFORMS FOR





MULTIBURST OUTPUT PARTS LOCATING CHART

C306	E2	C531	E 5	Q427	C5	R351	D2	R430	C5	R496	C7
C307	F2	C532	E5	Q432	C5	R352	D3	R434	B7	R497	C7
C308	F2	C533	E5	Q433	C5	R353	D2	R435	B6	R498	C7
C311	D2	C534	E 6	Q434	C5	R354	D2	R436	C6	R501	F6
C321	B8	C535	D5	Q435	B6	R359	E4	R437	B6	R507	C7
C323	F3	C536	E5	Q440	B 5	R360	D3	R438	B6	R508	C8
C324	F3	C537	E 5	Q449	B6	R361	D3	R439	C6	R512	D8
C328†*	E3	C538	E6	Q453	B 5	R364	E4	R440	B4	R513	D8
C331	D2			Q456	B 5	R365	E4	R441	B 5	R514	D8
C332	F3	CR363	F4	Q463	F5	R366	F4	R442	F5	R516	C8
C336	D2	CR371	E4	Q469	E7	R367	E4	R443	B6	R517	C8
C337	E3	CR423	C5	Q478	C7	R368	E4	R444	B6	R518	C8
C341	C1	CR424	C5	Q488	C7	R369	F4	R445	B 5	R519	C8
C344	D2	CR455	B 5	Q504	C8	R370	F4	R446	B6	R522	E7
C345	D2	CR456	B 5	Q506	C8	R372	F4	R447	B6	R523	E7
C355	E3	CR460	F5	Q508	C8	R373	E4	R448	B6	R525	E7
C356	B8	CR461	F5	Q524	E7	R374	D4	R450	B 5	R527	E6
C358	D4	CR462	F5			R375	E4	R451	B 5	R528	E6
C359	D3			R305	D1	R376	D4	R452	B4		
C361	D3	J370	C3	R306	D1	R377	E4	R454	B 5	S300B	C4
C363	D2			R308	E2	R378	D4	R455	B4	S335B	E1
C364	E4	L471	F5	R309	E2	R379	E4	R456	B6		
C383	D4	L475	E6	R311	E3	R380	C3	R457	B7	T474	E6
C384	C4	L485	E 6	R312	D1	R381	C3	R458	A7		
C393	C4	L531	E 5	R313	D2	R383	E4	R459	B7	U305	D1
C404	В3	L533	E 5	R314	C2	R384	D3	R460	F5	U308	E2
C405	В3	L535	E5	R315	F2	R385	B4	R462	E5	U315	C2
C412	C4	L537	E5	R316	D2	R386	E4	R463	E6	U336A	D3
C413	C4			R317	E1	R387	A3	R464	B5	U336B	E3
C417	A3	P515	D8	R318	E2	R388	A3	R465	B5	U338	C8
C420	C5	V-10-00-00		R319	F2	R389	D4	R466	B5	U354	E3
C428	C6	Q315	D2	R322	F3	R393	B4	R467	B5	U357	D3
C441	B 5	Q321	F3	R323	F3	R394	В3	R469	B5	U365A	D4
C443	B6	Q325	C2	R324	F3	R395	B3	R471	F6	U365B	E4
C444	B 5	Q331	E3	R325	C2	R396	B3	R474	F6	U390	C4
C463	E6	Q332	F2	R326	C2	R399	B2	R476	E7	U397A	A3
C468	B7	Q339	E2	R327	F2	R402	B3	R477	D7	U397B	B3
C470	F5	Q342	D2	R328	C2	R403	B4	R478	E7	U447	B6
C472	F6	Q343A	C2	R329	F2	R405	В3	R479	D7	U484	F6
C475	E7	Q343B	D2	R331	D2	R406	В3	R480	E6		
C485	E7	Q344	C2	R332	F3	R407	B2	R481	E6	VR325	C2
C486	C7	Q345	E2	R334	E3	R408	B3	R482	E6	VR356	D2
C488	C7	Q346	E2	R335	F3	R409	B3	R483	F6	VR360	D3
C490	E6	Q347	D2	R336	F3	R415	C5	R484	F6	VR387	B1
C492	F7	Q348	E2	R337	E3	R416	B5	R485	E6	VR393	C4
C495	C8	Q352	D3	R339	E3	R417	B3	R487	C7	VR412	C4
C501	B8	Q362	D3	R340	C2	R418	C5	R489	D7	VR442	C5
C502	B8	Q363	E4	R341	D2	R420	C5	R490	E6	******	00
C504	D7	Q371	E4	R342	C2	R421	C5	R490	E6	W400	C5
C505	C7	Q395	B4	R346	E2	R422	C5	R492	F7	W420	B5
C511	B8	Q415	B3	R348	E2	R425	B7	R493	F6	*******	
C514	D8	Q424	B5	R349	E2	R427	C6	R494	F6		
C515	D8	Q426	C5	R350	D2	R429	B5	R495	C7		
					_	11720		nass	01		

†Located on back of board

E7

^{*}See Parts List for serial number ranges.

B

C

D

E

MULTIBURST OUTPUT

REPLACEABLE MECHANICAL PARTS

PARTS ORDERING INFORMATION

Replacement parts are available from or through your local Tektronix, Inc. Field Office or representative.

Changes to Tektronix instruments are sometimes made to accommodate improved components as they become available, and to give you the benefit of the latest circuit improvements developed in our engineering department. It is therefore important, when ordering parts, to include the following information in your order: Part number, instrument type or number, serial number, and modification number if applicable.

If a part you have ordered has been replaced with a new or improved part, your local Tektronix, Inc. Field Office or representative will contact you concerning any change in part number.

Change information, if any, is located at the rear of this manual.

SPECIAL NOTES AND SYMBOLS

X000 Part first added at this serial number
00X Part removed after this serial number

FIGURE AND INDEX NUMBERS

Items in this section are referenced by figure and index numbers to the illustrations.

INDENTATION SYSTEM

This mechanical parts list is indented to indicate item relationships. Following is an example of the indentation system used in the description column.

1 2 3 4 5

Name & Description

Assembly and/or Component Attaching parts for Assembly and/or Component

Detail Part of Assembly and/or Component Attaching parts for Detail Part

Parts of Detail Part Attaching parts for Parts of Detail Part

Attaching Parts always appear in the same indentation as the item it mounts, while the detail parts are indented to the right. Indented items are part of, and included with, the next higher indentation. The separation symbol - - - * - - - indicates the end of attaching parts.

Attaching parts must be purchased separately, unless otherwise specified.

ITEM NAME

In the Parts List, an Item Name is separated from the description by a colon (:). Because of space limitations, an Item Name may sometimes appear as incomplete. For further Item Name identification, the U.S. Federal Cataloging Handbook H6-1 can be utilized where possible.

ABBREVIATIONS

# ACTR ADPTR ALIGN AL ASSEM AS	INCH NUMBER SIZE ACTUATOR ADAPTER ALIGNMENT ALUMINUM ASSEMBLED ASSEMBLY ATTENUATOR AMERICAN WIRE GAGE BOARD BRACKET BRASS BRONZE BUSHING CABINET CAPACITOR CERAMIC CHASSIS CIRCUIT COMPOSITION CONNECTOR COVER COUPLING CATHODE RAY TUBE DEGREE DRAWER	ELCTRN ELEC ELCTLT EPL EOPT EXT FIL FLEX FLH FLTR FR FSTNR FT FXD GSKT HDL HEX HD HEX HD HEX SOC HLCPS HLEXT HV IC ID IDENT IMPLR	ELECTRON ELECTRICAL ELECTROLYTIC ELEMENT ELECTRICAL PARTS LIST EQUIPMENT EXTERNAL FILLISTER HEAD FLEXIBLE FLAT HEAD FILTER FRAME OF FRONT FASTENER FOOT FIXED GASKET HANDLE HEXAGONAL HEAD HEXAGONAL HEAD HEXAGONAL SOCKET HELICAL COMPRESSION HELICAL EXTENSION HIGH VOLTAGE INTEGRATED CIRCUIT INSIDE DIAMETER IDENTIFICATION IMPELLER	IN INCAND INSUL INTU LPHLDR MACH MTG NIP NON WIRE OBD OD OVH PH BRZ PL PLSTC PN PNH PWR RCPT RES RGD RLF RTNR SCH SCOPE	INCH INCANDESCENT INSULATOR INTERNAL LAMPHOLDER MACHINE MECHANICAL MOUNTING NIPPLE NOT WIRE WOUND ORDER BY DESCRIPTION OUTSIDE DIAMETER OVAL HEAD PHOSPHOR BRONZE PLAIN OF PLATE PLASTIC PART NUMBER PAN HEAD POWER RECEPTACLE RESISTOR RIGID RELIEF RETAINER SOCKET HEAD OSCILLOSCOPE SCREW	SHLD SHLDR SKT SL SLFLKG SLVG SPR	SINGLE END SECTION SEMICONDUCTOR SHIELD SHOULDERED SOCKET SLIDE SELF-LOCKING SLEEVING SPRING SOUARE STAINLESS STEEL SWITCH TUBE TERMINAL THREAD THICK TENSION TAPPING TRUSS HEAD VOLTAGE VARIABLE WITH WASHER TRANSFORMER TRANSFORMER
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Replaceable Mechanical Parts—TSG6

CROSS INDEX—MFR. CODE NUMBER TO MANUFACTURER

Mfr. Code	Manufacturer	Address	City, State, Zip
000CY 00779 07707 22526 23880 26365	NORTHWEST FASTENER SALES, INC. AMP, INC. USM CORP., USM FASTENER DIV. BERG ELECTRONICS, INC. STANFORD APPLIED ENGINEERING, INC. GRIES REPRODUCER CO., DIV. OF COATS	7923 SW CIRRUS DRIVE P O BOX 3608 510 RIVER RD. YOUK EXPRESSWAY 340 MARTIN AVE.	BEAVERTON, OREGON 97005 HARRISBURG, PA 17105 SHELTON, CT 06484 NEW CUMBERLAND, PA 17070 SANTA CLARA, CA 95050
71785 73743 73803	AND CLARK, INC. TRW, CINCH CONNECTORS FISCHER SPECIAL MFG. CO. TEXAS INSTRUMENTS, INC., METALLURGICAL	125 BEECHWOOD AVE. 1501 MORSE AVENUE 446 MORGAN ST.	NEW ROCHELLE, NY 10802 ELK GROVE VILLAGE, IL 60007 CINCINNATI, OH 45206
78189	MATERIALS DIV. ILLINOIS TOOL WORKS, INC.	34 FOREST STREET	ATTLEBORO, MA 02703
80009 83385 91637	SHAKEPROOF DIVISION TEKTRONIX, INC. CENTRAL SCREW CO. DALE ELECTRONICS, INC.	ST. CHARLES ROAD P O BOX 500 2530 CRESCENT DR. P. O. BOX 609	ELGIN, IL 60120 BEAVERTON, OR 97077 BROADVIEW, IL 60153 COLUMBUS, NE 68601

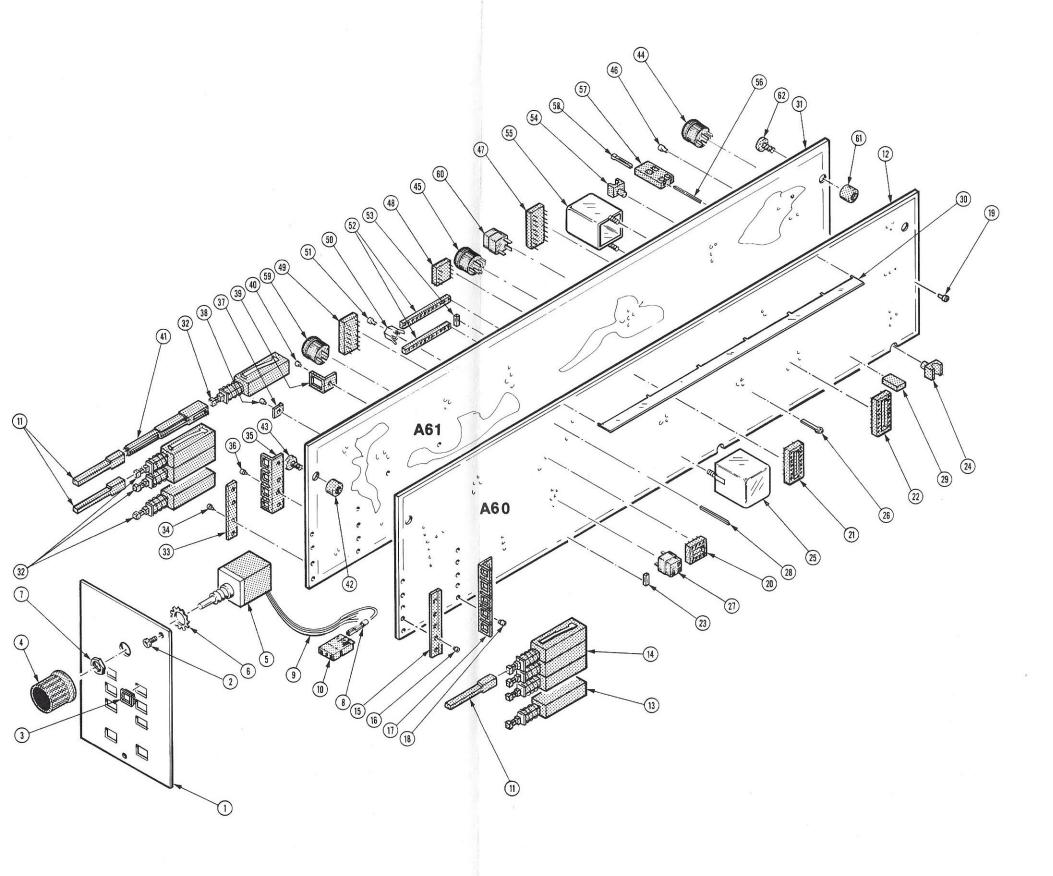
Fig. & Index No.		Serial/Model No. Eff Dscont	Qty	1 2 3 4 5	Name & Description	Mfr Code	Mfr Part Numbe
1-1	333-2430-00		1	PANEL, FRONT:	(ATTACHING PARTS)	80009	333-2430-00
-2	213-0277-00		2		R:2-56 X 0.312 INCH, PNH STL	83385	OBD
-3	426-1206-00		8	FRAME.PUSH BTN	: MOMENTARY, GRAY PLASTIC	80009	426-1206-00
-4	366-0497-00		1	KNOB: GY, 0.127	ID X0.706 OD	80009	366-0497-00
-5	213-0153-00		1	. SETSCREW:5-4 RES., VAR NONWI	0 X 0.125,STL BK OXD,HEX SKT R:(SEE R156 REPL) (ATTACHING PARTS)	000CY	OBD
-6	210-1026-00		1		26 ID, INTL, 0.025 THK, STL	78189	1114-00
-7	210-0465-00		1		:0.25-32 X 0.375 INCH BRS	73743	3095-402
	198-4060-00		1	WIRE SET, ELEC:		80009	198-4060-00
-8	131-0621-00		3	. CONNECTOR, TE	RM:22-26 AWG, BRS& CU BE GOLD	22526	46231
-9	175-0826-00		AR	. WIRE, ELECTRI	CAL: 3 WIRE RIBBON	80009	175-0826-00
-10	352-0199-00		1	. CONN BODY, PL	,EL:3 WIRE BLACK	80009	352-0199-00
-11	366-1691-00		8	PUSH BUTTON: GY	,1.2 L	80009	366-1691-00
	334-1378-00		1	PLATE, IDENT: MK		80009	334-1378-00
-12			1	CKT BOARD ASSY	:MULTIBURST LOGIC(SEE A60 REPL)		
-13			1	. SWITCH PB AS	SY:1 PUSH(SEE S100 REPL)		
-14			1	. SWITCH PB AS	SY:3 LCH(SEE S102,S103,S104 REPL)		
-15	343-0495-05		1		FRONT, 7.5MM X5 UNIT (ATTTACHING PARTS)		343-0495-05
-16	210-3033-00		5	. EYELET, METAL	LIC:0.59 OD X 0.156 INCH LONG	07707	
-17	343-0499-05	B010100 B012126	1	. CLIP, SWITCH:	REAR, 7.5MM X 5 UNIT	80009	343-0499-05
	343-0499-14	B012127	1		7.5MM X 5 UNIT (ATTACHING PARTS)	80009	343-0499-14
-18	210-3033-00		5	. EYELET, METAL	LIC:0.59 OD X 0.156 INCH LONG	07707	SE-25
-19	136-0252-07		15	. SOCKET, PIN C	CONN:W/O DIMPLE	22526	75060-012
-20	136-0514-00		3		EC:MICROCIRCUIT,8 DIP	73803	CS9002-8
-21	136-0269-02		12		EK:MICROCIRCUIT,14 DIP,LOW CLE	73803	CS9002-14
-22	136-0260-02	B010100 B010747	8		EK:MICROCIRCUIT, 16 DIP, LOW CLE	71785	133-51-92-008
	136-0260-02	B010748	5	. SKT, PL-IN EI	EK:MICROCIRCUIT, 16 DIP, LOW CLE	71785	133-51-92-008
-23	136-0328-03		45		TERM: HORIZ, SQ PIN RCPT	22526	47710
-24	214-2440-00		3		PIN:CIRCUIT CARD		214-2440-00
-25	337-1417-00		1	and the second s	0.55 SQ X 0.685 INCH HIGH	80009	337-1417-00
-26	214-0579-00			. TERM, TEST PO		80009	214-0579-00
-27	136-0220-00	B010100 B010253	22		LEK: TRANSISTOR 3 CONTACT, PCB MT	71785	133-23-11-034
	136-0220-00	B010254	8		LEK:TRANSISTOR 3 CONTACT, PCB MT		133-23-11-034
-28	131-0608-00		21		1:0.365 L X 0.025 PH BRZ GOLD		47357
	131-0589-00		3		1:0.46 L X 0.025 SQ		48283-029
	131-0993-00		8		OR:2 WIRE BLACK		850100-01 131-0998-00
	131-0998-00		1	. BUS BAR:9 TE	ERM, 8.132"LONG, CUT TO FIT	80009	131-0996-00
					Y:MULTIBURST OUTPUT(SEE A61 REPL)		
-32				. SWITCH PB AS			
-33	343-0495-04				302,S303,S335 REPL) FRONT,7.5 MM,4 UNIT	80009	343-0495-04
-34	210-3033-00		4	. EYELET, METAI	(ATTACHING PARTS) LIC:0.59 OD X 0.156 INCH LONG	07707	SE-25
2.5	2/2 0/00 0/	D010100 D010100	- 4	OLID CULTURAL	*	80009	343-0499-04
-35	343-0499-04	B010100 B012199 B012200	1	. CLIP, SWITCH:	REAR, 7.5MM X 4 UNIT	80009	343-0499-13
	343-0499-13	8012200	1	. CLIP, SWITCH	(ATTACHING PARTS)	00009	343 0497 13
-36	210-3033-00		4	. EYELET, METAI	LLIC: 0.59 OD X 0.156 INCH LONG	07707	SE-25
-37	343-0495-01		1	. CLIP, SWITCH	FRONT,7.5 MM,1 UNIT	80009	343-0495-01
-38	210-3033-00	T (2)	1	. EYELET, METAI	(ATTACHING PARTS) LLIC:0.59 OD X 0.156 INCH LONG	07707	SE-25
-39	343-0499-01		1	. CLIP, SWITCH	REAR, 7.5 MM, 1 UNIT	80009	343-0499-01
	210-3033-00			DIED DE AMERICA	(ATTACHING PARTS) LLIC:0.59 OD X 0.156 INCH LONG	07707	SE-25

Replaceable Mechanical Parts—TSG6

Fig. & Index	Tektronix	Serial/Mo	ndel No								MA	
No.	Part No.	Eff	Dscont	Qty	-	1 2	3 4 5		Name & Description		Mfr Code	Mfr Part Number
1-41	384-1341-00			1		ΕX	TENSION		.183 INCH LONG, OFFS	2.10	80009	
-42	385-0109-00	1		1		SE	ACER PO	ST · 0 312	L W/4-40 THD THRU,	777		384-1341-00
				-	•	UI	monn, i o	(\TT \	CHING PARTS)	NYL	80009	385-0109-00
-43	211-0040-00			1		SC	REW MACE		O X 0.25", BDGH PLSTO	,	0/0/5	opp.
				-	•	DC	, inci		- *	,	26365	OBD
-44	136-0237-00			1		SC	CKET PLI		CONTACT, ROUND		71785	122 00 10 000
-45	136-0241-00	B010100	B010747	3					CROCIRCUIT, 10 CONT, F	CP MT		133-98-12-062
	136-0241-00			2	0.0	SK	T PL-IN	FIFK . MI	CROCIRCUIT, 10 CONT, F	CB MI	71785	133-99-12-064
-46	136-0252-07			9		SO	CKET PIN	N CONN.W	O DIMPLE	CB MI	71785	133-99-12-064
-47	136-0260-02			í					CROCIRCUIT, 16 DIP, LO	NI OIR	22526	75060-012
-48	136-0514-00			4	•	SK	T PI - IN	FIFC MI	CROCIRCUIT, 8 DIP, LC	W CLE	71785	133-51-92-008
-49	136-0269-02			1					CROCIRCUIT, 14 DIP, LC	II OI D	73803	CS9002-8
-50	131-1003-00			1		CO	NN DCDT	ELEC.CV	F BD MT,3 PRONG	W CLE	73803	CS9002-14
-51	136-0252-07			1		SO	CKET DIN	J CONN.L	O DIMPLE		80009	131-1003-00
-52	136-0691-00			2	•	CV	T DI TN	FIEV.MI	CROCKT, 12 CONT LOW		22526	75060-012
-53	136-0328-03			29	•	20	CKET DIN	TEDM.U	ORIZ,SQ PIN RCPT		23880	C5A-3200-12B
-54	214-2440-00			3	•	BE	CEDTACIE	DIM.CT	RCUIT CARD		22526	47710
-55	337-1417-00			6					SQ X 0.685 INCH HIGH		80009	214-2440-00
-56	131-0589-00			4	•	TF	RMINAL D	DINIO 46	L X 0.025 SQ		80009	337-1417-00
	119-1158-00			1	ň	RE	S-CONN A	1N.0.40	L X 0.025 SQ		22526	48283-029
	321-0085-00			î					OHM,1%,0.125W		80009	119-1158-00
-57	352-0198-06			î					WIRE BLUE		91637	MFF1816G75R00F
-58	131-0621-00			2					2-26 AWG, BRS& CU BE	COLD	80009	352-0198-06
-59	136-0183-00	B010100	B010253X	1	•	so.	CKET DIII	IC-IN-3 I	IN, ROUND	GOLD	22526	46231
-60	136-0220-00		B010253	35					NSISTOR 3 CONTACT,P	CD MT	80009	136-0183-00
	136-0220-00		2010233	10	•	CK	T DI_TN	FIEV.TDA	NSISTOR 3 CONTACT,P	CB MI	71785	133-23-11-034
-61	385-0109-00	201012		1		SP	ACER DOG	T.O 312	L W/4-40 THD THRU, N	CB MI	71785	133-23-11-034
	vicinity in the state of the contract of the c			1	•	OLI	.1001,103		HING PARTS)	IL	80009	385-0109-00
-62	211-0040-00			1		SCI	REM MACU		X 0.25", BDGH PLSTC		26265	OND
				0.00	•	001	ich, Phon		- *		26365	OBD

STANDARD ACCESSORIES

070-2528-00 1 MANUAL, TECH: INSTRUCTION 80009 070-2528-00



MANUAL CHANGE INFORMATION

At Tektronix, we continually strive to keep up with latest electronic developments by adding circuit and component improvements to our instruments as soon as they are developed and tested.

Sometimes, due to printing and shipping requirements, we can't get these changes immediately into printed manuals. Hence, your manual may contain new change information on following pages.

A single change may affect several sections. Since the change information sheets are carried in the manual until all changes are permanently entered, some duplication may occur. If no such change pages appear following this page, your manual is correct as printed.

